cincoze

CV-200/P2302 Series

User Manual



Slim Bezel Panel PC

Intel Meteor Lake-PS Core Series (LGA Socket) Modular Slim Bezel Panel PC

Version: V1.01

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Preface

Revision

Revision	Description	Date
1.00	First Released	2026/01/15
1.01	Add CV-212C, CV-215C & CV-218C Display Module	2026/10/19

Copyright Notice

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Acknowledgement

Cincoze is a registered trademark of Cincoze Co., Ltd. All registered trademarks and product names mentioned herein are used for identification purposes only and may be trademarks and/or registered trademarks of their respective owners.

Disclaimer

This manual is intended to be used as a practical and informative guide only and is subject to change without notice. It does not represent a commitment on the part of Cincoze. This product might include unintentional technical or typographical errors. Changes are periodically made to the information herein to correct such errors, and these changes are incorporated into new editions of the publication.

Declaration of Conformity



FCC

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.



CE

The product(s) described in this manual complies with all application European Union (CE) directives if it has a CE marking. For computer systems to remain CE compliant, only CE-compliant parts may be used. Maintaining CE compliance also requires proper cable and cabling techniques.

Product Warranty Statement

Warranty

Cincoze products are warranted by Cincoze Co., Ltd. to be free from defect in materials and workmanship for 2 years from the date of purchase by the original purchaser. During the warranty period, we shall, at our option, either repair or replace any product that proves to be defective under normal operation. Defects, malfunctions, or failures of the warranted product caused by damage resulting from natural disasters (such as by lightning, flood, earthquake, etc.), environmental and atmospheric disturbances, other external forces such as power line disturbances, plugging the board in under power, or incorrect cabling, and damage caused by misuse, abuse, and unauthorized alteration or repair, and the product in question is either software, or an expendable item (such as a fuse, battery, etc.), are not warranted.

RMA

Before sending your product in, you will need to fill in Cincoze RMA Request Form and obtain an RMA number from us. Our staff is available at any time to provide you with the most friendly and immediate service.

- **RMA Instruction**
  - Customers must fill in the Cincoze Return Merchandise Authorization (RMA) Request Form and obtain an RMA number prior to returning a defective product to Cincoze for service.
  - Customers must collect all the information about the problems encountered and note anything abnormal, and describe the problems on the “Cincoze Service Form” for the RMA number application process.
  - Charges may be incurred for certain repairs. Cincoze will charge for repairs to products whose warranty period has expired. Cincoze will also charge for repairs to products if the damage resulted from acts of God, environmental or atmospheric disturbances, or other external forces through misuse, abuse, or unauthorized alteration or repair. If charges will be incurred for a repair, Cincoze lists all charges and will wait for the customer’s approval before performing the repair.
  - Customers agree to ensure the product or assume the risk of loss or damage during transit, to prepay shipping charges, and to use the original shipping container or equivalent.
  - Customers can be sent back the faulty products with or without accessories (manuals, cables, etc.) and any components from the system. If the components were suspected as part of the problem, please note clearly which components are included. Otherwise, Cincoze is not responsible for the devices/parts.
  - Repaired items will be shipped along with a "Repair Report" detailing the findings and actions taken.

Limitation of Liability

Cincoze’ liability arising out of the manufacture, sale, or supplying of the product and its use, whether based on warranty, contract, negligence, product liability, or otherwise, shall not exceed the original selling price of the product. The remedies provided herein are the customer’s sole and exclusive remedies. In no event shall Cincoze be liable for direct, indirect, special or consequential damages whether based on contract of any other legal theory.

Technical Support and Assistance

1. Visit the Cincoze website at www.cincoze.com where you can find the latest information about the product.
2. Contact your distributor or our technical support team, or sales representative for technical support if you need additional assistance. Please have the following information ready before you call:
   - Product name and serial number
   - Description of your peripheral attachments
   - Description of your software (operating system, version, application software, etc.)
   - A complete description of the problem
   - The exact wording of any error messages

Conventions Used in this Manual



WARNING (AVERTIR)

This indication alerts operators to an operation that, if not strictly observed, may result in severe injury.
(Cette indication avertit les opérateurs d'une opération qui, si elle n'est pas strictement observée, peut entraîner des blessures graves.)



CAUTION (ATTENTION)

This indication alerts operators to an operation that, if not strictly observed, may result in safety hazards to personnel or damage to equipment.
(Cette indication avertit les opérateurs d'une opération qui, si elle n'est pas strictement observée, peut entraîner des risques pour la sécurité du personnel ou des dommages à l'équipement.)



NOTE (NOTE)

This indication provides additional information to complete a task easily.
(Cette indication fournit des informations supplémentaires pour effectuer facilement une tâche.)

Safety Precautions

Before installing and using this device, please note the following precautions.

1. Read these safety instructions carefully.
2. Keep this User's Manual for future reference.
3. Disconnect this equipment from any AC outlet before cleaning.
4. For plug-in equipment, the power outlet socket must be located near the equipment and must be easily accessible.
5. Keep this equipment away from humidity.
6. Put this equipment on a reliable surface during installation. Dropping it or letting it fall may cause damage.
7. Make sure the voltage of the power source is correct before connecting the equipment to the power outlet.
8. Use a power cord that has been approved for use with the product and that it matches the voltage and current marked on the product's electrical range label. The voltage and current rating of the cord must be greater than the voltage and current rating marked on the product.
9. Position the power cord so that people cannot step on it. Do not place anything over the power cord.
10. All cautions and warnings on the equipment should be noted.
11. If the equipment is not used for a long time, disconnect it from the power source to avoid damage from transient overvoltage.
12. Never pour any liquid into an opening. This may cause fire or electrical shock.
13. Never open the equipment. For safety reasons, the equipment should be opened only by qualified service personnel.
    If one of the following situations arises, get the equipment checked by service personnel:
    - The power cord or plug is damaged.
    - Liquid has penetrated into the equipment.
    - The equipment has been exposed to moisture.
    - The equipment does not work well, or you cannot get it to work according to the user's manual.
    - The equipment has been dropped and damaged.
    - The equipment has obvious signs of breakage.
14. CAUTION: Danger of explosion if battery is incorrectly replaced. Replace only with the same or equivalent type recommended by the manufacturer.
15. Equipment intended only for use in a RESTRICTED ACCESS AREA.
16. Ensure to connect the power cord of the power adapter to a socket-outlet with an earth connection.
17. Dispose of used batteries promptly. Keep away from children. Do not disassemble and do not dispose of in fire.

Package Contents

Before installation, please ensure all the items listed in the following table are included in the package.

Item	Description	Q'ty
1	CV-200/P2302 Series Panel PC	1
2	Heatsink Kit	1
3	Power Terminal Block	1
4	Remote Power On/Off Terminal Block Connector	1
5	DIO Terminal Block Connector	2
6	Screws Pack	4
7	PCI / PCIe Card Installation Kit (P2302E only)	1
8	M.2 Key B Type 3052 to Type 3042 Adapter Bracket	1
9	Panel Mounting Kit (The quantity varies with the size of the display module, please refer to the datasheet for the actual quantity)	1

Note: Notify your sales representative if any of the above items are missing or damaged.

Ordering Information

Available Models

Model No.	Product Description
CV-212C-R10/P2302-R10	12.1" TFT WXGA 16:10 Slim Bezel Panel PC with Intel Meteor Lake-PS Core Series (LGA Socket) Embedded Computer, Projected Capacitive Touch, and AG Coating
CV-212C-R10/P2302E-R10	12.1" TFT WXGA 16:10 Slim Bezel Panel PC with Intel Meteor Lake-PS Core Series (LGA Socket) Expandable Embedded Computer, Projected Capacitive Touch, and AG Coating
CV-215C-R10/P2302-R10	15.6" FHD 16:9 Slim Bezel Panel PC with Intel Meteor Lake-PS Core Series (LGA Socket) Embedded Computer, Projected Capacitive Touch, and AG Coating
CV-215C-R10/P2302E-R10	15.6" FHD 16:9 Slim Bezel Panel PC with Intel Meteor Lake-PS Core Series (LGA Socket) Expandable Embedded Computer, Projected Capacitive Touch, and AG Coating
CV-218C-R10/P2302-R10	18.5" FHD 16:9 Slim Bezel Panel PC with Intel Meteor Lake-PS Core Series (LGA Socket) Embedded Computer, Projected Capacitive Touch, and AG Coating

CV-218C-R10/P2302E-R10	18.5" FHD 16:9 Slim Bezel Panel PC with Intel Meteor Lake-PS Core Series (LGA Socket) Expandable Embedded Computer, Projected Capacitive Touch, and AG Coating
CV-221C-R10/P2302-R10	21.5" FHD 16:9 Slim Bezel Panel PC with Intel Meteor Lake-PS Core Series (LGA Socket) Embedded Computer, Projected Capacitive Touch, and AG Coating
CV-221C-R10/P2302E-R10	21.5" FHD 16:9 Slim Bezel Panel PC with Intel Meteor Lake-PS Core Series (LGA Socket) Expandable Embedded Computer, Projected Capacitive Touch, and AG Coating

Optional Modules and Accessories

Model No.	Product Description
CFM-IGN101	CFM Module with Power Ignition Sensing Control Function, 12V/24V Voltage Detection Selectable
CFM-PoE08-R10	CFM Module with PoE Control Function, Individual Port 25.5W (For P2302 Only)
CFM-PoE09-R10	CFM Module with PoE Control Function, Individual Port 25.5W (For P2302E Only)
MEC-LAN-2002i	M.2 2242/2260/2280 2-port 10/100/1000 Isolated Ethernet Board(-40°C~+85°C), 2x RJ45 Connector
MEC-LAN-2002i-S	M.2 2242/2260/2280 2-port 10/100/1000 Isolated Ethernet Board(-0°C~+70°C), 2x RJ45 Connector
MEC-USB-2002-SP	M.2 2242/2260/2280 2 port USB 3.2 board(-0°C~+70°C), w/ IDE 20P 90° Cable, 2x USB Type A Connector *Only one MEC-USB-2002-SP can be installed on the P2302E
MEC-USB-2002C	M.2 2242/2260/2280 2-port USB 3.2 Board(-0°C~+70°C), 2x USB Type C Connector
MEC-COM-2012	M.2 2242/2260/2280 (B+M Key) 2-port RS-232 Serial Board (-40°C~+85°C), 2x DB9 Connector
MEC-COM-2032i	M.2 2242/2260/2280 (B+M key) 2-port RS-232/422/485 isolated serial board (-40°C~+85°C), 2x DB9 Connector

RC-E4-02	Riser Card with 1x PCIe x4 Slot (For P2302E only)
RC-PI-02	Riser Card with 1x PCI Slot (For P2302E only)
UB1203	Universal Bracket with 2x DB9 Cutout for MEC-COM Expansion
UB1211	Universal Bracket with 2x RJ45 Cutout for MEC-LAN Expansion
UB1233-R10	Universal Bracket with 2x USB Type C Cutout for MEC-USB Expansion
UB1234-R10	Universal Bracket with 2x USB Type A Cutout for MEC-USB (M.2 interface) Expansion
URM01	Universal 19" Rack Mount Kit for Industrial Panel PC & Industrial Monitor
GST120A24-CIN	Adapter AC/DC 24V 5A 120W with 3pin Terminal Block Plug and Tubes, Level VI
GST220A24-CIN	Adapter AC/DC 24V 9.2A 220W with 3pin Terminal Block Plug and Tubes, Level VI
GST360A24-CIN	Adapter AC/DC 24V 15A 360W with 3pin Terminal Block Plug 5.0mm Pitch, with TUBES, Level VI

Chapter 1
Product Introductions

1.1 Overview

The CV-200 / P2302 series is a high-performance slim-bezel modular industrial panel PC, powered by the latest Intel® Core™ Ultra (Meteor Lake-PS) processors for excellent computing performance, flexible integration, and modern design. Featuring ultra-slim bezels, rich built-in I/O, and versatile expansion options, including M.2, PCI/PCIe slots, and CFM/MEC modular support (P2302E), it allows upgrades for wireless connectivity, NVMe SSD, and I/O functions. Available in 10”–21.5” Full HD sizes with rugged industrial design, it’s ideal for HMIs and production process visualization.

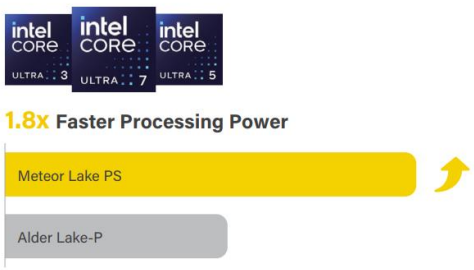
Key Features

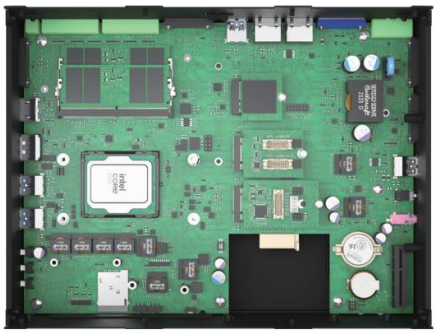
- 12.1” WXGA (1280 x 800, 16:10) and 15.6”/18.5”/21.5” Full HD (1920 x 1080, 16:9) LCD Displays
- Projected Capacitive Touch with Anti-Glare Coating.
- Wide Viewing Angle of 178°/178°
- Intel® Meteor Lake-PS Core™ Ultra 7/5/3 Processor
- Quad Independent Display (CDS / HDMI / DP / VGA)
- 1x M.2 Key E Type 2230 Socket for Wireless / Bluetooth Module Expansion
- 1x M.2 Key B Type 3052/3042 Socket for 5G/GNSS/Storage/Add-on Card Expansion
- 1x M.2 Key B Type 3042 Socket for Storage/Add-on Card Expansion
- Front Panel IP66 Compliant

Certifications

Improved Performance x Power-Saving x AI Boost

The CV-200/P2302 series supports Intel® 4 Core Ultra i7/i5/i3 U Series (Meteor Lake-PS) processors with up to 12 cores and 15W low power consumption, providing 1.8 times the performance of the previous model. The new built-in Intel NPU delivers faster and more efficient AI acceleration capabilities for high-volume image processing and AI recognition.





High Flexibility, Unlimited Applications

The CV-200/P2302 series offers outstanding flexibility, supporting Core Ultra U-series LGA CPUs for customizable performance. It features M.2 Key B/E slots for 5G, Wi-Fi, Bluetooth, NVMe SSDs, and I/O expansion. The CV-200/P2302E further supports PCI/PCIe slots for expansion cards (up to 75W, 111 × 169 mm), enabling diverse applications.

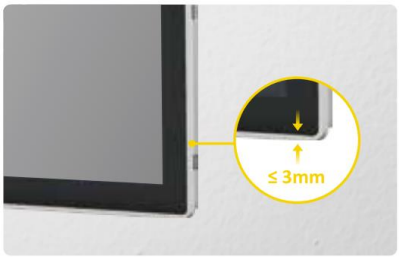
CDS Technology

Our exclusive CDS (Convertible Display System) technology enables easy maintenance in the field and simplifies future upgrades. Replacing the display or improving system performance only requires replacing a single component, significantly saving upgrade costs.



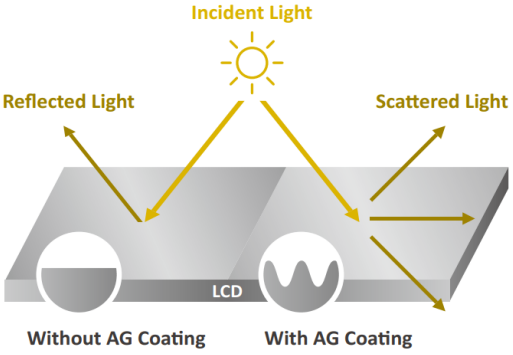
Ultra-Slim Bezel

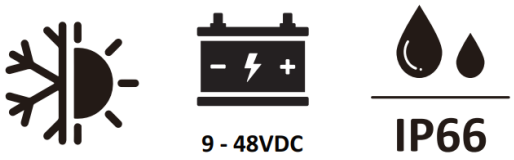
With an ultra-slim bezel of ≤ 3 mm (varies by display size), the CV-200 minimizes physical constraints for compact installations. It's ideal for space-limited enclosures and applications requiring efficient integration with a streamlined appearance.



Reliable Touch Performance

All models support P-Cap touch, anti-glare (AG) coating, and wet tracking technology, ensuring stable operation and clear visibility even in humid environments or under bright indoor lighting.





Rugged, Safe, and More Reliable

The CV-200/P2302 series has multiple industrial-grade protections for applications in harsh industrial environments such as field-side HMI or production process visualization. Industrial-grade protections include wide temperature design, wide voltage design, and waterproof and dustproof IP66 front panel.

1.2 Specifications

1.2.1 CV-212C/P2302 Series

Model Name	CV-212C
Display	
LCD Size	• 12.1” (16:10)
Max. Resolution	• 1280x800
Brightness (cd/m2)	• 400
Contrast Ratio	• 1000 : 1
LCD Color	• 16.2M
Pixel Pitch (mm)	• 0.204 (H) x 0.204 (V)
Viewing Angle (H-V)	• 178 / 178
Backlight LED Life Time	• 50,000 hrs (LED Backlight)
Touch Screen	
Touch Type	• Projected Capacitive
Anti-Glare	✓
Wet Touch Tracking	✓
Physical	
Dimension (W x D x H)	• 309.3 x 213.7 x 63.4 mm
Weight Information	• 2.13 kg
Mechanical Construction	• Die-Cast Flat Surface
Power	
Power Consumption	• 7.45 W (Typ.)
Environment	
Front Panel Protection	• IP 66 Compliant
Operating Temperature	• -20°C - 70°C (-4°F to 158°F) - With Industrial Grade peripherals; Ambient with air flow
Storage Temperature	• -30°C - 85°C (-22°F to 185°F)
Relative Humidity	• 90% RH @ 40°C (non-condensing)
EMC	• CE, UKCA, FCC, ICES-003 Class A
EMI	• CISPR 32 Conducted & Radiated: Class A • EN/BS EN 55032 Conducted & Radiated: Class A • EN/BS EN IEC 61000-3-2 Harmonic current emissions: Class A • EN/BS EN61000-3-3 Voltage fluctuations & flicker • FCC 47 CFR Part 15B, ICES-003 Conducted & Radiated: Class A
EMS	• EN/IEC 61000-4-2 ESD: Contact: 4 kV; Air: 8 kV • EN/IEC 61000-4-3 RS: 80 MHz to 1000 MHz: 3 V/m • EN/IEC 61000-4-4 EFT: AC Power: 1 kV; DC Power: 0.5 kV; Signal: 0.5 kV • EN/IEC 61000-4-5 Surges: AC Power: 2 kV; Signal: 1 kV

	• EN/IEC 61000-4-6 CS: 3V • EN/IEC 61000-4-8 PFMF: 50 Hz, 1A/m • EN/IEC 61000-4-11 Voltage Dips & Voltage Interruptions: 0.5 cycles at 50 Hz
Industrial Environment	• EMC: - EN/BS/IEC 61000-6-4: 2019 Class A - EN/BS/IEC 61000-6-2: 2019
Railway	• EMC: EN 50155: 2021 Clause 4.4.6, 13.4.9 (w/ M1101 only) - EN 50121-1: 2017 - EN 50121-3-2: 2016 + A1: 2019

Model Name	**P2302**	**P2302E**
System		
Processor	• Intel® Meteor Lake-PS Core™ Ultra 7/5/3 Processor • Intel® Core™ Ultra 7 Processor 165UL 12 Cores Up to 4.9 GHz, TDP 15W • Intel® Core™ Ultra 7 Processor 155UL 12 Cores Up to 4.8 GHz, TDP 15W • Intel® Core™ Ultra 5 Processor 135UL 12 Cores Up to 4.4 GHz, TDP 15W • Intel® Core™ Ultra 5 Processor 125UL 12 Cores Up to 4.3 GHz, TDP 15W • Intel® Core™ Ultra 3 Processor 105UL 8 Cores Up to 4.2 GHz, TDP 15W	
Memory	• 2x DDR5 5600 MHz SO-DIMM Socket, Supports Un-buffered and non-ECC Type, Up to 96 GB	
BIOS	• AMI BIOS	
Graphics		
Graphics Engine	• Intel® Graphics	
Maximum Display Output	• Supports Quad Independent Display	
CDS	• 1x CDS Connector (1920 x 1080 @60Hz)	
DP	• 1x DisplayPort Connector (4096 x 2304 @60Hz) * Verified maximum resolution: 3840 x 2160 @ 60Hz	
HDMI	• 1x HDMI Connector (3840 x 2160 @30Hz)	
VGA	• 1x VGA Connector (1920 x 1080 @60Hz)	
Audio		
Audio Codec	• Realtek® ALC888, High Definition Audio	
Line-out	• 1x Line-out, Phone Jack 3.5mm	
Mic-in	• 1x Mic-in, Phone Jack 3.5mm	
I/O		
LAN	• 2x 2.5 GbE LAN, RJ45 - GbE1: Intel® I226 - GbE2: Intel® I226	
COM	• 4x RS-232/422/485 with Auto Flow Control (Supports 5V/12V), DB9	
USB	• 2 x USB 3.2 Gen2x1 (10Gbps), Type A	

	• 1 x USB 3.2 Gen1x1 (5Gbps), Type A • 1 x USB 2.0 (480Mbps), Type A	
DIO	• 16x Isolated Digital I/O (8in/8out), 20-Pin Terminal Block	
Storage/ Expansion		
2.5” SSD/HDD	• 2x 2.5” SATA HDD/SSD Bay (SATA3.0)	
M.2 Key E Socket	• 1x M.2 Key E Type 2230 Socket (PCIe Gen 3x1 / USB2.0), Support Wireless/Bluetooth Module Expansion	
M.2 Key B Socket	• 1x M.2 Key B Type 3042/3052 Socket (PCIe Gen 4x2 / USB3.2 Gen2 x1 / USB2.0), Support 5G/GNSS/Storage/Add-on Card Expansion • 1x M.2 Key B Type 3042 (PCIe Gen 3x2/USB2.0), Support Storage/Add-on Card Expansion	
PCI Express		• 1x PCI or 1x PCIe Gen3 x4 Expansion slot (with Optional Riser Card) • Supports maximum dimensions of add-on card (H x L): 111 x 169mm
SIM Socket	• 1 x Front Accessible SIM Socket	
CFM (Control Function Module) Interface	• 1x CFM Interface for optional IGN Module Expansion • 1x CFM Interface for optional PoE Module Expansion	
Other Function		
RAID	• RAID 0/1	
Clear CMOS Switch	• 1x Clear CMOS Switch	
Reset Button	• 1x Reset Button	
Watchdog Timer	• Software Programmable Supports 256 Levels System Reset	
OSD Button	• LCD On/Off, Brightness Up, Brightness Down	
Internal Speaker	• AMP 2W + 2W	
Status LED Indicator	• Power LED, Storage LED	
Antenna Holes	• 6x Antenna Holes	
Power		
Power Button	• 1x ATX Power On/Off Button	
Power Mode Switch	• 1x AT/ATX Mode Switch	
Power Input	• 9 - 48VDC, 3-pin Terminal Block	
Remote Power On/Off	• 1x Remote Power On/Off, 2-pin Terminal Block	
Max. Power Consumption	• Intel Core™ Ultra 7 Processor 165UL: 79.7W - Test conducted with CPU, 1x RAM, and 1x storage - 100% load during burn-in testing	
Inrush Current (Peak)	• Intel Core™ Ultra 7 Processor 165UL: 5.010 A@24V	
Operating System		
Windows	• Windows®11, Windows®10	
Linux	• Ubuntu Desktop 24.04 LTS	
Physical		

Dimension (W x D x H)	• 254.5 x 190 x 49.5 mm	• 254.5 x 190 x 69 mm
Weight Information	• 2.16 kg	• 2.26 kg
Mechanical Construction	• Extruded Aluminum with Heavy Duty Metal	
Mounting	• Wall / VESA / CDS / DIN Rail	
Physical Design	• Fanless Design • Jumper-less Design	
Reliability & Protection		
Reverse Power Input Protection	• Yes	
Over Voltage Protection	• Protection Range: 51-58V • Protection Type: shut down operating voltage, re-power on at the preset level to recover	
Over Current Protection	• 15A	
CMOS Battery Backup	• SuperCap Integrated for CMOS Battery Maintenance-free Operation	
MTBF	• 206,043 Hours - Database: Telcordia SR-332 Issue3, Method 1, Case 3	
Environment		
Operating Temperature	• -40°C to 65°C (-40°F to 149°F) *PassMark BurnIn Test: 100% CPU, 2D/3D Graphics (without thermal throttling *With extended temperature peripherals; Ambient with air flow *According to IEC60068-2-1, IEC60068-2-2, IEC60068-2-14	
Storage Temperature	• -40°C to 85°C (-40°F to 185°F)	
Relative Humidity	• 95%RH @ 65°C (Non-condensing)	
Shock	• Operating, 50 Grms (w/SSD, according to IEC60068-2-27) • MIL-STD-810H	
Vibration	• Operating, 1 Grms, 10-500 Hz, 3 Axes (w/SSD, according to IEC60068-2-6) • MIL-STD-810H	
EMC	• CE, UKCA, FCC, ICES-003 Class A	
EMI	• CISPR 32 Conducted & Radiated: Class A • EN/BS EN 55032 Conducted & Radiated: Class A • EN/BS EN IEC 61000-3-2 Harmonic current emissions: Class A • EN/BS EN61000-3-3 Voltage fluctuations & flicker • FCC 47 CFR Part 15B, ICES-003 Conducted & Radiated: Class A	
EMS	• EN/IEC 61000-4-2 ESD: Contact: 4 kV; Air: 8 kV • EN/IEC 61000-4-3 RS: 80 MHz to 1000 MHz: 10 V/m • EN/IEC 61000-4-4 EFT: AC Power: 2 kV; DC Power: 1 kV; Signal: 1 kV • EN/IEC 61000-4-5 Surges: AC Power: 2 kV; Signal: 1 kV • EN/IEC 61000-4-6 CS: 10V • EN/IEC 61000-4-8 PFMF: 50 Hz, 30A/m • EN/IEC 61000-4-11 Voltage Dips & Voltage Interruptions: 1 cycles at 60 Hz	
Industrial Environment	• EMC	

	- EN/BS/IEC 61000-6-4: 2019 Class A - EN/BS/IEC 61000-6-2: 2019
Safety	• UL, cUL, CB, IEC, EN 62368-1

** Product Specifications and features are for reference only and are subject to change without prior notice. For more information, please refer to the latest product datasheet from Cincoze's website.*

1.2.2 CV-215C/P2302 Series

Model Name	CV-215C
Display	
LCD Size	• 15.6” (16:9)
Max. Resolution	• 1920x1080
Brightness (cd/m2)	• 350
Contrast Ratio	• 800 : 1
LCD Color	• 16.7M
Pixel Pitch (mm)	• 0.17925 (H) x 0.17925 (V)
Viewing Angle (H-V)	• 178 / 178
Backlight LED Life Time	• 50,000 hrs (LED Backlight)
Touch Screen	
Touch Type	• Projected Capacitive
Anti-Glare	✓
Wet Touch Tracking	✓
Physical	
Dimension (W x D x H)	• 389.3 x 239.9 x 63.4 mm
Weight Information	• 3.12 kg
Mechanical Construction	• Die-Cast Flat Surface
Power	
Power Consumption	• 11.45 W (Typ.)
Environment	
Front Panel Protection	• IP 66 Compliant
Operating Temperature	• -20°C - 70°C (-4°F to 158°F) - With Industrial Grade peripherals; Ambient with air flow
Storage Temperature	• -30°C - 70°C (-22°F to 158°F)
Relative Humidity	• 90% RH @ 40°C (non-condensing)
EMC	• CE, UKCA, FCC, ICES-003 Class A
EMI	• CISPR 32 Conducted & Radiated: Class A • EN/BS EN 55032 Conducted & Radiated: Class A • EN/BS EN IEC 61000-3-2 Harmonic current emissions: Class A • EN/BS EN61000-3-3 Voltage fluctuations & flicker • FCC 47 CFR Part 15B, ICES-003 Conducted & Radiated: Class A
EMS	• EN/IEC 61000-4-2 ESD: Contact: 4 kV; Air: 8 kV • EN/IEC 61000-4-3 RS: 80 MHz to 1000 MHz: 3 V/m • EN/IEC 61000-4-4 EFT: AC Power: 1 kV; DC Power: 0.5 kV; Signal: 0.5 kV • EN/IEC 61000-4-5 Surges: AC Power: 2 kV; Signal: 1 kV • EN/IEC 61000-4-6 CS: 3V • EN/IEC 61000-4-8 PFMF: 50 Hz, 1A/m

	• EN/IEC 61000-4-11 Voltage Dips & Voltage Interruptions: 0.5 cycles at 50 Hz
Industrial Environment	• EMC: - EN/BS/IEC 61000-6-4: 2019 Class A - EN/BS/IEC 61000-6-2: 2019
Railway	• EMC: EN 50155: 2021 Clause 4.4.6, 13.4.9 (w/ M1101 only) - EN 50121-1: 2017 - EN 50121-3-2: 2016 + A1: 2019

Model Name	**P2302**	**P2302E**
System		
Processor	• Intel® Meteor Lake-PS Core™ Ultra 7/5/3 Processor • Intel® Core™ Ultra 7 Processor 165UL 12 Cores Up to 4.9 GHz, TDP 15W • Intel® Core™ Ultra 7 Processor 155UL 12 Cores Up to 4.8 GHz, TDP 15W • Intel® Core™ Ultra 5 Processor 135UL 12 Cores Up to 4.4 GHz, TDP 15W • Intel® Core™ Ultra 5 Processor 125UL 12 Cores Up to 4.3 GHz, TDP 15W • Intel® Core™ Ultra 3 Processor 105UL 8 Cores Up to 4.2 GHz, TDP 15W	
Memory	• 2x DDR5 5600 MHz SO-DIMM Socket, Supports Un-buffered and non-ECC Type, Up to 96 GB	
BIOS	• AMI BIOS	
Graphics		
Graphics Engine	• Intel® Graphics	
Maximum Display Output	• Supports Quad Independent Display	
CDS	• 1x CDS Connector (1920 x 1080 @60Hz)	
DP	• 1x DisplayPort Connector (4096 x 2304 @60Hz) * Verified maximum resolution: 3840 x 2160 @ 60Hz	
HDMI	• 1x HDMI Connector (3840 x 2160 @30Hz)	
VGA	• 1x VGA Connector (1920 x 1080 @60Hz)	
Audio		
Audio Codec	• Realtek® ALC888, High Definition Audio	
Line-out	• 1x Line-out, Phone Jack 3.5mm	
Mic-in	• 1x Mic-in, Phone Jack 3.5mm	
I/O		
LAN	• 2x 2.5 GbE LAN, RJ45 - GbE1: Intel® I226 - GbE2: Intel® I226	
COM	• 4x RS-232/422/485 with Auto Flow Control (Supports 5V/12V), DB9	
USB	• 2 x USB 3.2 Gen2x1 (10Gbps), Type A • 1 x USB 3.2 Gen1x1 (5Gbps), Type A • 1 x USB 2.0 (480Mbps), Type A	

DIO	• 16x Isolated Digital I/O (8in/8out), 20-Pin Terminal Block	
Storage/ Expansion		
2.5” SSD/HDD	• 2x 2.5” SATA HDD/SSD Bay (SATA3.0)	
M.2 Key E Socket	• 1x M.2 Key E Type 2230 Socket (PCIe Gen 3x1 / USB2.0), Support Wireless/Bluetooth Module Expansion	
M.2 Key B Socket	• 1x M.2 Key B Type 3042/3052 Socket (PCIe Gen 4x2 / USB3.2 Gen2 x1 / USB2.0), Support 5G/GNSS/Storage/Add-on Card Expansion • 1x M.2 Key B Type 3042 (PCIe Gen 3x2/USB2.0), Support Storage/Add-on Card Expansion	
PCI Express		• 1x PCI or 1x PCIe Gen3 x4 Expansion slot (with Optional Riser Card) • Supports maximum dimensions of add-on card (H x L): 111 x 169mm
SIM Socket	• 1 x Front Accessible SIM Socket	
CFM (Control Function Module) Interface	• 1x CFM Interface for optional IGN Module Expansion • 1x CFM Interface for optional PoE Module Expansion	
Other Function		
RAID	• RAID 0/1	
Clear CMOS Switch	• 1x Clear CMOS Switch	
Reset Button	• 1x Reset Button	
Watchdog Timer	• Software Programmable Supports 256 Levels System Reset	
OSD Button	• LCD On/Off, Brightness Up, Brightness Down	
Internal Speaker	• AMP 2W + 2W	
Status LED Indicator	• Power LED, Storage LED	
Antenna Holes	• 6x Antenna Holes	
Power		
Power Button	• 1x ATX Power On/Off Button	
Power Mode Switch	• 1x AT/ATX Mode Switch	
Power Input	• 9 - 48VDC, 3-pin Terminal Block	
Remote Power On/Off	• 1x Remote Power On/Off, 2-pin Terminal Block	
Max. Power Consumption	• Intel Core™ Ultra 7 Processor 165UL: 79.7W - Test conducted with CPU, 1x RAM, and 1x storage - 100% load during burn-in testing	
Inrush Current (Peak)	• Intel Core™ Ultra 7 Processor 165UL: 5.010 A@24V	
Operating System		
Windows	• Windows®11, Windows®10	
Linux	• Ubuntu Desktop 24.04 LTS	
Physical		
Dimension (W x D x H)	• 254.5 x 190 x 49.5 mm	• 254.5 x 190 x 69 mm
Weight Information	• 2.16 kg	• 2.26 kg

Mechanical Construction	• Extruded Aluminum with Heavy Duty Metal
Mounting	• Wall / VESA / CDS / DIN Rail
Physical Design	• Fanless Design • Jumper-less Design
Reliability & Protection	
Reverse Power Input Protection	• Yes
Over Voltage Protection	• Protection Range: 51-58V • Protection Type: shut down operating voltage, re-power on at the preset level to recover
Over Current Protection	• 15A
CMOS Battery Backup	• SuperCap Integrated for CMOS Battery Maintenance-free Operation
MTBF	• 206,043 Hours - Database: Telcordia SR-332 Issue3, Method 1, Case 3
Environment	
Operating Temperature	• -40°C to 65°C (-40°F to 149°F) *PassMark BurnIn Test: 100% CPU, 2D/3D Graphics (without thermal throttling *With extended temperature peripherals; Ambient with air flow *According to IEC60068-2-1, IEC60068-2-2, IEC60068-2-14
Storage Temperature	• -40°C to 85°C (-40°F to 185°F)
Relative Humidity	• 95%RH @ 65°C (Non-condensing)
Shock	• Operating, 50 Grms (w/SSD, according to IEC60068-2-27) • MIL-STD-810H
Vibration	• Operating, 1 Grms, 10-500 Hz, 3 Axes (w/SSD, according to IEC60068-2-6) • MIL-STD-810H
EMC	• CE, UKCA, FCC, ICES-003 Class A
EMI	• CISPR 32 Conducted & Radiated: Class A • EN/BS EN 55032 Conducted & Radiated: Class A • EN/BS EN IEC 61000-3-2 Harmonic current emissions: Class A • EN/BS EN61000-3-3 Voltage fluctuations & flicker • FCC 47 CFR Part 15B, ICES-003 Conducted & Radiated: Class A
EMS	• EN/IEC 61000-4-2 ESD: Contact: 4 kV; Air: 8 kV • EN/IEC 61000-4-3 RS: 80 MHz to 1000 MHz: 10 V/m • EN/IEC 61000-4-4 EFT: AC Power: 2 kV; DC Power: 1 kV; Signal: 1 kV • EN/IEC 61000-4-5 Surges: AC Power: 2 kV; Signal: 1 kV • EN/IEC 61000-4-6 CS: 10V • EN/IEC 61000-4-8 PFMF: 50 Hz, 30A/m • EN/IEC 61000-4-11 Voltage Dips & Voltage Interruptions: 1 cycles at 60 Hz
Industrial Environment	• EMC - EN/BS/IEC 61000-6-4: 2019 Class A - EN/BS/IEC 61000-6-2: 2019

Safety	• UL, cUL, CB, IEC, EN 62368-1

** Product Specifications and features are for reference only and are subject to change without prior notice. For more information, please refer to the latest product datasheet from Cincoze's website.*

1.2.3 CV-218C/P2302 Series

Model Name	CV-218C
Display	
LCD Size	• 18.5” (16:9)
Max. Resolution	• 1920x1080
Brightness (cd/m2)	• 350
Contrast Ratio	• 1000 : 1
LCD Color	• 16.7M
Pixel Pitch (mm)	• 0.213 (H) x 0.213 (V)
Viewing Angle (H-V)	• 178 / 178
Backlight LED Life Time	• 50,000 hrs (LED Backlight)
Touch Screen	
Touch Type	• Projected Capacitive
Anti-Glare	✓
Wet Touch Tracking	✓
Physical	
Dimension (W x D x H)	• 457.3 x 279.9 x 63.4 mm
Weight Information	• 4.47 kg
Mechanical Construction	• Die-Cast Flat Surface
Power	
Power Consumption	• 21.4 W (Typ.)
Environment	
Front Panel Protection	• IP 66 Compliant
Operating Temperature	• -20°C - 70°C (-4°F to 158°F) - With Industrial Grade peripherals; Ambient with air flow
Storage Temperature	• -30°C - 80°C (-22°F to 176°F)
Relative Humidity	• 90% RH @ 40°C (non-condensing)
EMC	• CE, UKCA, FCC, ICES-003 Class A
EMI	• CISPR 32 Conducted & Radiated: Class A • EN/BS EN 55032 Conducted & Radiated: Class A • EN/BS EN IEC 61000-3-2 Harmonic current emissions: Class A • EN/BS EN61000-3-3 Voltage fluctuations & flicker • FCC 47 CFR Part 15B, ICES-003 Conducted & Radiated: Class A
EMS	• EN/IEC 61000-4-2 ESD: Contact: 4 kV; Air: 8 kV • EN/IEC 61000-4-3 RS: 80 MHz to 1000 MHz: 3 V/m • EN/IEC 61000-4-4 EFT: AC Power: 1 kV; DC Power: 0.5 kV; Signal: 0.5 kV • EN/IEC 61000-4-5 Surges: AC Power: 2 kV; Signal: 1 kV • EN/IEC 61000-4-6 CS: 3V • EN/IEC 61000-4-8 PFMF: 50 Hz, 1A/m

	• EN/IEC 61000-4-11 Voltage Dips & Voltage Interruptions: 0.5 cycles at 50 Hz
Industrial Environment	• EMC: - EN/BS/IEC 61000-6-4: 2019 Class A - EN/BS/IEC 61000-6-2: 2019
Railway	• EMC: EN 50155: 2021 Clause 4.4.6, 13.4.9 (w/ M1101 only) - EN 50121-1: 2017 - EN 50121-3-2: 2016 + A1: 2019

Model Name	P2302	P2302E
System		
Processor	• Intel® Meteor Lake-PS Core™ Ultra 7/5/3 Processor • Intel® Core™ Ultra 7 Processor 165UL 12 Cores Up to 4.9 GHz, TDP 15W • Intel® Core™ Ultra 7 Processor 155UL 12 Cores Up to 4.8 GHz, TDP 15W • Intel® Core™ Ultra 5 Processor 135UL 12 Cores Up to 4.4 GHz, TDP 15W • Intel® Core™ Ultra 5 Processor 125UL 12 Cores Up to 4.3 GHz, TDP 15W • Intel® Core™ Ultra 3 Processor 105UL 8 Cores Up to 4.2 GHz, TDP 15W	
Memory	• 2x DDR5 5600 MHz SO-DIMM Socket, Supports Un-buffered and non-ECC Type, Up to 96 GB	
BIOS	• AMI BIOS	
Graphics		
Graphics Engine	• Intel® Graphics	
Maximum Display Output	• Supports Quad Independent Display	
CDS	• 1x CDS Connector (1920 x 1080 @60Hz)	
DP	• 1x DisplayPort Connector (4096 x 2304 @60Hz) * Verified maximum resolution: 3840 x 2160 @ 60Hz	
HDMI	• 1x HDMI Connector (3840 x 2160 @30Hz)	
VGA	• 1x VGA Connector (1920 x 1080 @60Hz)	
Audio		
Audio Codec	• Realtek® ALC888, High Definition Audio	
Line-out	• 1x Line-out, Phone Jack 3.5mm	
Mic-in	• 1x Mic-in, Phone Jack 3.5mm	
I/O		
LAN	• 2x 2.5 GbE LAN, RJ45 - GbE1: Intel® I226 - GbE2: Intel® I226	
COM	• 4x RS-232/422/485 with Auto Flow Control (Supports 5V/12V), DB9	
USB	• 2 x USB 3.2 Gen2x1 (10Gbps), Type A • 1 x USB 3.2 Gen1x1 (5Gbps), Type A • 1 x USB 2.0 (480Mbps), Type A	

DIO	• 16x Isolated Digital I/O (8in/8out), 20-Pin Terminal Block	
Storage/ Expansion		
2.5” SSD/HDD	• 2x 2.5” SATA HDD/SSD Bay (SATA3.0)	
M.2 Key E Socket	• 1x M.2 Key E Type 2230 Socket (PCIe Gen 3x1 / USB2.0), Support Wireless/Bluetooth Module Expansion	
M.2 Key B Socket	• 1x M.2 Key B Type 3042/3052 Socket (PCIe Gen 4x2 / USB3.2 Gen2 x1 / USB2.0), Support 5G/GNSS/Storage/Add-on Card Expansion • 1x M.2 Key B Type 3042 (PCIe Gen 3x2/USB2.0), Support Storage/Add-on Card Expansion	
PCI Express		• 1x PCI or 1x PCIe Gen3 x4 Expansion slot (with Optional Riser Card) • Supports maximum dimensions of add-on card (H x L): 111 x 169mm
SIM Socket	• 1 x Front Accessible SIM Socket	
CFM (Control Function Module) Interface	• 1x CFM Interface for optional IGN Module Expansion • 1x CFM Interface for optional PoE Module Expansion	
Other Function		
RAID	• RAID 0/1	
Clear CMOS Switch	• 1x Clear CMOS Switch	
Reset Button	• 1x Reset Button	
Watchdog Timer	• Software Programmable Supports 256 Levels System Reset	
OSD Button	• LCD On/Off, Brightness Up, Brightness Down	
Internal Speaker	• AMP 2W + 2W	
Status LED Indicator	• Power LED, Storage LED	
Antenna Holes	• 6x Antenna Holes	
Power		
Power Button	• 1x ATX Power On/Off Button	
Power Mode Switch	• 1x AT/ATX Mode Switch	
Power Input	• 9 - 48VDC, 3-pin Terminal Block	
Remote Power On/Off	• 1x Remote Power On/Off, 2-pin Terminal Block	
Max. Power Consumption	• Intel Core™ Ultra 7 Processor 165UL: 79.7W - Test conducted with CPU, 1x RAM, and 1x storage - 100% load during burn-in testing	
Inrush Current (Peak)	• Intel Core™ Ultra 7 Processor 165UL: 5.010 A@24V	
Operating System		
Windows	• Windows®11, Windows®10	
Linux	• Ubuntu Desktop 24.04 LTS	
Physical		
Dimension (W x D x H)	• 254.5 x 190 x 49.5 mm	• 254.5 x 190 x 69 mm
Weight Information	• 2.16 kg	• 2.26 kg

Mechanical Construction	• Extruded Aluminum with Heavy Duty Metal
Mounting	• Wall / VESA / CDS / DIN Rail
Physical Design	• Fanless Design • Jumper-less Design
Reliability & Protection	
Reverse Power Input Protection	• Yes
Over Voltage Protection	• Protection Range: 51-58V • Protection Type: shut down operating voltage, re-power on at the preset level to recover
Over Current Protection	• 15A
CMOS Battery Backup	• SuperCap Integrated for CMOS Battery Maintenance-free Operation
MTBF	• 206,043 Hours - Database: Telcordia SR-332 Issue3, Method 1, Case 3
Environment	
Operating Temperature	• -40°C to 65°C (-40°F to 149°F) *PassMark BurnIn Test: 100% CPU, 2D/3D Graphics (without thermal throttling *With extended temperature peripherals; Ambient with air flow *According to IEC60068-2-1, IEC60068-2-2, IEC60068-2-14
Storage Temperature	• -40°C to 85°C (-40°F to 185°F)
Relative Humidity	• 95%RH @ 65°C (Non-condensing)
Shock	• Operating, 50 Grms (w/SSD, according to IEC60068-2-27) • MIL-STD-810H
Vibration	• Operating, 1 Grms, 10-500 Hz, 3 Axes (w/SSD, according to IEC60068-2-6) • MIL-STD-810H
EMC	• CE, UKCA, FCC, ICES-003 Class A
EMI	• CISPR 32 Conducted & Radiated: Class A • EN/BS EN 55032 Conducted & Radiated: Class A • EN/BS EN IEC 61000-3-2 Harmonic current emissions: Class A • EN/BS EN61000-3-3 Voltage fluctuations & flicker • FCC 47 CFR Part 15B, ICES-003 Conducted & Radiated: Class A
EMS	• EN/IEC 61000-4-2 ESD: Contact: 4 kV; Air: 8 kV • EN/IEC 61000-4-3 RS: 80 MHz to 1000 MHz: 10 V/m • EN/IEC 61000-4-4 EFT: AC Power: 2 kV; DC Power: 1 kV; Signal: 1 kV • EN/IEC 61000-4-5 Surges: AC Power: 2 kV; Signal: 1 kV • EN/IEC 61000-4-6 CS: 10V • EN/IEC 61000-4-8 PFMF: 50 Hz, 30A/m • EN/IEC 61000-4-11 Voltage Dips & Voltage Interruptions: 1 cycles at 60 Hz
Industrial Environment	• EMC - EN/BS/IEC 61000-6-4: 2019 Class A - EN/BS/IEC 61000-6-2: 2019

Safety	• UL, cUL, CB, IEC, EN 62368-1

** Product Specifications and features are for reference only and are subject to change without prior notice. For more information, please refer to the latest product datasheet from Cincoze's website.*

1.2.4 CV-221C/P2302 Series

Model Name	CV-221C
Display	
LCD Size	• 21.5” (16:9)
Max. Resolution	• 1920 x 1080
Brightness (cd/m2)	• 300
Contrast Ratio	• 5000:1
LCD Color	• 16.7M
Pixel Pitch (mm)	• 0.24825 (H) x 0.24825 (V)
Viewing Angle (V-H)	• 178 / 178
Backlight LED Life Time	• 50,000 hrs (LED Backlight)
Touch Screen	
Touch Type	• Projected Capacitive
Anti-Glare	✓
Wet Touch Tracking	✓
Physical	
Dimension (W x D x H)	• 522.4 x 318.3 x 63.4 mm
Weight Information	• 5.28 kg
Mechanical Construction	• Die-Cast Flat Surface
Power	
Power Consumption	• 24.8 W (Max.)
Environment	
Front Panel Protection	• IP 66 Compliant
Operating Temperature	• 0°C - 60°C (32°F to 140°F) - with Industrial Grade peripherals; Ambient with air flow
Storage Temperature	• -20°C - 60°C (-4°F to 140°F)
Relative Humidity	• 90% RH @ 40°C (non-condensing)
EMC	• CE, UKCA, FCC, ICES-003 Class A
EMI	• CISPR 32 Conducted & Radiated: Class A • EN/BS EN 55032 Conducted & Radiated: Class A • EN/BS EN 50121-3-2 Conducted & Radiated: Class A • EN/BS EN IEC 61000-3-2 Harmonic current emissions: Class A • EN/BS EN61000-3-3 Voltage fluctuations & flicker • FCC 47 CFR Part 15B, ICES-003 Conducted & Radiated: Class A
EMS	• EN/IEC 61000-4-2 ESD: Contact: 6 kV; Air: 8 kV • EN/IEC 61000-4-3 RS: 80 MHz to 1000 MHz: 20 V/m • EN/IEC 61000-4-4 EFT: AC Power: 2 kV; DC Power: 1 kV; Signal: 2 kV • EN/IEC 61000-4-5 Surges: AC Power: 2 kV; Signal: 1 kV • EN/IEC 61000-4-6 CS: 10V

	(**Compliant with the standard when utilizing shielded cable.) • EN/IEC 61000-4-8 PFMF: 50/60 Hz, 30A/m • EN/IEC 61000-4-11 (50/60 Hz): Voltage dips duration up to 25/30 cycles; interruptions up to 250/300 cycles
Industrial Environment	• EMC: - EN/BS/IEC 61000-6-4: 2019 Class A - EN/BS/IEC 61000-6-2: 2019
Railway	• EMC: EN 50155: 2021 Clause 4.4.6, 13.4.9 (w/ M1101 only) - EN 50121-1: 2017 - EN 50121-3-2: 2016 + A1: 2019

Model Name	**P2302**	**P2302E**
System		
Processor	• Intel® Meteor Lake-PS Core™ Ultra 7/5/3 Processor • Intel® Core™ Ultra 7 Processor 165UL 12 Cores Up to 4.9 GHz, TDP 15W • Intel® Core™ Ultra 7 Processor 155UL 12 Cores Up to 4.8 GHz, TDP 15W • Intel® Core™ Ultra 5 Processor 135UL 12 Cores Up to 4.4 GHz, TDP 15W • Intel® Core™ Ultra 5 Processor 125UL 12 Cores Up to 4.3 GHz, TDP 15W • Intel® Core™ Ultra 3 Processor 105UL 8 Cores Up to 4.2 GHz, TDP 15W	
Memory	• 2x DDR5 5600 MHz SO-DIMM Socket, Supports Un-buffered and non-ECC Type, Up to 96 GB	
BIOS	• AMI BIOS	
Graphics		
Graphics Engine	• Intel® Graphics	
Maximum Display Output	• Supports Quad Independent Display	
CDS	• 1x CDS Connector (1920 x 1080 @60Hz)	
DP	• 1x DisplayPort Connector (4096 x 2304 @60Hz) * Verified maximum resolution: 3840 x 2160 @ 60Hz	
HDMI	• 1x HDMI Connector (3840 x 2160 @30Hz)	
VGA	• 1x VGA Connector (1920 x 1080 @60Hz)	
Audio		
Audio Codec	• Realtek® ALC888, High Definition Audio	
Line-out	• 1x Line-out, Phone Jack 3.5mm	
Mic-in	• 1x Mic-in, Phone Jack 3.5mm	
I/O		
LAN	• 2x 2.5 GbE LAN, RJ45 - GbE1: Intel® I226	

	- GbE2: Intel® I226	
COM	• 4x RS-232/422/485 with Auto Flow Control (Supports 5V/12V), DB9	
USB	• 2 x USB 3.2 Gen2x1 (10Gbps), Type A • 1 x USB 3.2 Gen1x1 (5Gbps), Type A • 1 x USB 2.0 (480Mbps), Type A	
DIO	• 16x Isolated Digital I/O (8in/8out), 20-Pin Terminal Block	
Storage/ Expansion		
2.5” SSD/HDD	• 2x 2.5” SATA HDD/SSD Bay (SATA3.0)	
M.2 Key E Socket	• 1x M.2 Key E Type 2230 Socket (PCIe Gen 3x1 / USB2.0), Support Wireless/Bluetooth Module Expansion	
M.2 Key B Socket	• 1x M.2 Key B Type 3042/3052 Socket (PCIe Gen 4x2 / USB3.2 Gen2 x1 / USB2.0), Support 5G/GNSS/Storage/Add-on Card Expansion • 1x M.2 Key B Type 3042 (PCIe Gen 3x2/USB2.0), Support Storage/Add-on Card Expansion	
PCI Express		• 1x PCI or 1x PCIe Gen3 x4 Expansion slot (with Optional Riser Card) • Supports maximum dimensions of add-on card (H x L): 111 x 169mm
SIM Socket	• 1 x Front Accessible SIM Socket	
CFM (Control Function Module) Interface	• 1x CFM Interface for optional IGN Module Expansion • 1x CFM Interface for optional PoE Module Expansion	
Other Function		
RAID	• RAID 0/1	
Clear CMOS Switch	• 1x Clear CMOS Switch	
Reset Button	• 1x Reset Button	
Watchdog Timer	• Software Programmable Supports 256 Levels System Reset	
OSD Button	• LCD On/Off, Brightness Up, Brightness Down	
Internal Speaker	• AMP 2W + 2W	
Status LED Indicator	• Power LED, Storage LED	
Antenna Holes	• 6x Antenna Holes	
Power		
Power Button	• 1x ATX Power On/Off Button	
Power Mode Switch	• 1x AT/ATX Mode Switch	
Power Input	• 9 - 48VDC, 3-pin Terminal Block	
Remote Power On/Off	• 1x Remote Power On/Off, 2-pin Terminal Block	
Max. Power Consumption	• Intel Core™ Ultra 7 Processor 165UL: 79.7W - Test conducted with CPU, 1x RAM, and 1x storage - 100% load during burn-in testing	
Inrush Current (Peak)	• Intel Core™ Ultra 7 Processor 165UL: 5.010 A@24V	
Operating System		

Windows	• Windows®11, Windows®10	
Linux	• Ubuntu Desktop 24.04 LTS	
Physical		
Dimension (W x D x H)	• 254.5 x 190 x 49.5 mm	• 254.5 x 190 x 69 mm
Weight Information	• 2.16 kg	• 2.26 kg
Mechanical Construction	• Extruded Aluminum with Heavy Duty Metal	
Mounting	• Wall / VESA / CDS / DIN Rail	
Physical Design	• Fanless Design • Jumper-less Design	
Reliability & Protection		
Reverse Power Input Protection	• Yes	
Over Voltage Protection	• Protection Range: 51-58V • Protection Type: shut down operating voltage, re-power on at the preset level to recover	
Over Current Protection	• 15A	
CMOS Battery Backup	• SuperCap Integrated for CMOS Battery Maintenance-free Operation	
MTBF	• 206,043 Hours - Database: Telcordia SR-332 Issue3, Method 1, Case 3	
Environment		
Operating Temperature	• -40°C to 65°C (-40°F to 149°F) *PassMark BurnIn Test: 100% CPU, 2D/3D Graphics (without thermal throttling *With extended temperature peripherals; Ambient with air flow *According to IEC60068-2-1, IEC60068-2-2, IEC60068-2-14	
Storage Temperature	• -40°C to 85°C (-40°F to 185°F)	
Relative Humidity	• 95%RH @ 65°C (Non-condensing)	
Shock	• Operating, 50 Grms (w/SSD, according to IEC60068-2-27) • MIL-STD-810H	
Vibration	• Operating, 1 Grms, 10-500 Hz, 3 Axes (w/SSD, according to IEC60068-2-6) • MIL-STD-810H	
EMC	• CE, UKCA, FCC, ICES-003 Class A	
EMI	• CISPR 32 Conducted & Radiated: Class A • EN/BS EN 55032 Conducted & Radiated: Class A • EN/BS EN IEC 61000-3-2 Harmonic current emissions: Class A • EN/BS EN61000-3-3 Voltage fluctuations & flicker • FCC 47 CFR Part 15B, ICES-003 Conducted & Radiated: Class A	
EMS	• EN/IEC 61000-4-2 ESD: Contact: 4 kV; Air: 8 kV • EN/IEC 61000-4-3 RS: 80 MHz to 1000 MHz: 10 V/m • EN/IEC 61000-4-4 EFT: AC Power: 2 kV; DC Power: 1 kV; Signal: 1 kV • EN/IEC 61000-4-5 Surges: AC Power: 2 kV; Signal: 1 kV • EN/IEC 61000-4-6 CS: 10V	

	• EN/IEC 61000-4-8 PFMF: 50 Hz, 30A/m • EN/IEC 61000-4-11 Voltage Dips & Voltage Interruptions: 1 cycles at 60 Hz
Industrial Environment	• EMC - EN/BS/IEC 61000-6-4: 2019 Class A - EN/BS/IEC 61000-6-2: 2019
Safety	• UL, cUL, CB, IEC, EN 62368-1

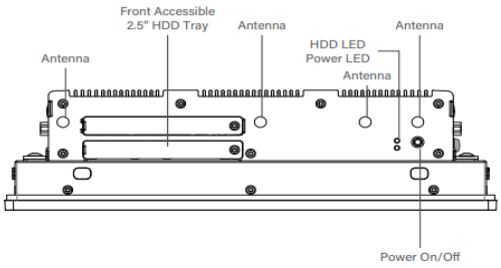
** Product Specifications and features are for reference only and are subject to change without prior notice. For more information, please refer to the latest product datasheet from Cincoze's website.*

1.3 External Layout

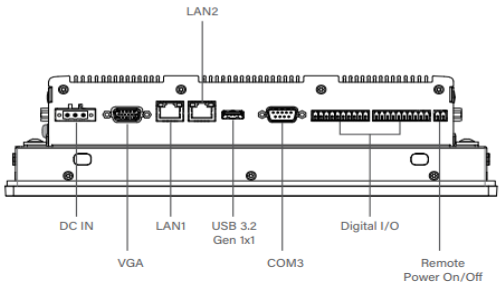
1.3.1 CV212C/P2302 Series

CV-212C/P2302

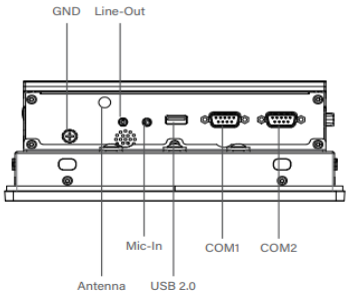
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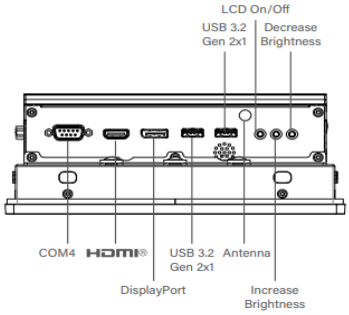
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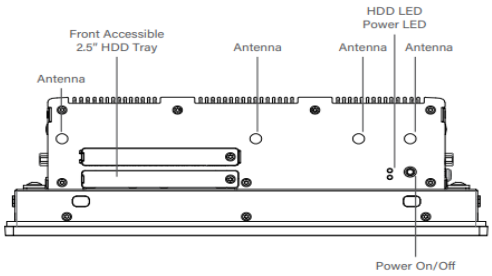


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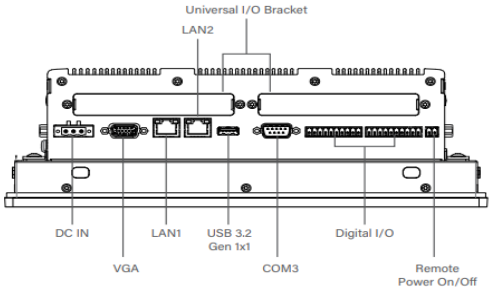


CV-212C/P2302E

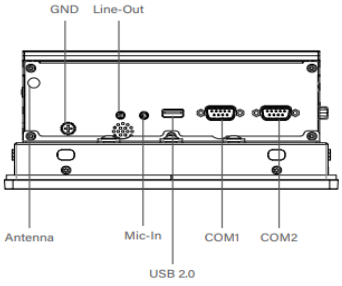
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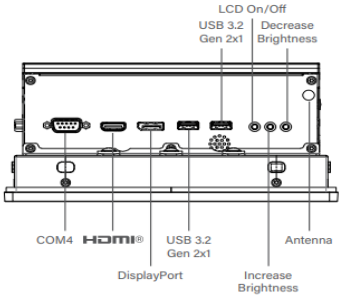
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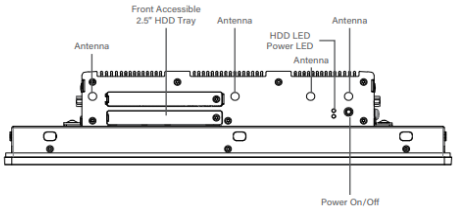
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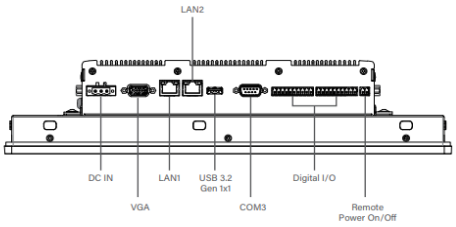
1.3.2 CV215C/P2302 Series

CV-215C/P2302

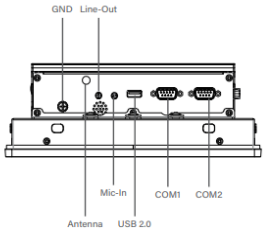
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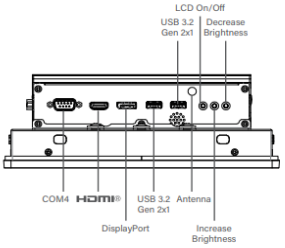
Rear I/O



Left I/O

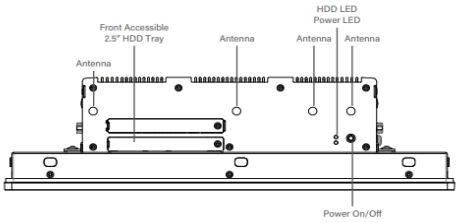


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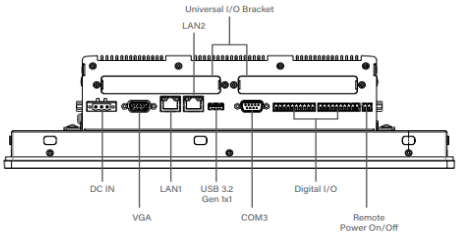


CV-215C/P2302E

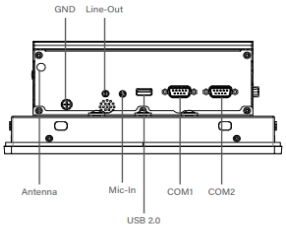
Front I/O



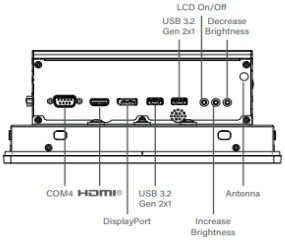
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Left I/O



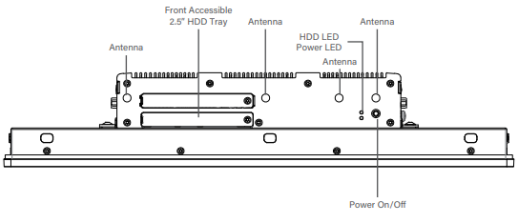
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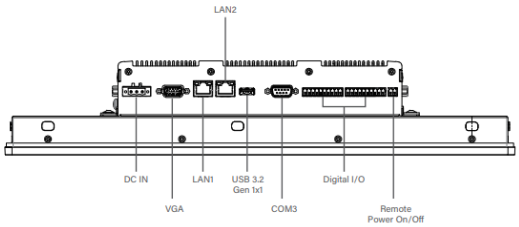
1.3.3 CV218C/P2302 Series

CV-218C/P2302

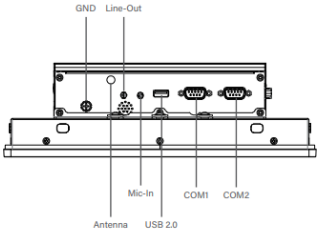
Front I/O



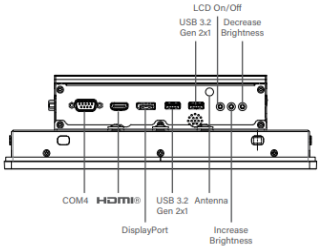
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Left I/O

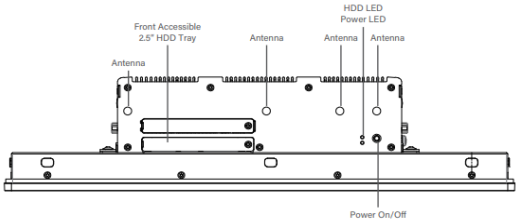


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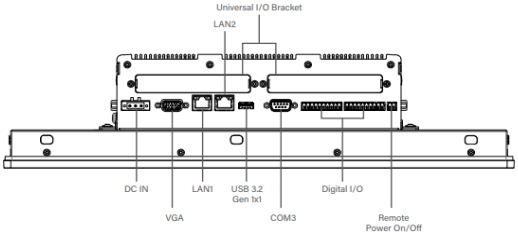


CV-218C/P2302E

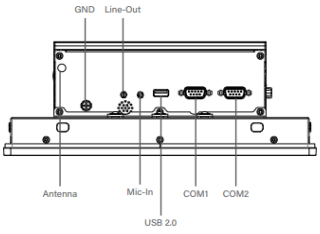
Front I/O



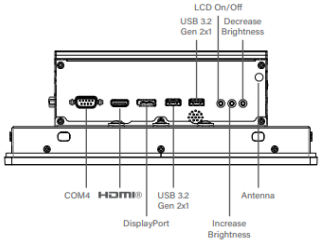
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Left I/O



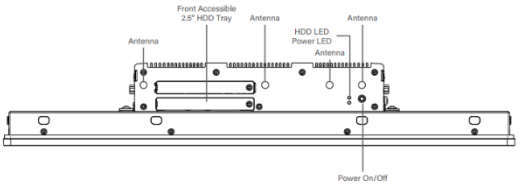
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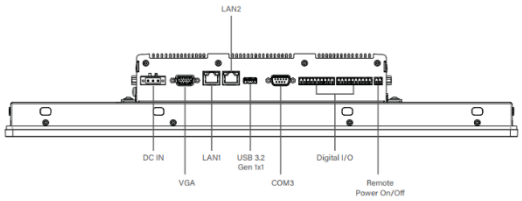
1.3.4 CV-221C/P2302 Series

CV-221C/P2302

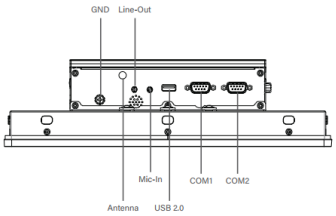
Front I/O



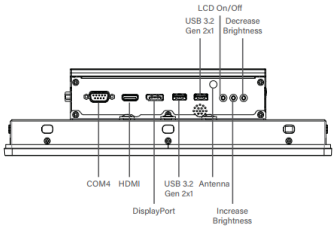
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Left I/O

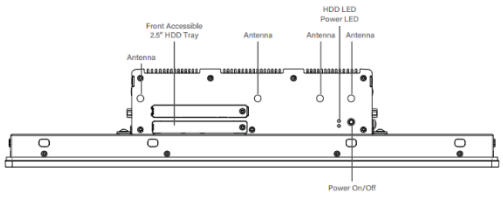


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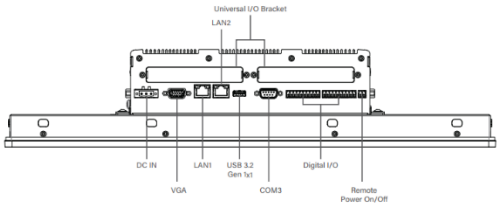


CV-221C/P2302E

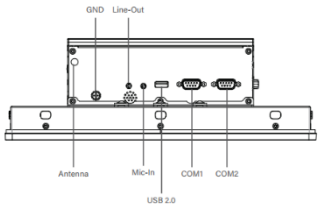
Front I/O



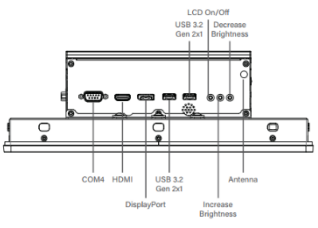
Rear I/O



Left I/O



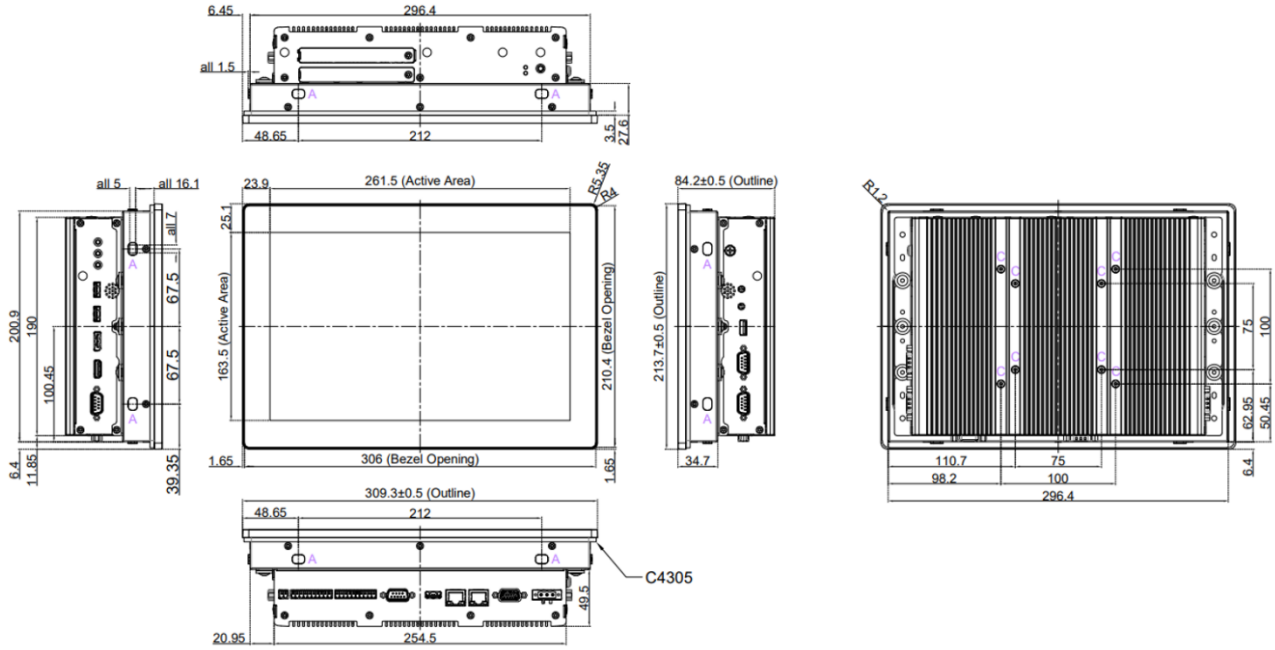
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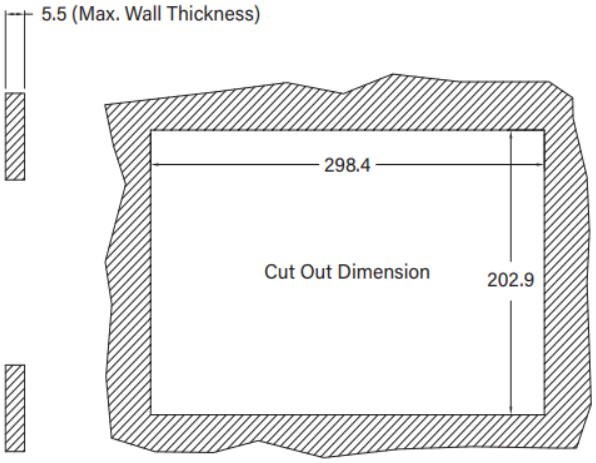


1.4 Dimensions

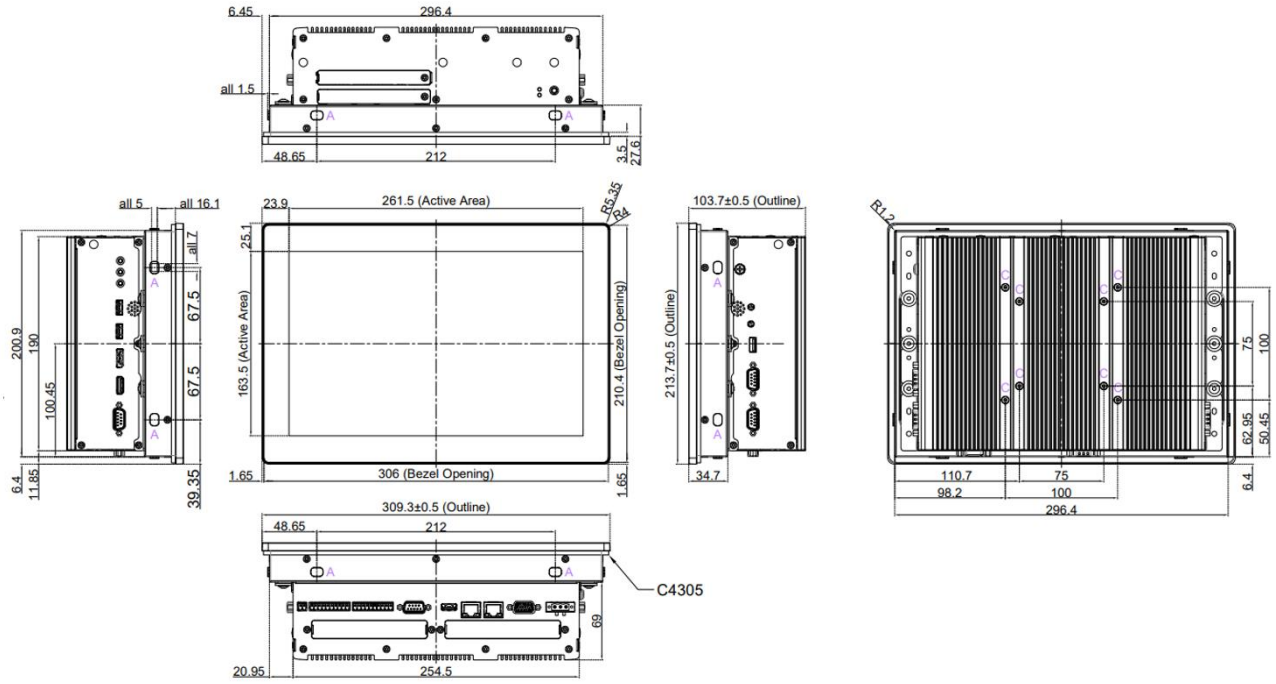
1.4.1 CV-212C/P2302 Series

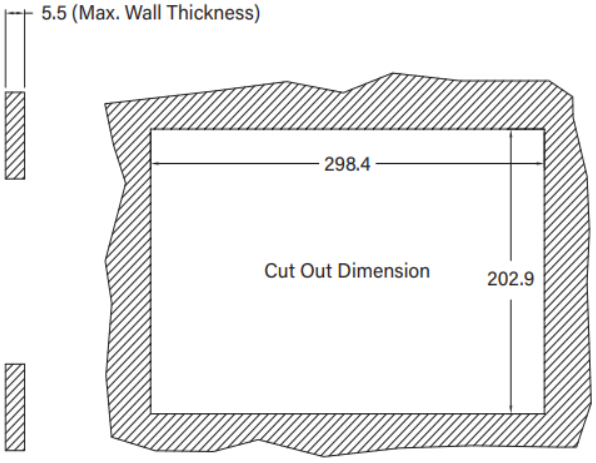
CV-212C/P2302 **Unit: mm**





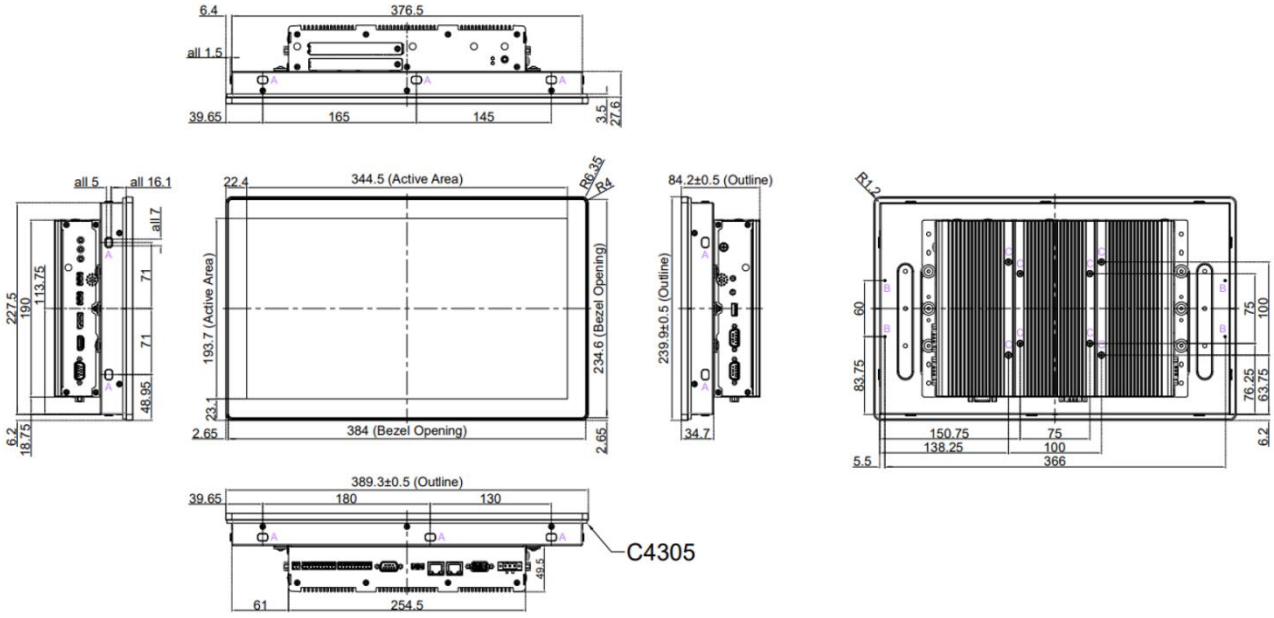
CV-212C/P2302E **Unit: mm**

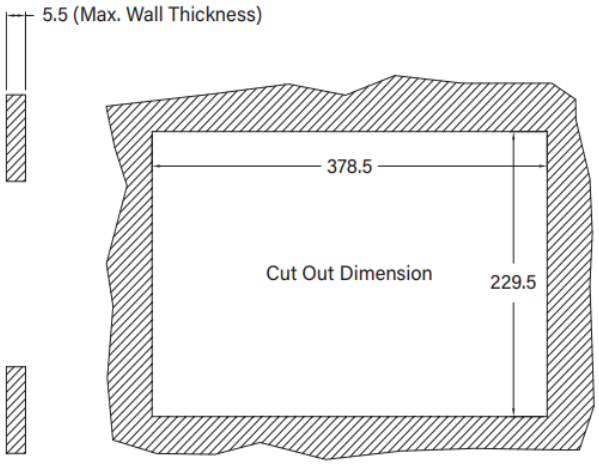




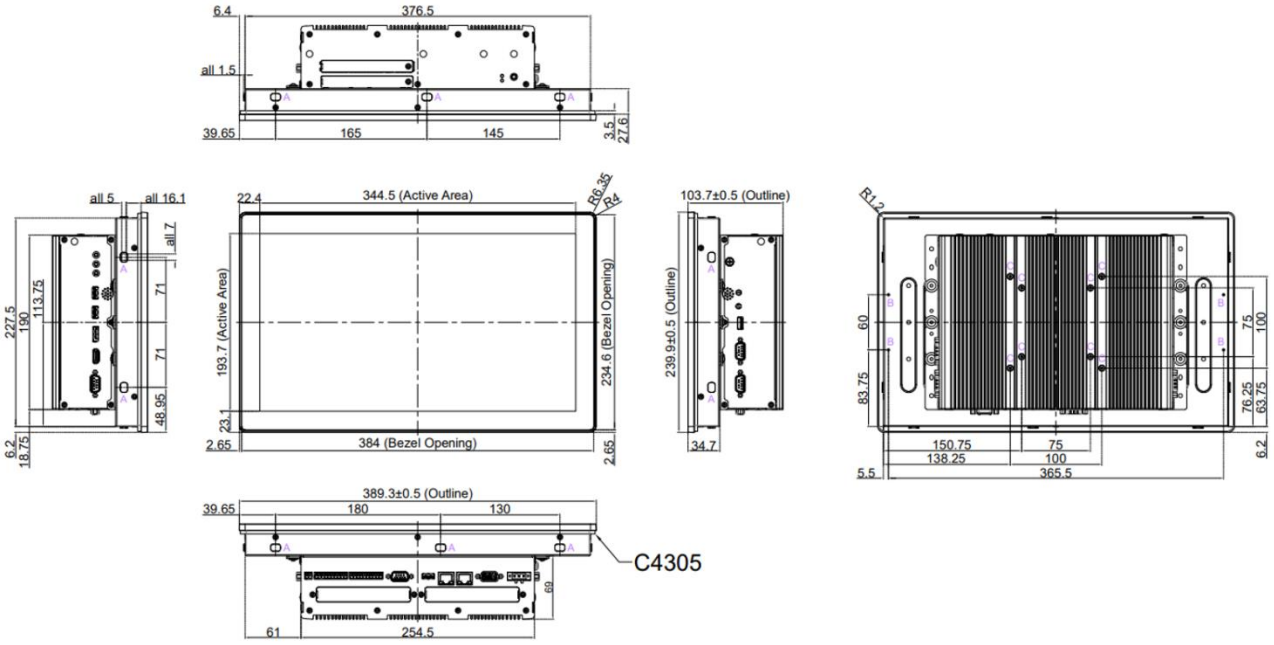
1.4.2 CV-215C/P2302 Series

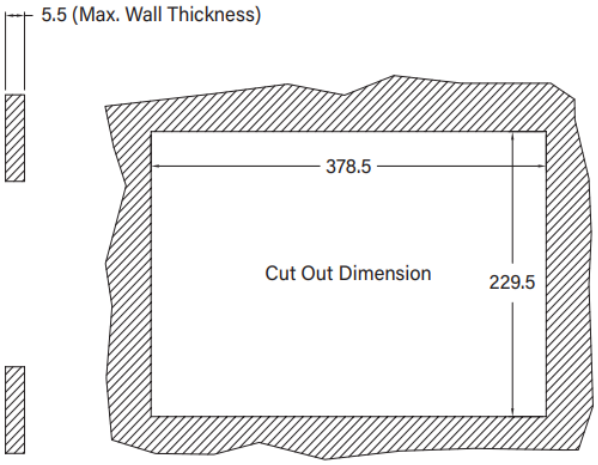
CV-215C/P2302 **Unit: mm**





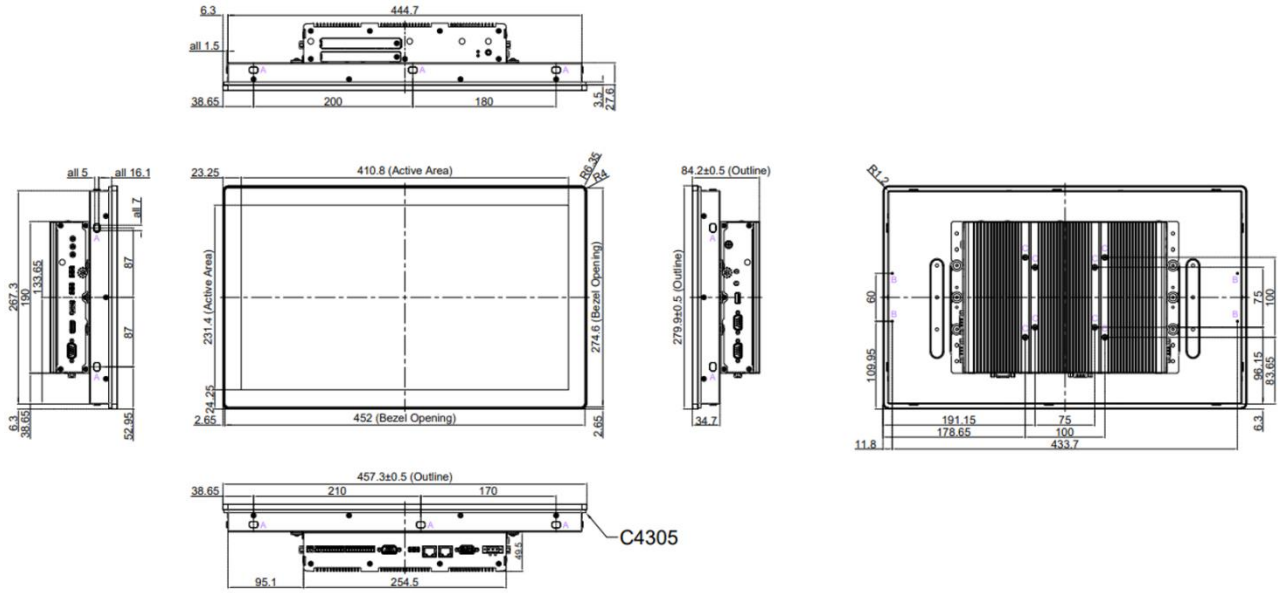
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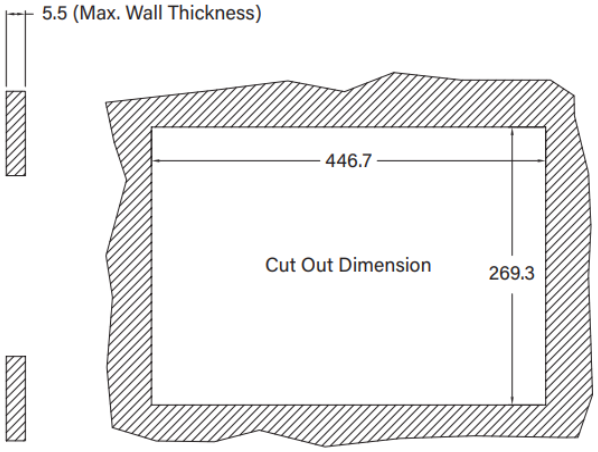




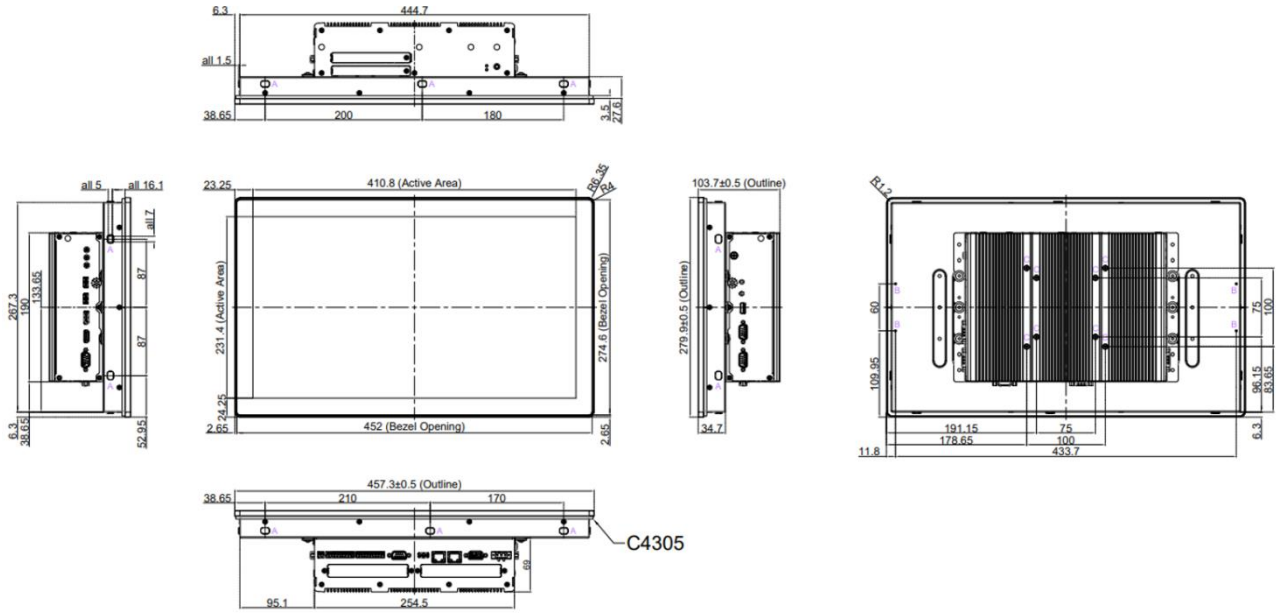
1.4.3 CV-218C/P2302 Series

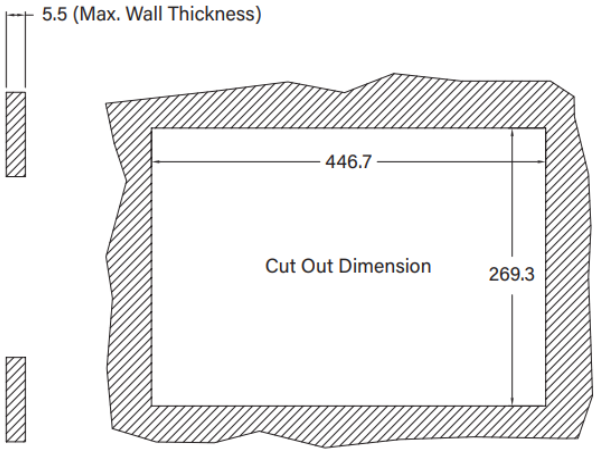
CV-218C/P2302 **Unit: mm**





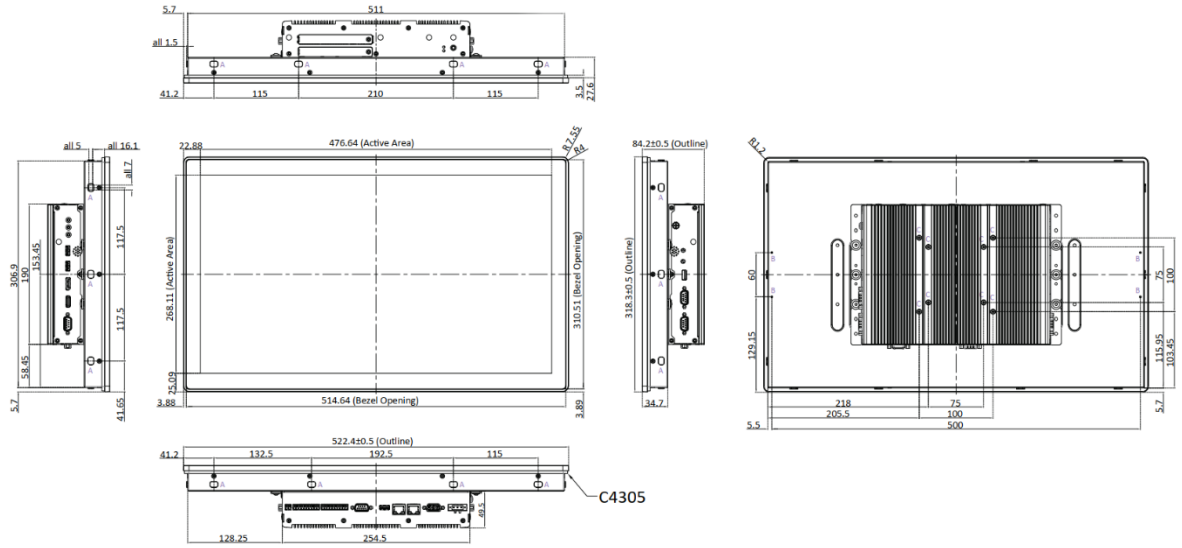
CV-218C/P2302E **Unit: mm**

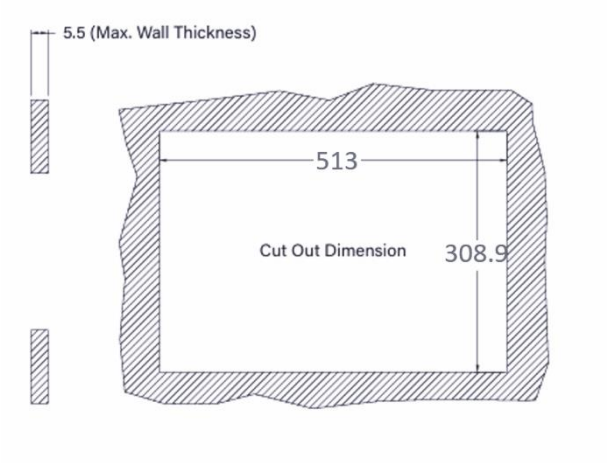




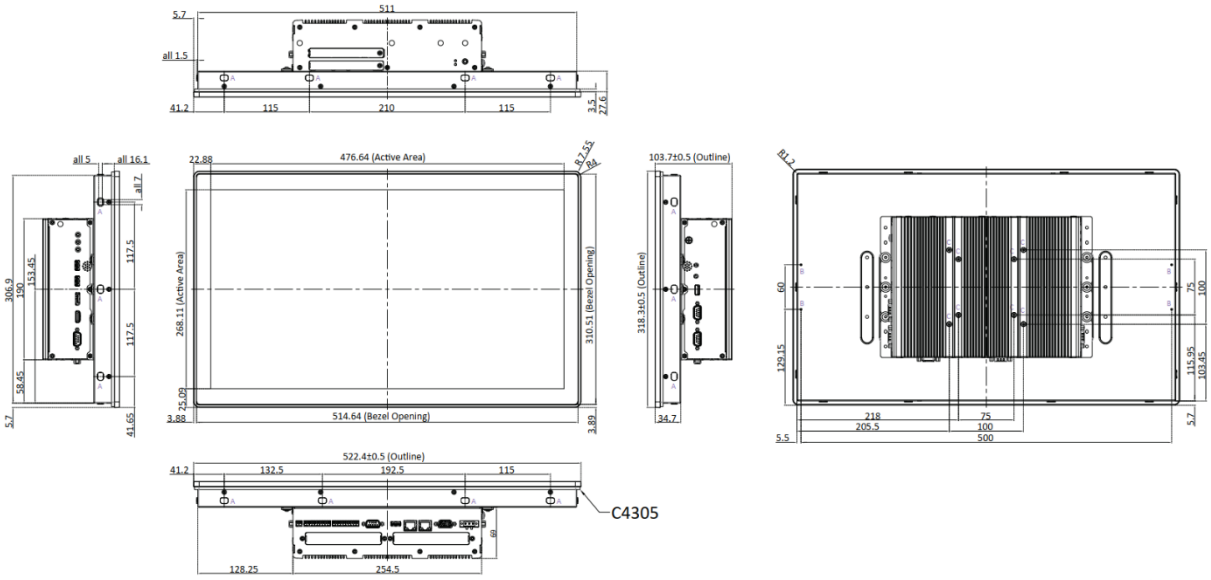
1.4.4 CV-221C/P2302 Series

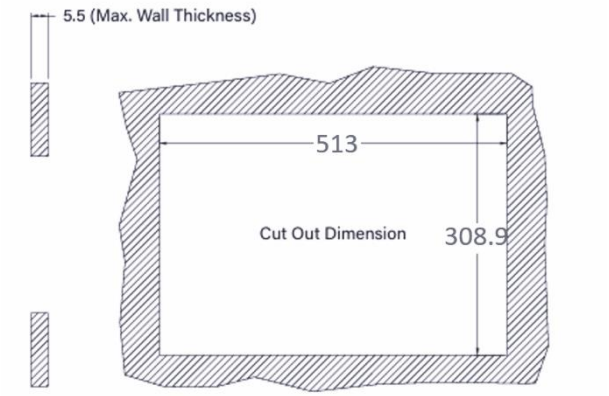
CV-221C/P2302 **Unit: mm**





CV-221C/P2302E **Unit: mm**

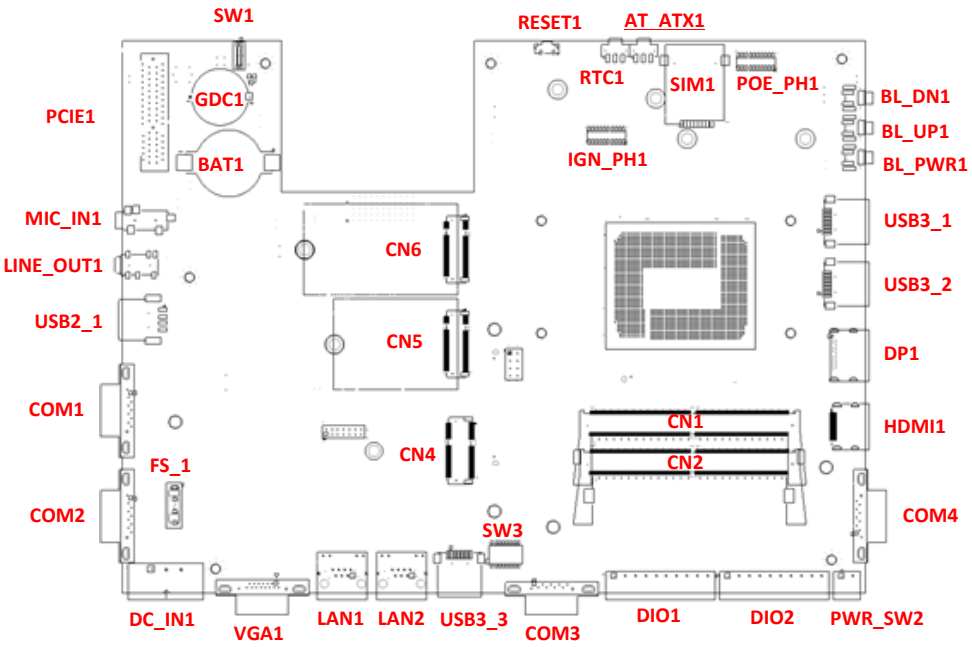




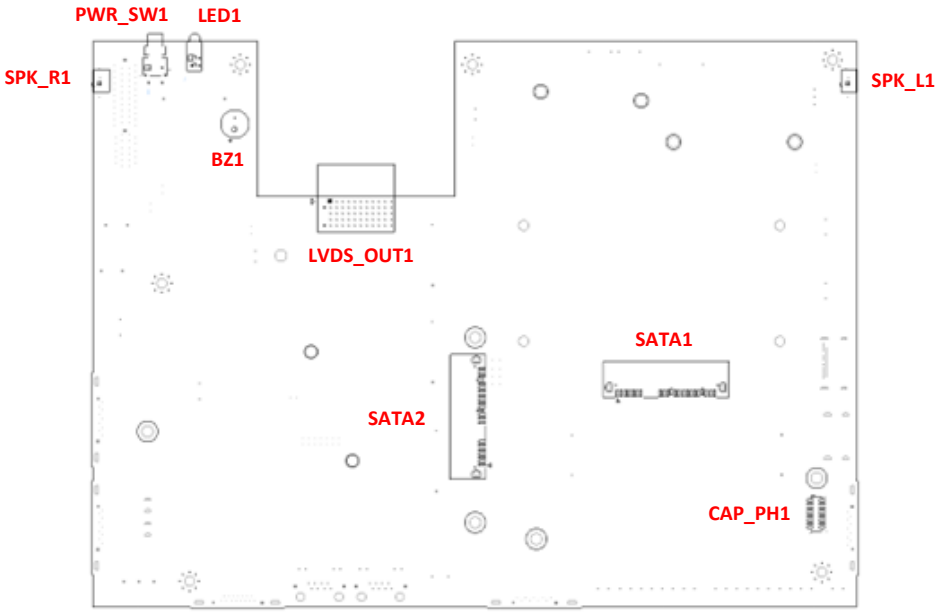
Chapter 2
Introduction to Switches and Connectors

2.1 Location of Switches and Connectors

2.1.1 Top View



2.1.2 Bottom View



2.2 Switches and Connectors Definition

List of Switches and Connectors

Location	Definition
AT_ATX1	AT / ATX Power Mode Switch
BAT1	Battery Holder
BL_DN1	Backlight Decrease Button
BL_PWR1	Backlight Power on/off Button
BL_UP1	Backlight Increase Button
BZ1	Buzzer
CAP_PH1	CAP Board to Board Connector
CN1, CN2	DDR5 SO-DIMM Socket
CN4	M.2 Key E 2230 Connector, support PCIE/USB2.0 interface
CN5	M.2 Key B 3042 Connector support PCIE x2/USB2.0 interface
CN6	M.2 Key B 3052 Connector w/SIM support PCIE x2/USB3.2/USB2.0
COM1, COM2, COM3, COM4	COM Connector, Support RS232 / RS422 / RS485
DC_IN1	3-pin DC 9-48V Power Input with Power Ignition Connector
DIO1	Digital 8 Output Connector
DIO2	Digital 8 Input Connector
DP1	Display Port
FS_1	DC Input Power Fuse Holder
GDC1	Super CAP for CMOS Backup
HDMI1	HDMI Connector
IGN_PH1	IGN Control Board Female Header
LAN1, LAN2	2.5 Giga LAN RJ45 Connector with i226
LED1	HDD / Power LED
LINE_OUT1	Line-out Jack
LVDS_OUT1	LVDS Connector
MIC_IN1	Mic-in Jack
PCIE1	PCIEx4 Slot
POE_PH1	PSE Board Male Header
PWR_SW1	Power Button
PWR_SW2	Remote Power on/off Connector
Reset1	Reset Button
RTC1	Clear CMOS Switch
SATA1, SATA2	SATA Connector
SIM1	SIM Card Socket
SPK_L1	Speaker out Connector for Left Side

SPK_R1	Speaker out Connector for Right Side
SW1	Super CAP Switch
SW3	Power Select for COM1/COM2/COM3/COM4
USB2_1	USB 2.0 Connector
USB3_1, USB3_2	USB3.2 GEN2x1 connector
USB3_3	USB3.2 GEN1 connector
VGA1	VGA Connector (DB15)

2.3 Definition of Switches

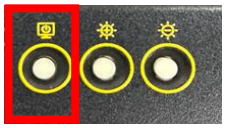
AT_ATX1: AT / ATX Power Mode Switch

Switch	Definition
Left	AT Power Mode
Right	ATX Power Mode (Default)



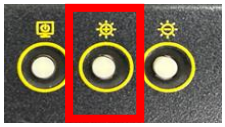
BL_PWR1: Backlight Power on / off

Switch	Definition
Push	Push to Control Backlight Power on / off switching



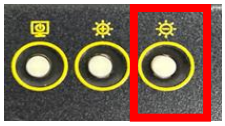
BL_UP1: Backlight Increase

Switch	Definition
Push	Push to Control Backlight Increase



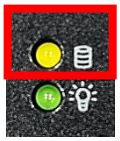
BL_DN1: Backlight Decrease

Switch	Definition
Push	Push to Control Backlight Decrease



LED1: HDD / Power LED

Switch	Definition	LED Color
HDD LED	HDD Read/Write	Yellow
	No Operation	Colorless
POWER LED	POWER ON	Green
	POWER OFF	Colorless





PWR_SW1: Power Button

Switch	Definition
Push	Push to Power on/off the System Power



RESET1: Reset Button

Switch	Definition
Push	Push to Reset System



RTC1: Clear CMOS Switch

Switch	Definition
Left	Normal (Default)
Right	Clear CMOS



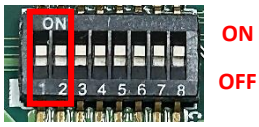
SW1: Super CAP Switch

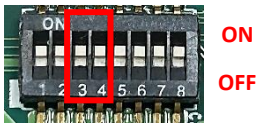
Location	Function	DIP1	DIP2
SW1	Super CAP Enabled	ON (Default)	ON (Default)
	Super CAP Disabled	OFF	

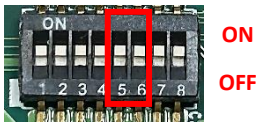


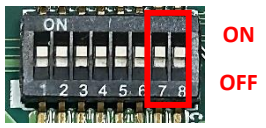
SW3: Power Select for COM1/COM2/COM3/COM4

Location	Function		DIP1	DIP2
SW3	COM1	0V(RI)	ON (Default)	ON (Default)
		5V	ON	OFF
		12V	OFF	OFF
Location	**Function**		**DIP3**	**DIP4**
SW3	COM2	0V(RI)	ON (Default)	ON (Default)
		5V	ON	OFF
		12V	OFF	OFF
Location	**Function**		**DIP5**	**DIP6**
SW3	COM3	0V(RI)	ON (Default)	ON (Default)
		5V	ON	OFF
		12V	OFF	OFF
Location	**Function**		**DIP7**	**DIP8**
SW3	COM4	0V(RI)	ON (Default)	ON (Default)
		5V	ON	OFF
		12V	OFF	OFF



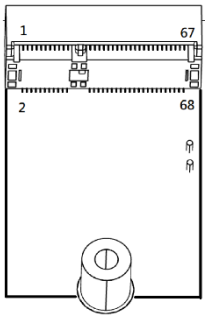






2.4 Definition of Connectors

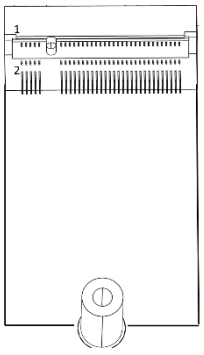
CN4 : M.2 Key E 2230 Connector, support PCIE /USB2.0 interface



Pin No.	PIN Name	Pin No.	Pin name
1	GND	2	+3.3V
3	USB_D+	4	+3.3V
5	USB_D-	6	NC
7	GND	8	PCM_CLK
9	NC	10	PCM_SYNC
11	NC	12	PCM_IN
13	GND	14	PCM_OUT
15	NC	16	NC
17	NC	18	GND
19	GND	20	UART_WAKE#
21	NC	22	UART_ RXD
23	NC	24	Key
25	Key	26	Key
27	Key	28	Key
29	Key	30	Key
31	Key	32	UART_TXD
33	GND	34	UART_CTS#
35	PETp0	36	UART_RTS#
37	PETn0	38	CLINK_RST#
39	GND	40	CLINK_ DATA
41	PERp0	42	CLINK_CLK
43	PERn0	44	COEX3
45	GND	46	COEX2
47	REFCLKp0	48	COEX1
49	REFCLKn0	50	SUSCLK
51	GND	52	PERST0#
53	CLKREQ0#	54	W_DISABLE2# (Pull-up)
55	PEWAKE0#	56	W_DISABLE1# (Pull-up)
57	GND	58	I2C_DATA
59	PETp1	60	I2C_CLK
61	PETn1	62	NC
63	GND	64	NC
65	PERp1	66	NC
67	PERn1	68	CLKREQ1#
69	GND	70	PEWAKE1#

71	REFCLKp1	72	+3.3V
73	REFCLKn1	74	+3.3V
75	GND		

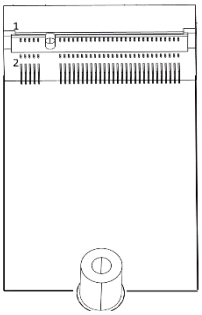
CN5 : M.2 Key B 3042 Connector support PCIE x2/USB2.0 interface



Pin No.	PIN Name	Pin No.	Pin name
1	CFG3	2	+3.3V
3	GND	4	+3.3V
5	GND	6	NC
7	USB2_D+	8	NC
9	USB2_D-	10	LED#1
11	GND	12	Key
13	Key	14	Key
15	Key	16	Key
17	Key	18	Key
19	Key	20	NC
21	CFG0	22	NC
23	NC	24	NC
25	NC	26	NC
27	GND	28	NC
29	PERN1	30	NC
31	PERP1	32	NC
33	GND	34	NC
35	PETN1	36	NC
37	PETP1	38	NC
39	GND	40	NC
41	PERN0	42	NC
43	PERP0	44	NC
45	GND	46	NC
47	PETN0	48	NC
49	PETP0	50	PERST#
51	GND	52	CLKREQ#
53	REFCLKN	54	WAKE#
55	REFCLKP	56	NC
57	GND	58	NC
59	NC	60	NC
61	NC	62	NC
63	NC	64	NC
65	NC	66	NC

67	NC	68	SUSCLK
69	CFG1	70	+3.3V
71	GND	72	+3.3V
73	GND	74	+3.3V
75	CFG2		

CN6 : M.2 Key B Type 3052 Connector w/SIM support PCIE x2/USB3.2/USB2.0



Pin No.	PIN Name	Pin No.	Pin name
1	CFG3	2	+3.3V
3	GND	4	+3.3V
5	GND	6	FULL_CAR D_PWR_OFF#
7	USB2_D+	8	W_DISABLE1#
9	USB2_D-	10	LED#1
11	GND	12	Key
13	Key	14	Key
15	Key	16	Key
17	Key	18	Key
19	Key	20	NC
21	CFG0	22	NC
23	WAKE_WWAN#	24	NC
25	DPR	26	W_DISABLE2#
27	GND	28	NC
29	PERN1/USB3_RX-	30	USIM_RESET
31	PERP1/USB3_RX+	32	USIM_CLK
33	GND	34	USIM_DATA
35	PETN1/USB3_TX-	36	USIM_PWR
37	PETP1/USB3_TX+	38	NC
39	GND	40	NC
41	PERN0	42	NC
43	PERP0	44	NC
45	GND	46	NC
47	PETN0	48	NC
49	PETP0	50	PERST#
51	GND	52	CLKREQ#
53	REFCLKN	54	WAKE#
55	REFCLKP	56	NC
57	GND	58	NC
59	NC	60	COEX3
61	NC	62	COEX2

63	NC	64	COEX1
65	NC	66	USIM_DET
67	PERST2# FOR WWAN	68	SUSCLK
69	CFG1	70	+3.3V
71	GND	72	+3.3V
73	VIO_CFGX40	74	+3.3V
75	CFG2		

COM1 / COM2 / COM3/ COM4: COM Connector, Support RS232 / RS422 / RS485

Connector Type: 9-pin D-Sub

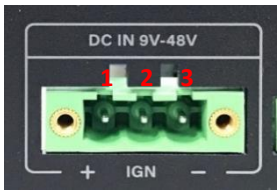
Pin	RS232 Definition	RS422 / 485 Full Duplex Definition	RS485 Half Duplex Definition
1	DCD	TX-	DATA -
2	RXD	TX+	DATA +
3	TXD	RX+	
4	DTR	RX-	
5	GND		
6	DSR		
7	RTS		
8	CTS		
9	RI		



DC_IN1: 3 PINs DC 9-48V power input with power ignition connector

Connector Type: Terminal Block 1x3 3-pin, 5.0mm pitch

Pin	Definition
1	9_48VSB_IN
2	9_32VSB_ACC (IGN detection)
3	GND

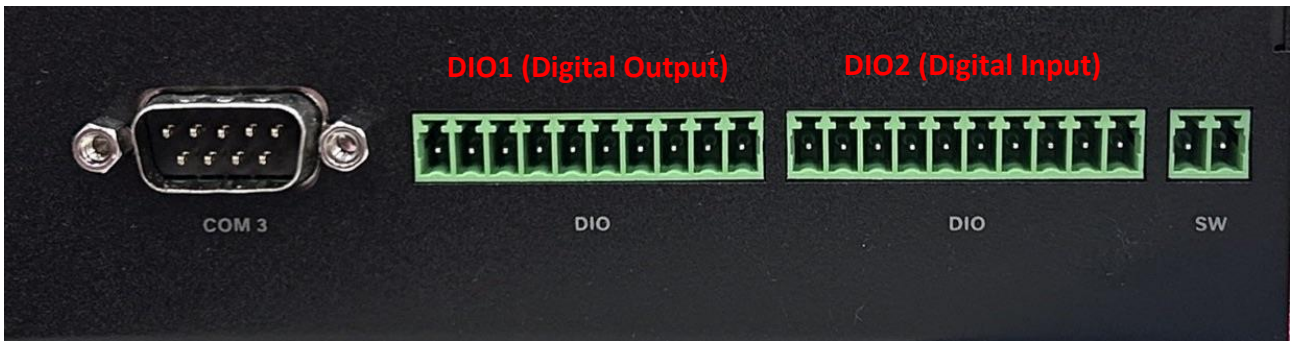




CAUTION (ATTENTION)

Please disconnect the power source before mounting the DC power cables or connecting the DC power connector to system.

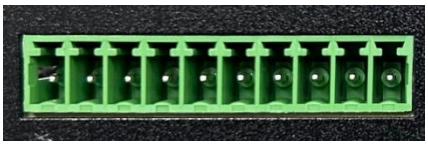
(Veuillez débrancher la source d'alimentation avant de monter les câbles d'alimentation CC ou de connecter le connecteur d'alimentation CC au système.)



DIO1: Digital 8 Output Connector

Connector Type: Terminal Block 1X10 10-pin, 3.5mm pitch

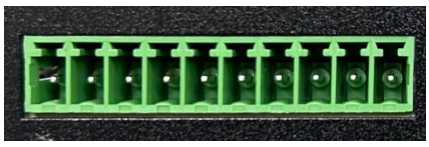
Pin	Definition	Pin	Definition
1	XCOM+(DC INPUT)	6	DO5
2	DO1	7	DO6
3	DO2	8	DO7
4	DO3	9	DO8
5	DO4	10	XCOM-(GND)



DIO2: Digital 8 Input Connector

Connector Type: Terminal Block 1X10 10-pin, 3.5mm pitch

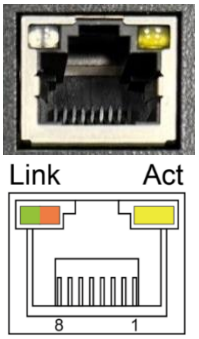
Pin	Definition	Pin	Definition
1	XCOM+(DC INPUT)	6	DI5
2	DI1	7	DI6
3	DI2	8	DI7
4	DI3	9	DI8
5	DI4	10	XCOM-(GND)



LAN1, LAN2: 2.5 Giga LAN RJ45 Connector with i226

LAN LED Status Definition

Link Speed LED Status	Definition
Steady Green	2.5 Gbps Network Link
Steady Orange	1 Gbps Network Link
Off	100 Mbps/ 10 Mbps Network Link
Link Act LED Status	**Definition**
Blinking Yellow	Link and Data Activity
Steady Yellow	Link but No Activity
Off	No Link



PWR_SW2: Remote Power on/off Connector

Connector Type: Terminal Block 1X2 2-pin, 3.5mm pitch

Pin	Definition
1	RMT_PWR_BTN_N
2	GND





WARNING (AVERTIR)

Do not apply power to this connector! This port is used to connect a SWITCH!

(Ne mettez pas sous tension ce connecteur! Ce port est utilisé pour connecter un SWITCH!)

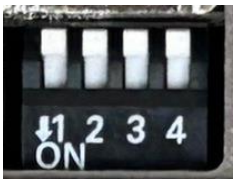
2.5 Optional Module Pin Definition & Settings

2.5.1 CFM-IGN101 Module

SW2 (on CFM-IGN101)：IGN Module Timing Setting Switch

Set shutdown delay timer when ACC is turned off

Pin 1	Pin 2	Pin 3	Pin 4	Definition
ON (IGN Enabled) / OFF (IGN Disabled)	ON	ON	ON	0 second
	ON	ON	OFF	1 minute
	ON	OFF	ON	5 minutes
	ON	OFF	OFF	10 minutes
	OFF	ON	ON	30 minutes
	OFF	ON	OFF	1 hour
	OFF	OFF	ON	2 hours
	OFF	OFF	OFF	Reserved (0 second)



Default setting of Pin1 to Pin4 is OFF/OFF/OFF/OFF.

24V_12V_1 (on the system): IGN Module Voltage Mode Setting Switch

12V / 24V Car Battery Switch

Switch	Definition
Left	24V Car Battery Input (Default)
Right	12V Car Battery Input



Chapter 3
System Setup

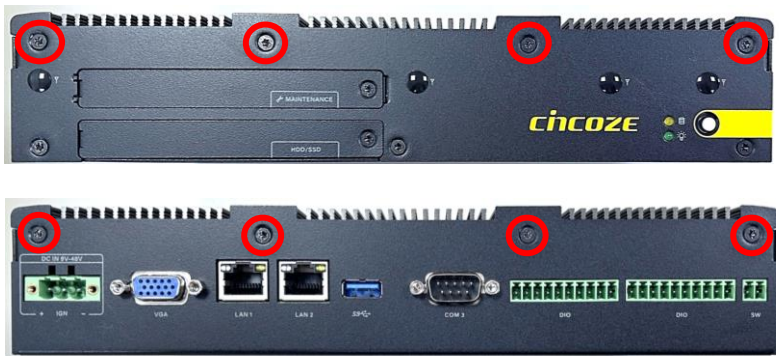
This chapter uses the P2302 for hardware installation examples, except in the “Installing PCI(e) Card” section, which uses the P2302E.

3.1 Removing Top Cover

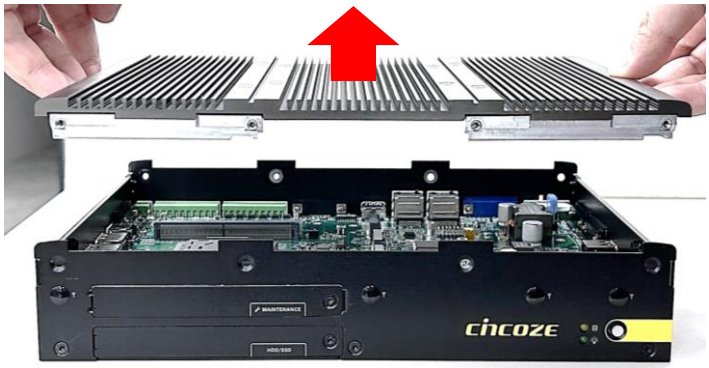
WARNING (AVERTIR)

In order to prevent electric shock or system damage, must turn off power and disconnect the unit from power source before removing the chassis cover.
(Afin d'éviter tout risque d'électrocution ou d'endommagement du système, vous devez couper l'alimentation et débrancher l'appareil de la source d'alimentation avant de retirer le couvercle du châssis.)

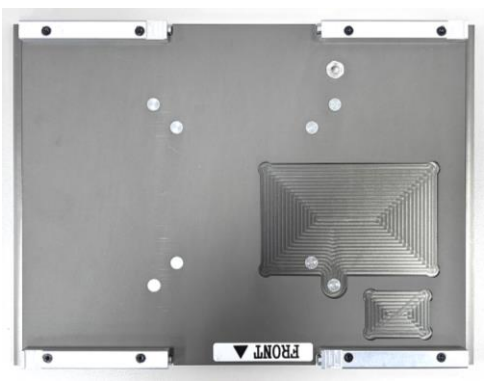
Step 1. Loosen the eight screws on the front and rear panels of the system.



Step 2. Carefully lift the top cover and detach it from the chassis.



Step 3. Place the top cover aside gently.





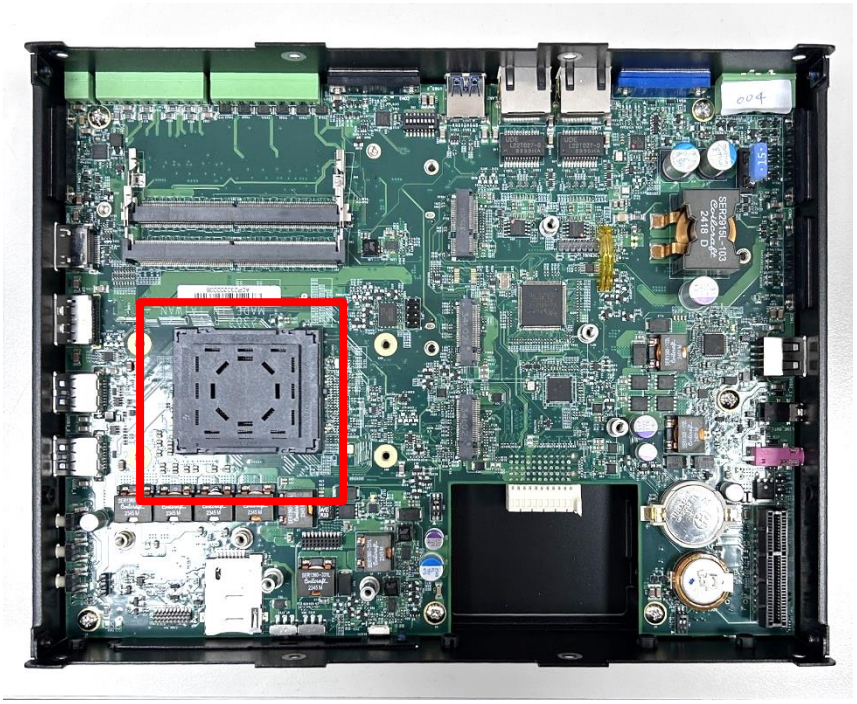
3.2 Installing CPU

WARNING (AVERTIR)

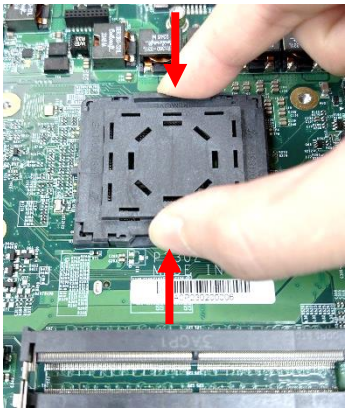
After replacing the CPU, please perform a Clear CMOS before powering on. According to Intel documentation (Clear CMOS after Hardware Configuration Change, Document Number: 337986-001), if you do not perform a Clear CMOS, the BIOS will apply settings from the old CPU to the new CPU, which may cause performance issues or startup failures. Therefore, Cincoze performs a Clear CMOS procedure before shipping. When customers power on the system for the first time, it will take several minutes to start. This is normal. During this process, the system will POST three times, and the Power LED will alternate between green and blue lights.

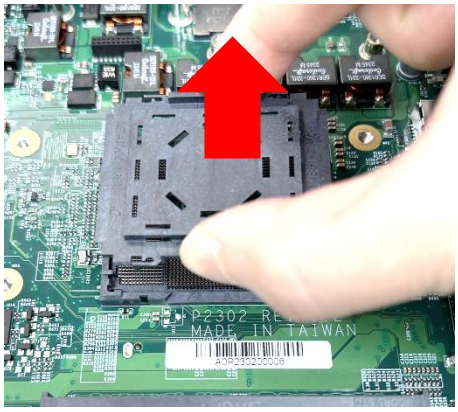
(Après avoir remplacé le CPU, veuillez effectuer un Clear CMOS avant de mettre sous tension. Selon la documentation Intel (Clear CMOS after Hardware Configuration Change, Document Number: 337986-001), si vous n'effectuez pas un Clear CMOS, le BIOS appliquera les paramètres de l'ancien CPU au nouveau CPU, ce qui peut entraîner des problèmes de performance ou des échecs de démarrage. Par conséquent, Cincoze effectue une procédure de Clear CMOS avant l'expédition. Lorsque les clients mettent le système sous tension pour la première fois, il faudra plusieurs minutes pour démarrer. Cela est normal. Pendant ce processus, le système effectuera trois fois le POST et la LED d'alimentation alternera entre les lumières verte et bleue.)

Step 1. Locate the CPU socket.

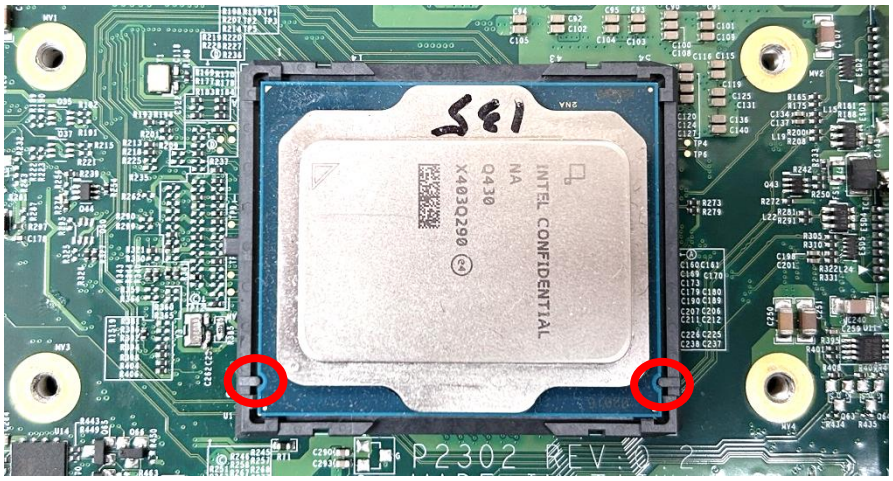


Step 2. Hold both sides of the cover of the CPU socket and remove it.

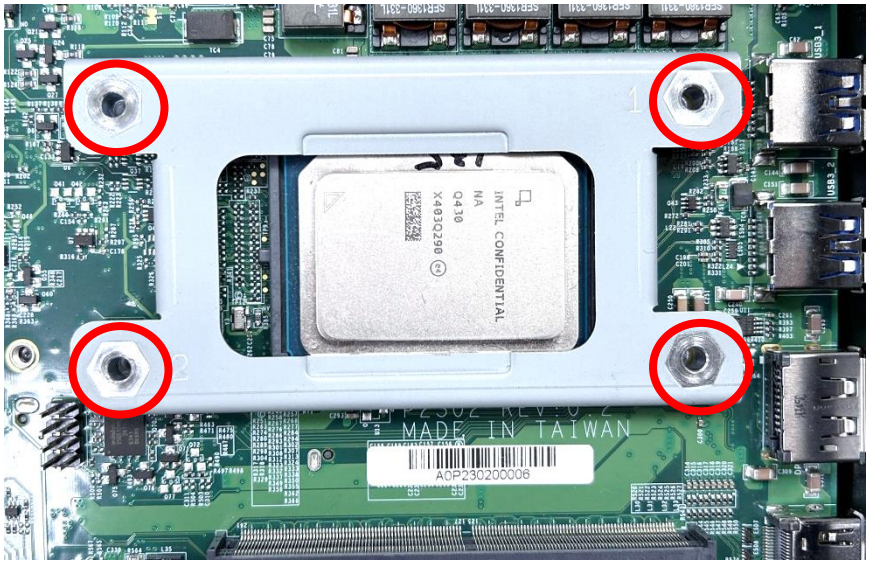




Step 3. Insert the CPU gently by aligning the notches of the socket.



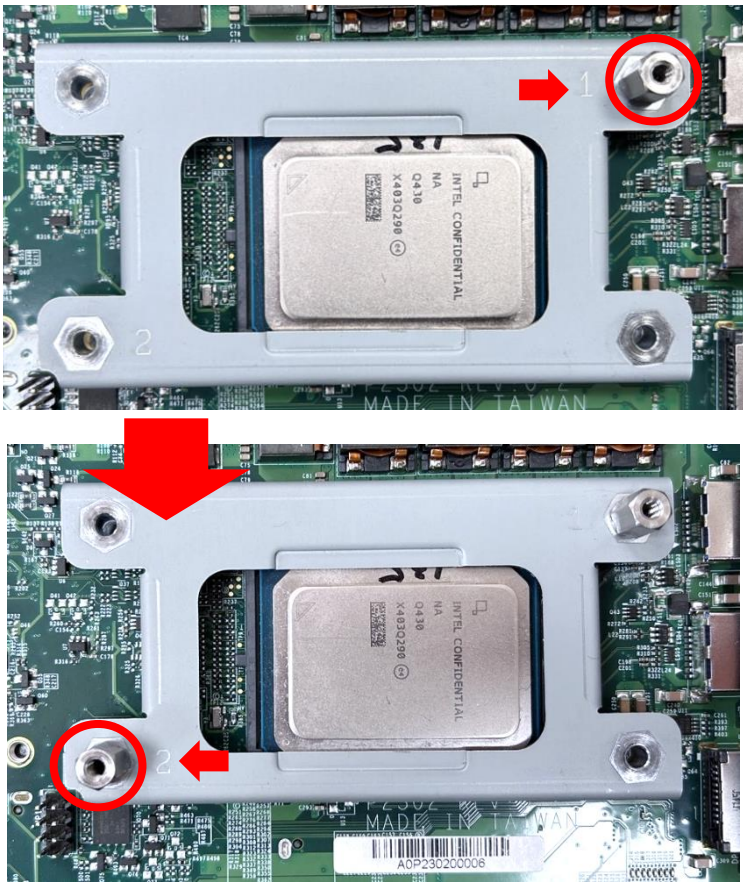
Step 4. Place the CPU bracket and ensure that the screw holes are properly aligned.



Step 5. Please use a torque screwdriver (manual type with adjustable torque setting; see the example below left), and set the torque to 5–5.5 kgf·cm when fastening the CPU bracket.

Follow the sequence 1 → 2 (as marked on the top surface of the bracket), and fasten the two hexagonal carbon steel standoffs (M3 × 8.4L, included in the package) with the torque screwdriver to complete the installation.





NOTE (NOTE)

Failure to apply the specified torque may result in system boot failure or other unpredictable errors. (Le non-respect du couple de serrage spécifié peut entraîner un échec du démarrage du système ou d'autres erreurs imprévisibles.)

Step 6. Make sure that the CPU surface is clean, then peel off the protective film from one side of the thermal pad (included in the package) and place the peeled side onto the CPU. Then, remove the transparent protective film from the other side (top side).



CAUTION (ATTENTION)

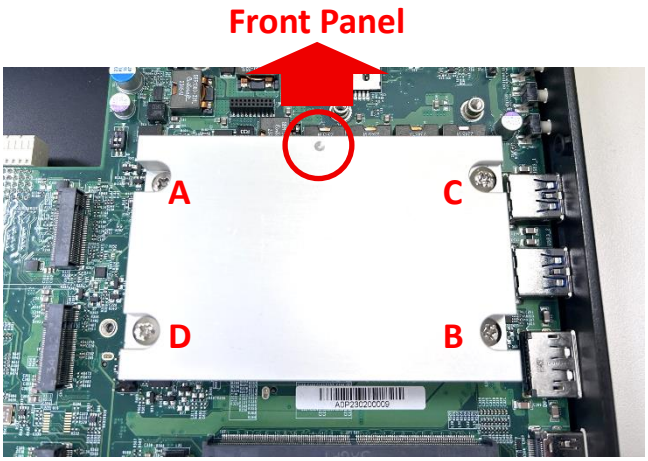
Before installing the CPU heatsink, please make sure the protective films on the Thermal Pad have been removed!

(Avant d'installer le dissipateur thermique du processeur, veuillez vous assurer que les films de protection sur le tampon thermique ont été retirés!)

Step 7. Penetrate the four screws through the corresponding holes on the heatsink. Use two M3 × 10L round head screws for the top-right and bottom-left corners, and two M3 × 20L round head screws for the top-left and bottom-right corners.



Step 8. Ensure that the circular indentation mark, as shown in the image, is facing the front panel of the system. Align the whole set with the four mounting holes and place it onto the CPU bracket. Use the torque screwdriver with torque 5–5.5 kgf·cm (mentioned in the step 5) to fasten the screws in the sequence A → B → C → D.



NOTE (NOTE)

Failure to apply the specified torque may result in system boot failure or other unpredictable errors. (Le non-respect du couple de serrage spécifié peut entraîner un échec du démarrage du système ou d'autres erreurs imprévisibles.)

Step 9. Peel off the protective film from one side of the thermal pad (included in the package) and place the peeled side onto the CPU heatsink. Then, remove the transparent protective film from the other side (top side) to complete the installation.





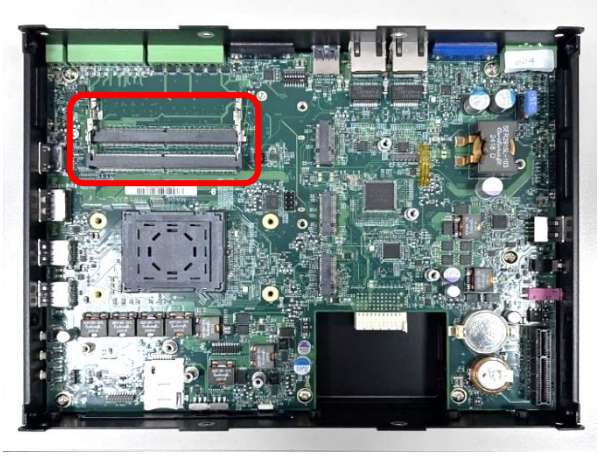
CAUTION (ATTENTION)

Before assembling the system's chassis cover, please make sure the protective films on the Thermal Pad have been removed!

(Avant d'assembler le couvercle du châssis du système, assurez-vous que le film protecteur sur le coussin thermique a été retiré !)

3.3 Installing SO-DIMM

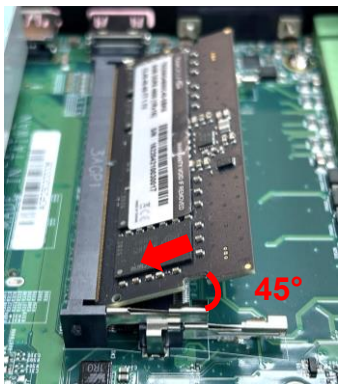
Step 1. Locate the SO-DIMM sockets on the system board.



Step 2. Tilt the memory module at a 45-degree angle, and insert it into SO-DIMM socket until the golden finger connector of the module is seated firmly.

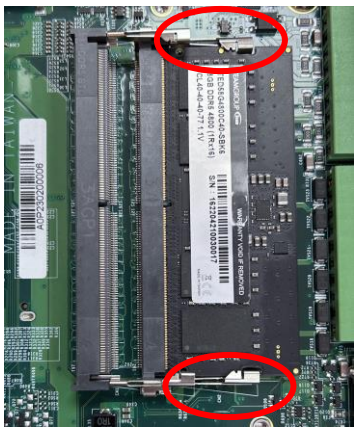


Lower socket

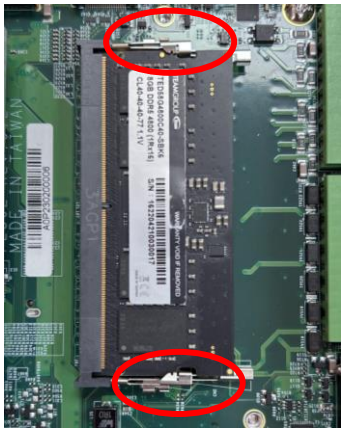


Upper socket

Step 3. Press down the memory module until retaining clips snap back in place.



Lower socket



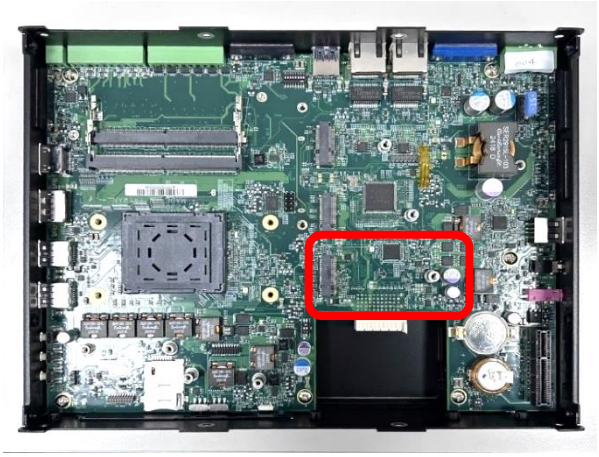
Upper socket

3.4 Installing M.2 Key B Module

3.4.1 M.2 Key B type 3052 Socket

3.4.1.1 M.2 Key B type 3052 Module

Step 1. Locate the M.2 Key B type 3052 connector (CN6) on the top side of the system motherboard.



Step 2. Insert the M.2 Key B type 3052 module at a 45-degree angle and insert it to the slot until the gold-plated connector of module contacted firmly with the slot.



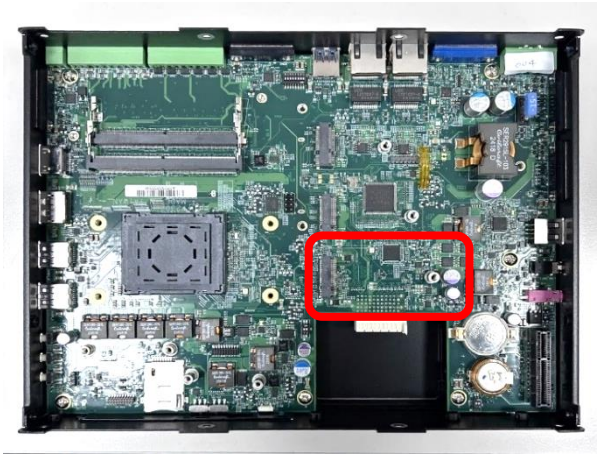
Step 3. Press down the module and fasten the screw to secure the module. (M3X5L, included in the screw pack).



3.4.1.2 M.2 Key B type 3042/2242 Module

In this section, we will use an M.2 Key B 2242 module as an example for installing demonstration.

Step 1. Locate the M.2 Key B type 3052 connector (CN6) on the top side of the system motherboard.



Step 2. Align the M.2 Key B Type 3052 to 3042 Adapter Bracket (included in the Package) with the corresponding screw hole. Secure the bracket in place and fasten the screw (M3x4L, included in the Screw Pack).

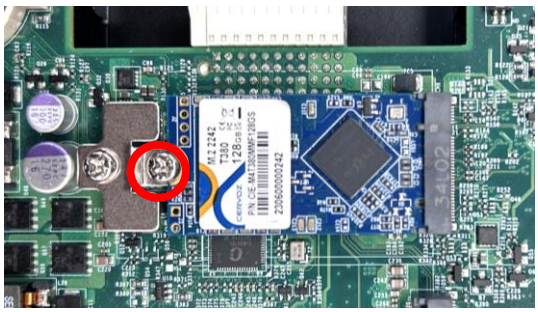




Step 3. Insert the M.2 Key B module at a 45-degree angle and insert it to the slot until the gold-plated connector of module contacted firmly with the slot.



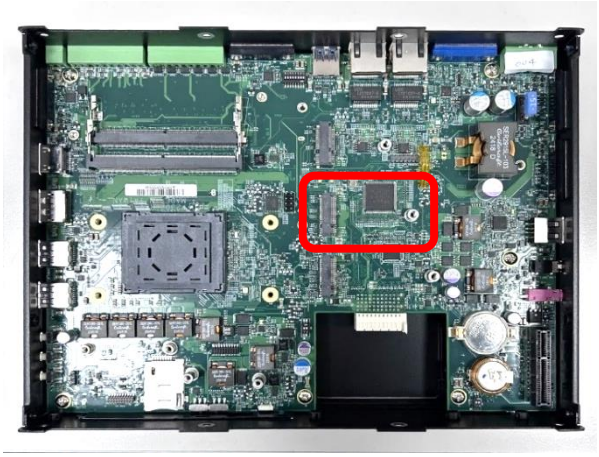
Step 4. Press down the module and fasten the screw to secure the module. (M3X5L, included in the screw pack).



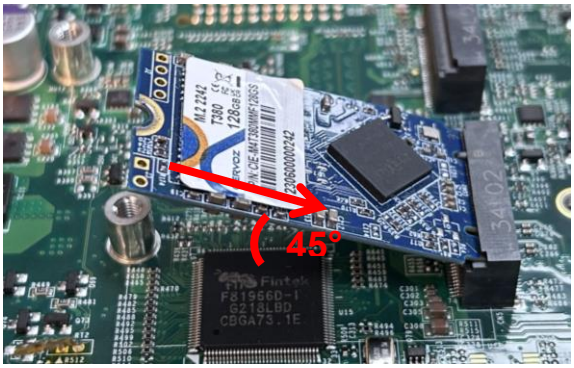
3.4.2 M.2 Key B type 3042 Socket

In this section, we will use an M.2 Key B 2242 module as an example for installing demonstration.

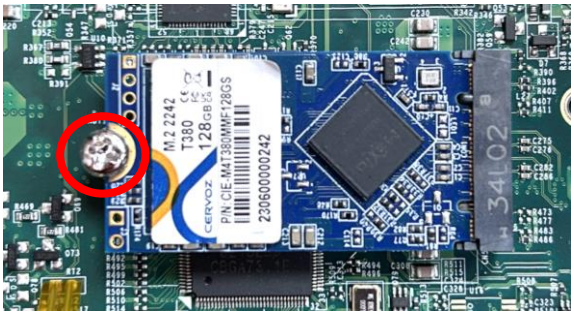
Step 1. Locate the M.2 Key B type 3042 connector (CN5) on the top side of the system motherboard.



Step 2. Insert the M.2 Key B type 2242 module at a 45-degree angle and insert it to the slot until the gold-plated connector of module contacted firmly with the slot.

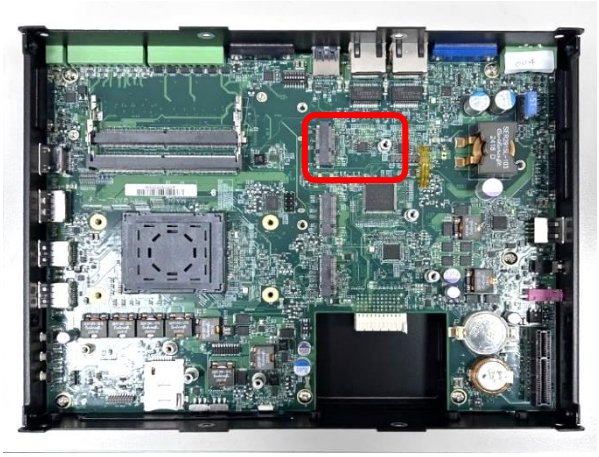


Step 3. Press down the module and fasten the screw (M3X5L, included in the screw pack) to secure the module.



3.5 Installing an M.2 Key E Module

Step 1. Locate the M.2 Key E socket (CN4) on the system board.



Step 2. Tilt the M.2 E Key card at a 45-degree angle and insert it to the socket until the golden finger connector of the card seated firmly.



Step 3. Press the module down and secure with the screw (M3x5L, included in the screw pack).



3.6 Installing Antenna

Step 1. Remove the antenna rubber cover on the front panel of the system.



Step 2. Insert the antenna jack through the hole, then attach the antenna's washer or nut and fasten it securely.





Step 3. Assemble the antenna and antenna jack together.



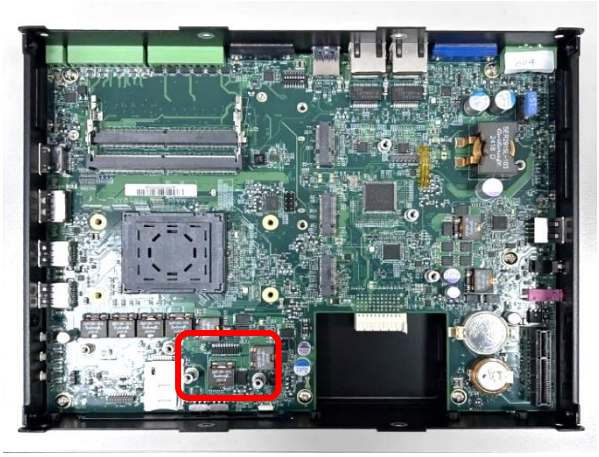
Step 4. Attach the RF connector at another end of the cable onto the card.



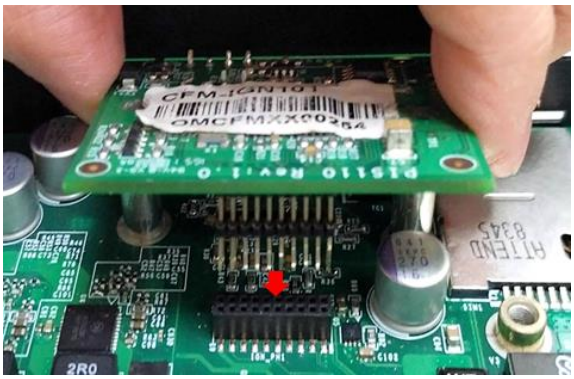
3.7 Installing CFM Module

3.7.1 CFM-IGN101

Step 1. Locate the power Ignition connector on system motherboard as indicated.



Step 2. Insert the female connector of power ignition board to the male connector on system motherboard.



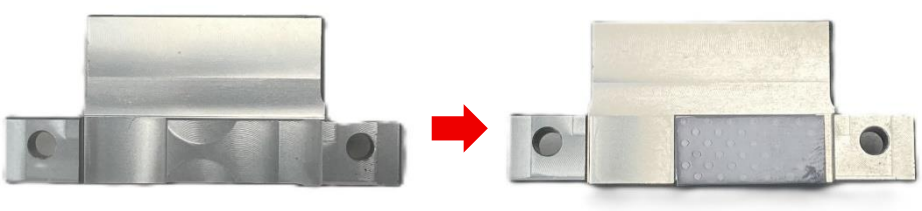
Step 3. Fasten two screws to secure the power ignition board.



3.7.2 CFM-PoE08/ CFM-PoE09

In this section, the CFM-PoE08 module is used as an example. The CFM-PoE09 module, which is designed for the P2302E, is identical to the CFM-PoE08 module except for the taller heatsink.

Step 1. Place a thermal pad on the bottom of the heatsink as shown below.

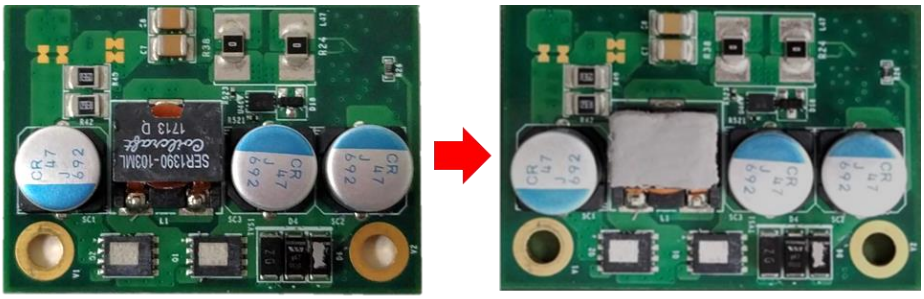


CAUTION (ATTENTION)

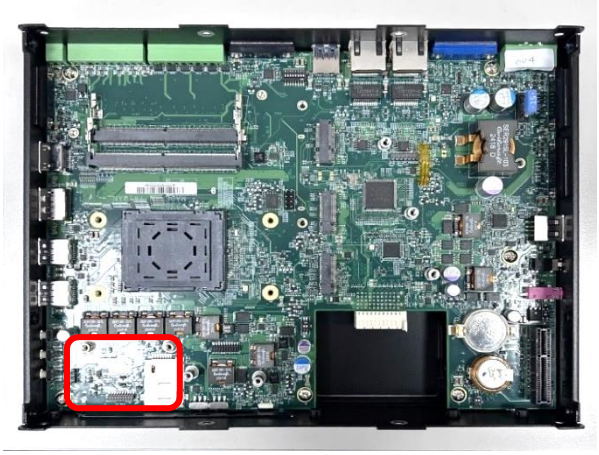
Before installing the heatsink, please make sure the protective film on the thermal pad has been removed!

(Avant d'installer le dissipateur thermique, veuillez vous assurer que le film de protection sur le tampon thermique a été retiré!)

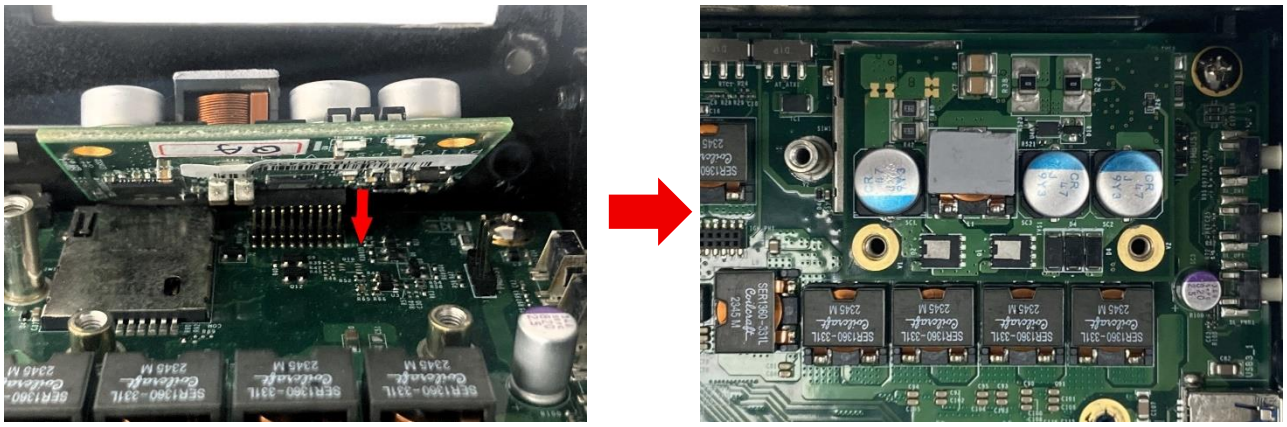
Step 2. Paste a thermal pad onto the coil of the CFM-PoE module.



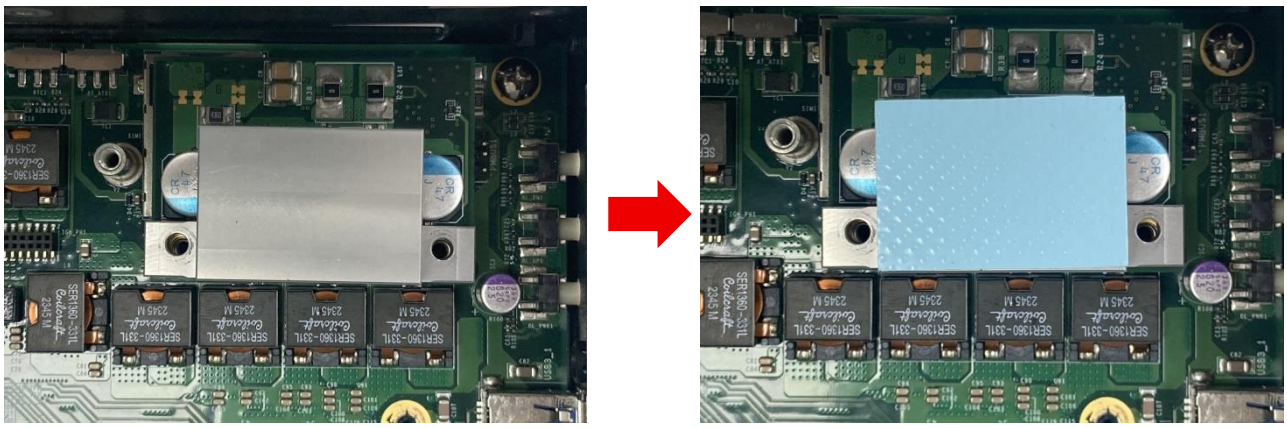
Step 3. Locate the PoE connector on the system motherboard as indicated.



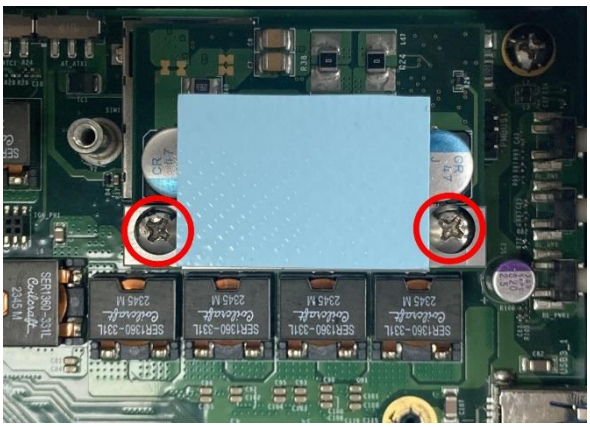
Step 4. Carefully align the connector of the PoE board with the pins and insert the module onto the motherboard.



Step 5. Install the PoE heatsink and apply a thermal pad.



Step 6. Fasten two screws to secure it to the motherboard.



CAUTION (ATTENTION)

Before assembling the system's chassis cover, please make sure the protective films on the Thermal Pads have been removed!

(Avant d'assembler le capot du châssis du système, assurez-vous que les films de protection sur les coussinets thermiques ont été retirés !)

3.8 Installing PCI(e) Card

The applicable riser cards for the P2302E are listed in the table below.

Item	Model No.	Description	Compatible Model
1	RC-E4-02	Riser Card with 1 x PCIex4 Slot	P2302E
2	RC-PI-02	Riser Card with 1 x PCI Slot	P2302E

The installation method for both item 1 and item 2 is the same. Therefore, this chapter uses the P2302E with the RC-E4-02 riser card as an example to illustrate the installation steps.

Step 1. Loosen the two screws as indicated at rear panel.



Step 2. Attach the PCI / PCIe Card Installation Kit (included in the package), and fasten the two screws back onto the rear panel to secure it.

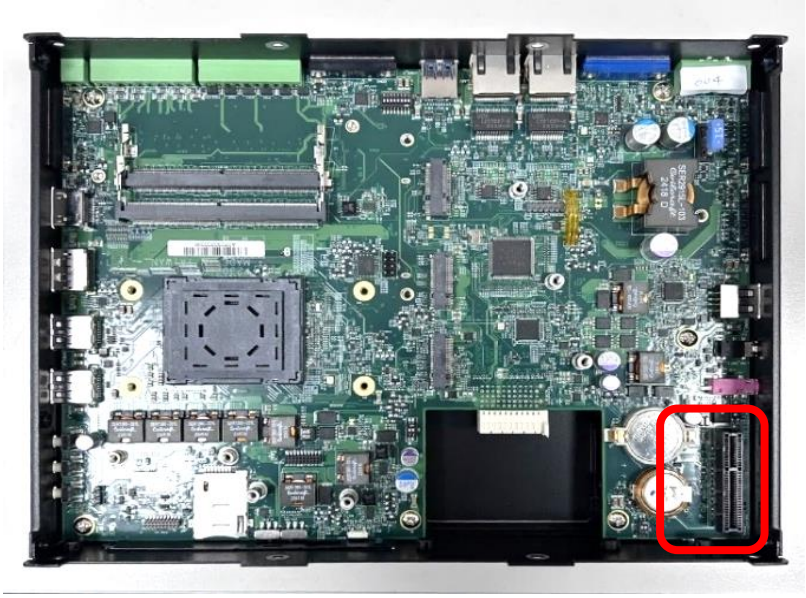




Step 3. Loosen the screw as indicated to remove the L-shaped bracket.



Step 4. Locate the PCIE1 connector.



Step 5. Align the notch on the golden fingers of the riser card with the slot. Insert the card vertically, and press it straight down until it is firmly seated.



Step 6. Fasten the screw (M3x5L) to fix the riser card.



Step 7. Locate the PCI(e) slot on the riser card. Align the notch on the golden fingers of the PCI(e) card with the slot, then insert the card horizontally and press it firmly into place until fully seated.





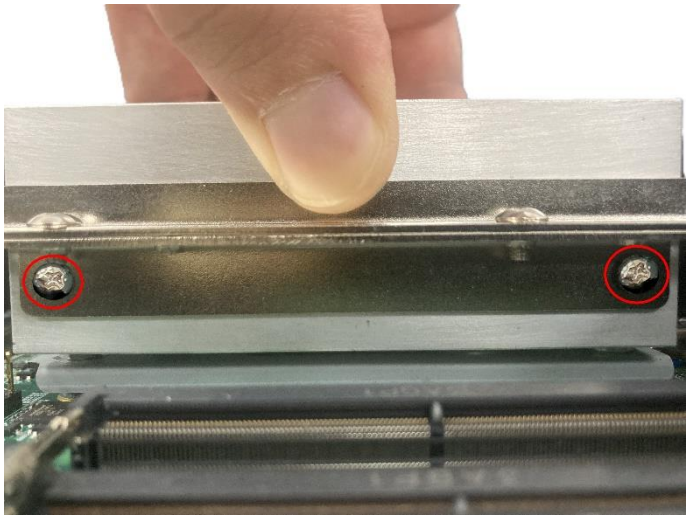
Step 8. Fasten the screw back to secure the PCI(e) card.



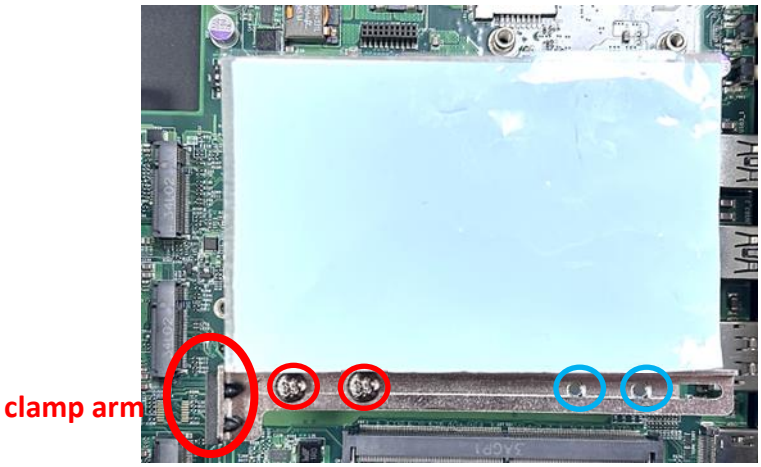
Step 9. Loosen the two screws as indicated on the rear panel to provide access into the system.



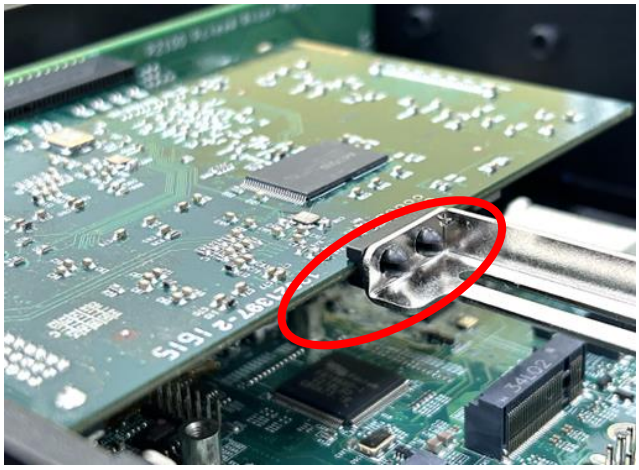
Step 10. Fasten the clamp arm to the CPU heatsink with two screws as indicated.



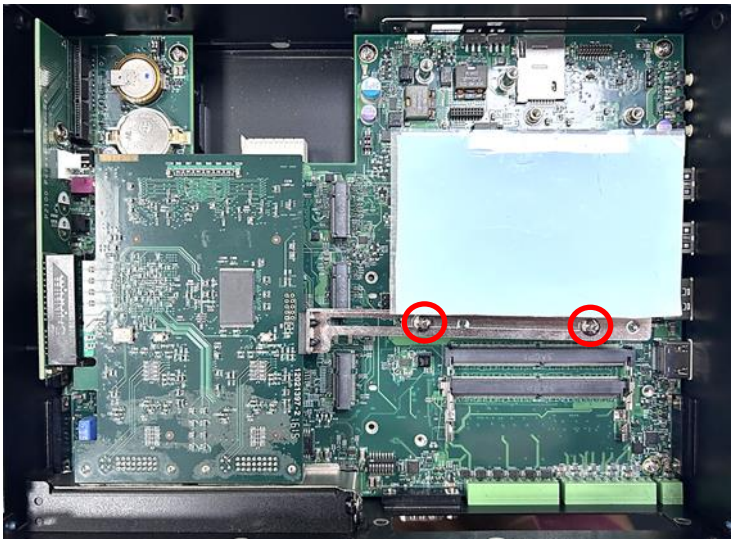
Step 11. Loosen the two screws or adjust their positions as needed. You may also relocate them to the screw holes indicated in blue, depending on the size of the PCI(e) card, to allow the clamp arm to slide freely and extend far enough to secure the card in place.



Step 12. Slide the clamp arm of retention module until it contacts the edge of PCI(e) card.

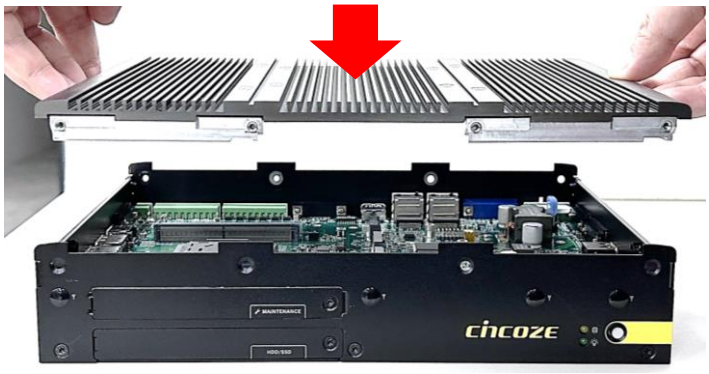


Step 13. Finally, fasten the two screws that were previously loosened to fix the clamp arm in place.

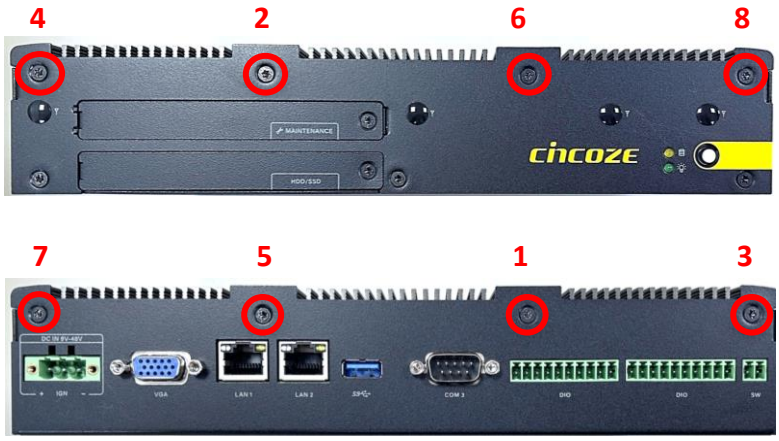


3.9 Installing Top Cover

Step 1. Place the top cover back onto the system.



Step 2. Gently press down on the top cover to align the screw holes, then fasten screws 1 to 4 in order. Once secured, proceed to fasten screws 5 to 8 in order.



3.10 Installing SATA Hard Drive at Front Panel

Step 1. Loosen the screw to remove the HDD bay cover bracket.



Step 2. Loosen the screw as indicated on the HDD bracket.



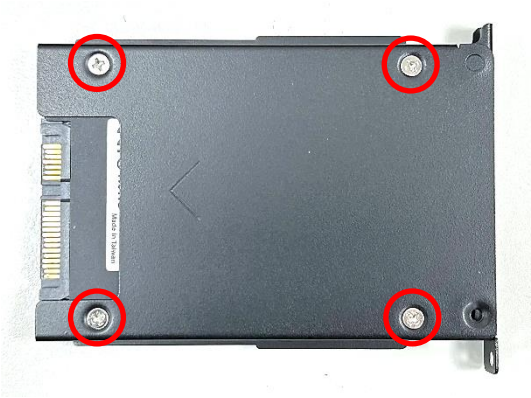
Step 3. Pull the rotating arm of HDD bracket outward as indicated.



Step 4. Hold the rotating arm to pull out the HDD bracket.



Step 5. Place the HDD bracket on screw-hole side of HDD. Use four screws provided to assemble HDD on the bracket.



Step 6. Align the HDD bracket with the entrance of HDD bay. And insert the HDD bracket and push it until the edge connector of HDD fully inserted into SATA slot.



Step 7. Fasten the screw as indicated on the HDD bracket.

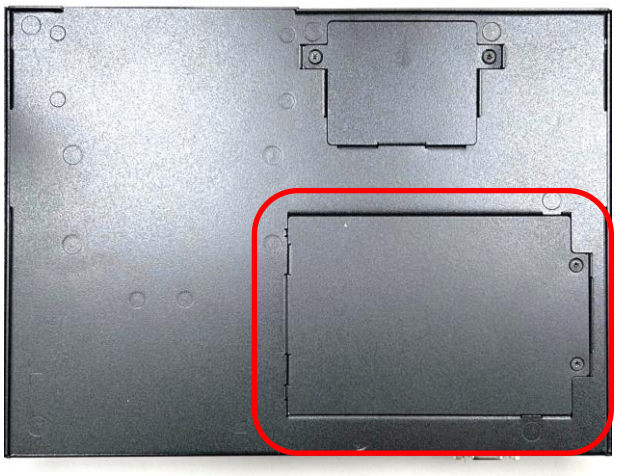


Step 8. Put back HDD bay cover at front panel, and fasten it with the screw.

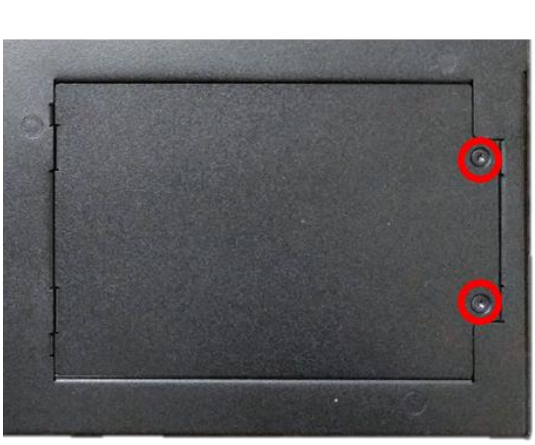


3.11 Installing SATA hard drive on Bottom Side

Step 1. Turn over the system to bottom side. Locate the cover of HDD compartment.

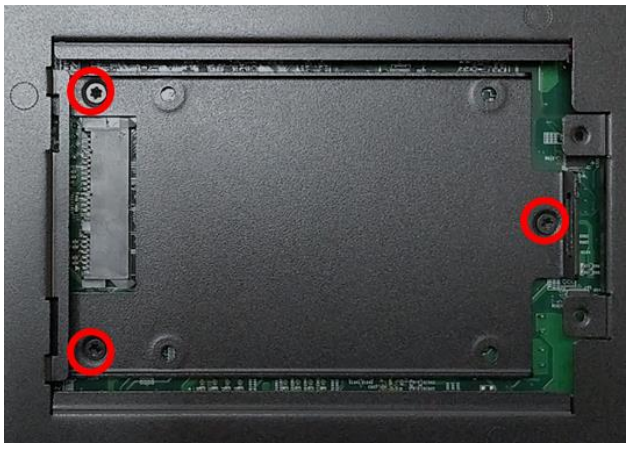


Step 2. Loosen the two screws, lift the cover, and then remove it.





Step 3. Loosen three screws and take the HDD bracket out of HDD compartment.



Step 4. Place the HDD bracket on screw-hole side of HDD. Use four screws provided to assemble HDD on the bracket.



Step 5. Seat the HDD bracket into HDD compartment, and line up the connector of HDD with SATA slot, then push it until HDD is fully connected into slot.



Step 6. Secure the HDD bracket with three screws.



Step 7. Put back the cover and fasten the two screws.



3.12 Installing SIM Card

Please install a 5G/4G module before the SIM card installation for the SIM application.

Step 1. Loosen the screw to remove the Maintenance cover bracket.



Step 2. Locate the SIM card slot.

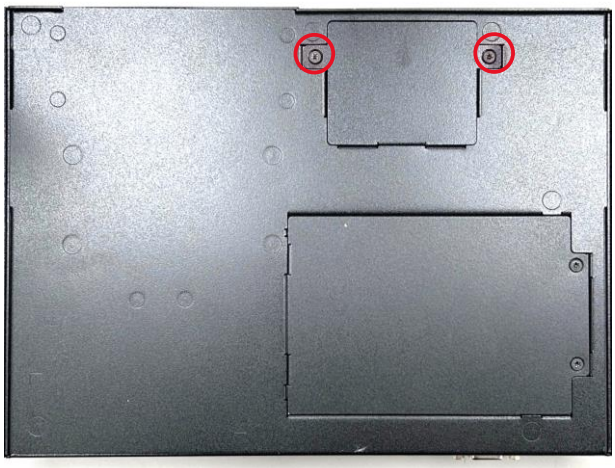


Step 3. Insert a SIM card into the SIM slot with the gold contacts facing down. Please pay attention to the insert orientation as illustrated.

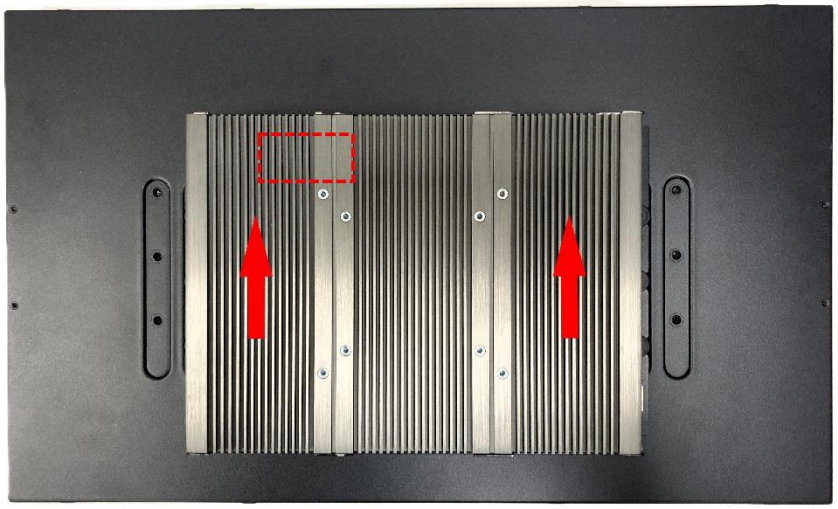


3.13 Installing Display Module

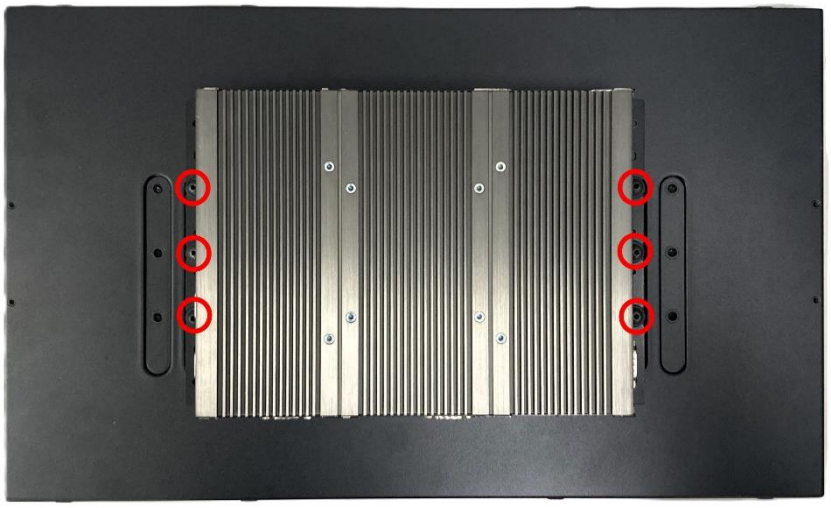
Step 1. Flip the system upside down and remove the two screws indicated below.



Step 2. Align the connectors and connect the display module with the PC module.



Step 3. Secure the PC module to the display module using 6 screws as indicated below.



3.14 Installing Panel Mount

Step 1. Prepare the mounting kits included with the display.



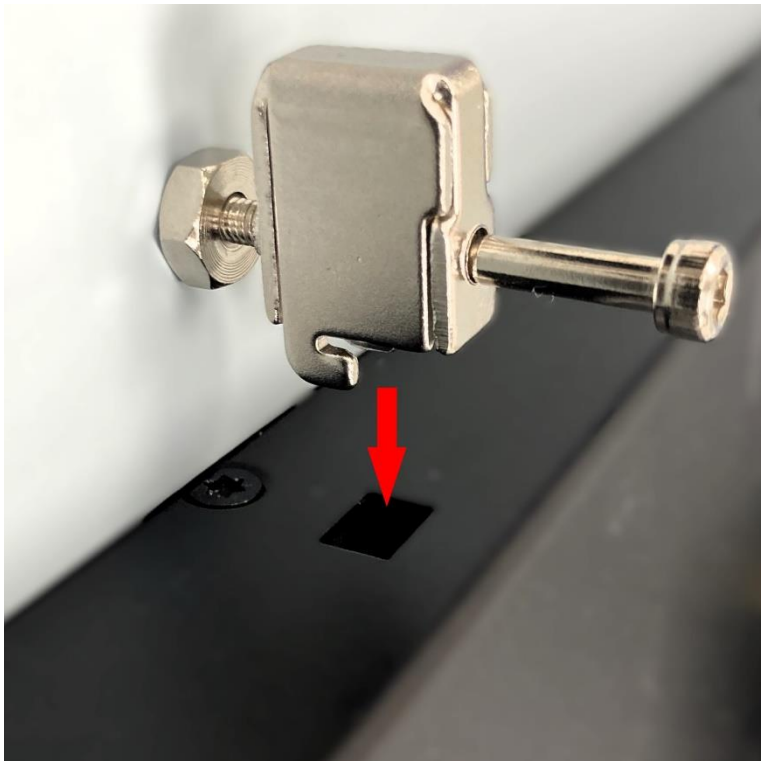
Step 2. Slot the Panel PC (PPC) into the fixture.



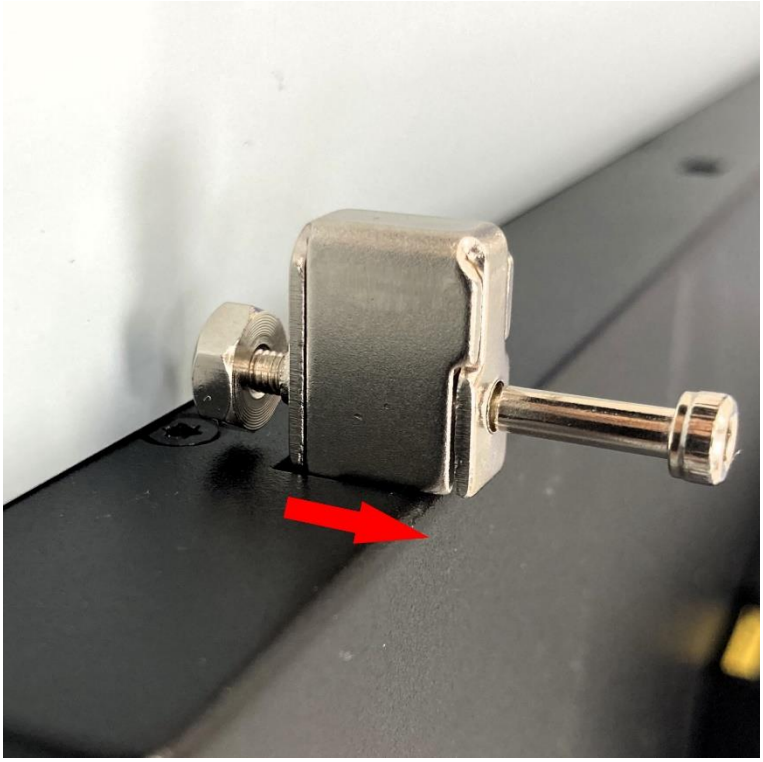
Step 3. Remove all plastic covers.



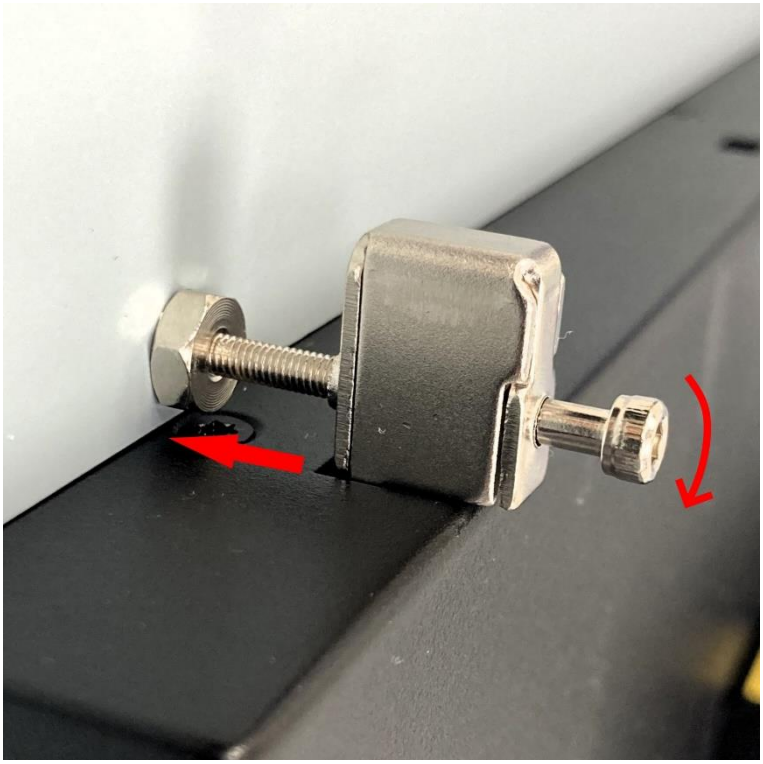
Step 4. Insert the Mounting Kit with the hook facing away from the fixture.



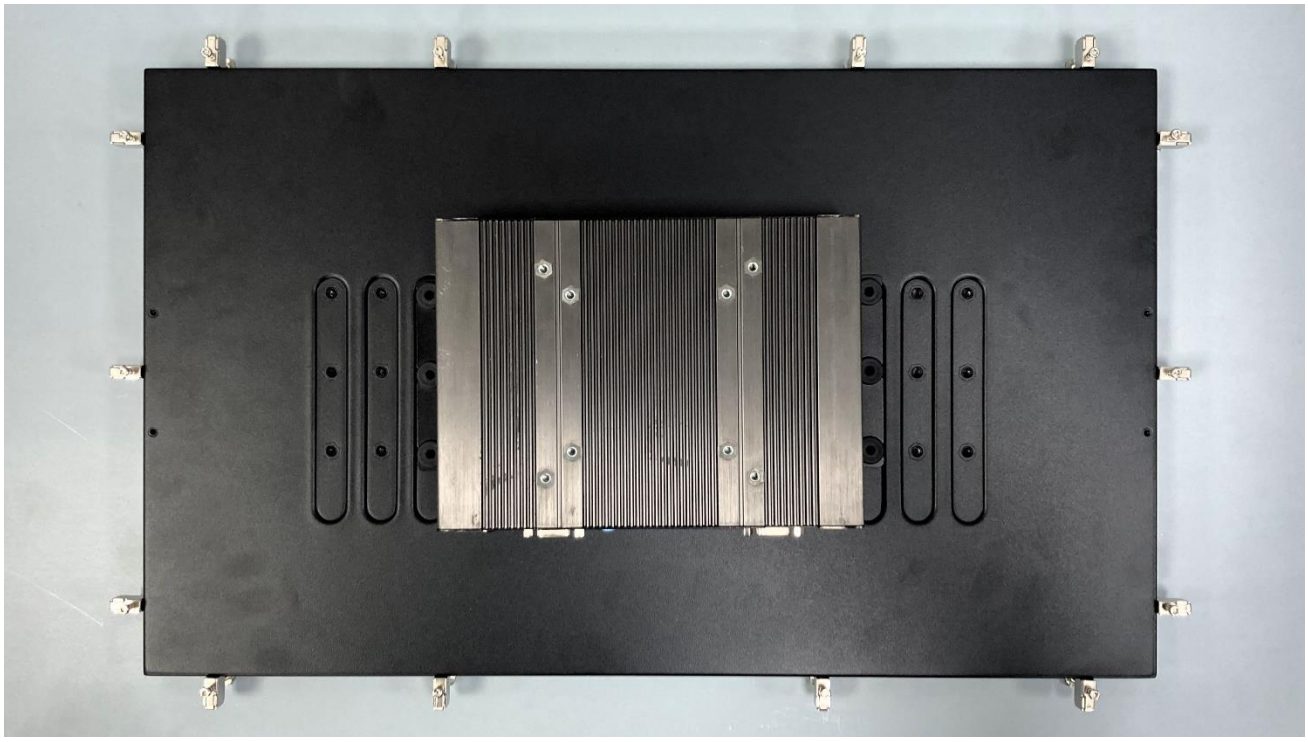
Step 5. Slide the Mounting Kit away from the fixture to lock it in place.



Step 6. Tighten the screw on the Mounting Kit until the other end sits flush against the fixture.

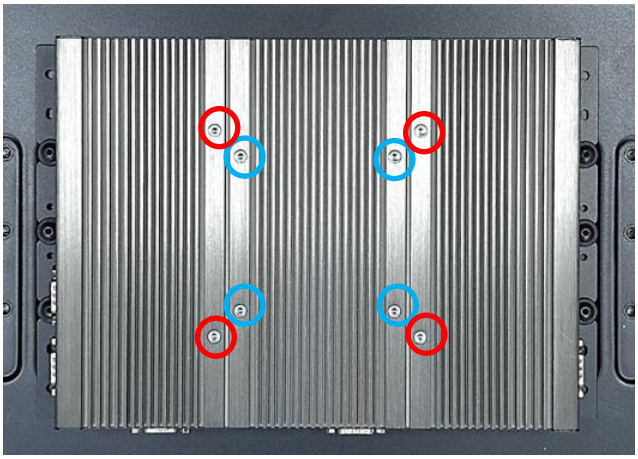


Step 7. Repeat steps 4-6 until all Mounting Kits have been installed. In this example (CV-221C), 14 Mounting Kits are required to secure the display to the fixture.

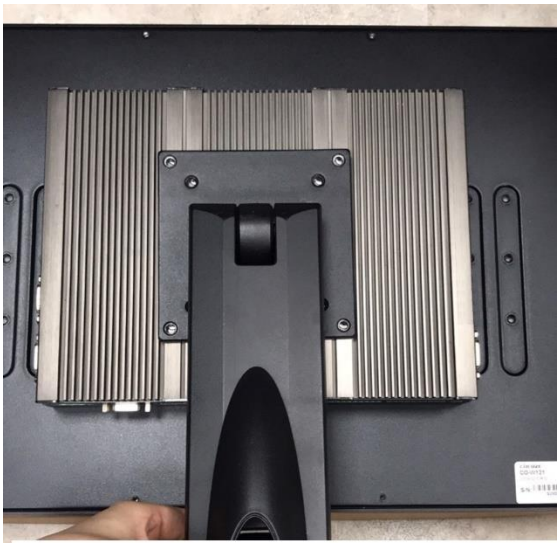


3.15 Installing VESA Mount

The P2302 series supports VESA mounting for both the VESA 75mm and 100 mm standards. The 75mm VESA standard uses the screw holes marked in blue. The 100mm VESA standard uses the screw holes marked in red.



Step 1. The following picture uses a panel PC (P2302+ Display Module) as a demonstration. Align the VESA stand with the screw holes on the system, then secure it in place by tightening the corresponding number of screws as shown below. (Please note the VESA mounting holes deep 3 mm at the back of the terminal are provided with M4-type blind fasteners to fix the VESA mounting plate. Please select a suitable screw length (L) based on the on-site application.) After completing this step, the VESA mount installation for the system is complete.

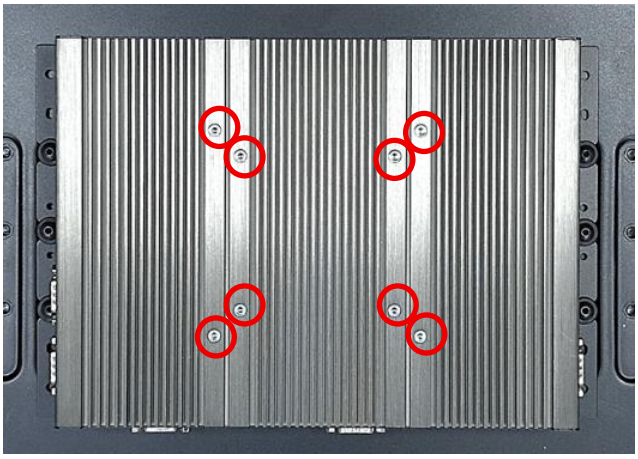


Step 2. Fasten the VESA mount screws to complete the VESA mounting.

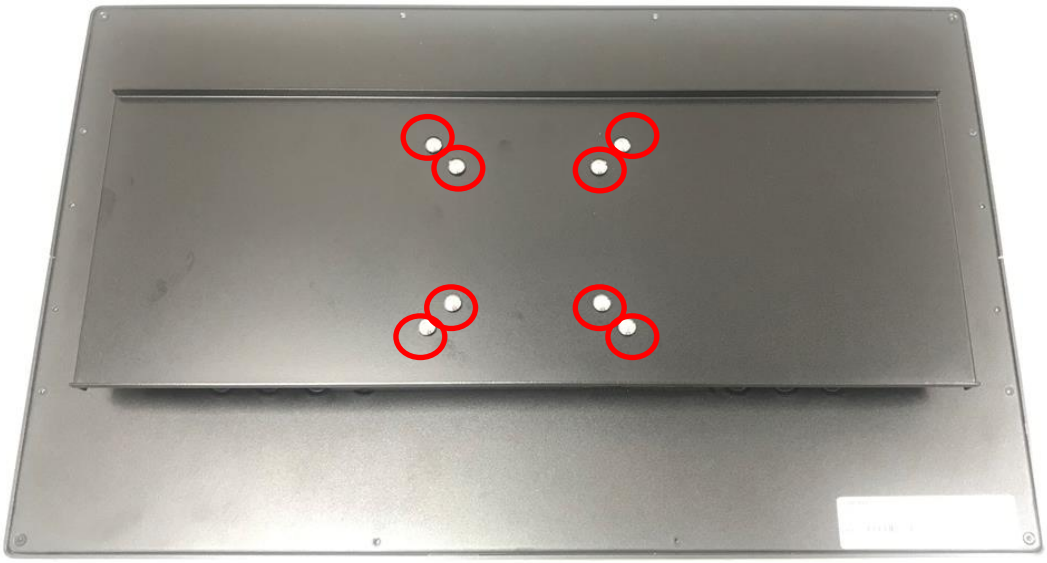


3.16 Installing Rack Mount

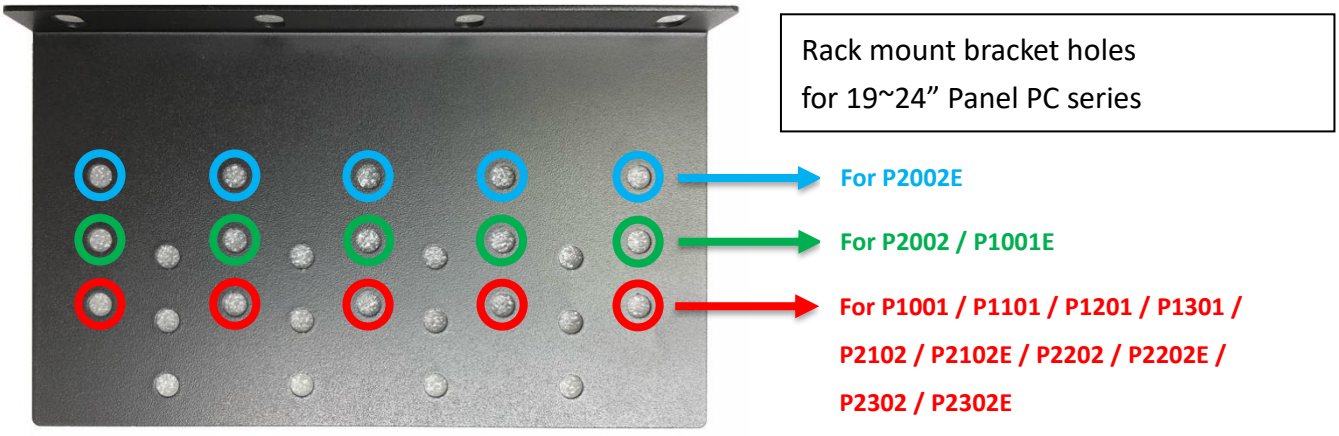
Step 1. Locate the screw holes on the PC or monitor module.

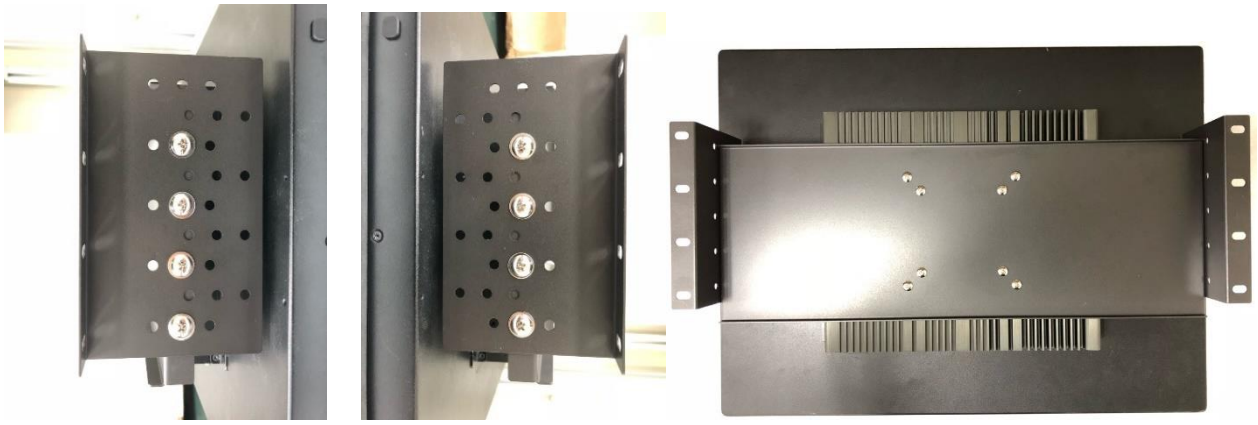


Step 2. Put on the rack mount base and fasten the screws.



Step 3. Assemble two rack mount brackets by fastening 4 screws (M5x6) at each side.





Left Right Bottom

Step 4. Assemble two rack mount brackets by fastening 4 screws (M5x12), flat washers and hex nuts at each side.



Chapter 4
BIOS Setup

4.1 BIOS Introduction

The BIOS (Basic Input/ Output System) is a program located on a Flash Memory on the motherboard. When you start the computer, the BIOS program will gain control. The BIOS first operates an auto-diagnostic test called POST (power on self-test) for all the necessary hardware, it detects the entire hardware device and configures the parameters of the hardware synchronization.

BIOS Setup

Power on the computer and by pressing <Del> immediately allows you to enter Setup. If the message disappears before your respond and you still wish to enter Setup, restart the system to try again by turning it OFF then ON or pressing <Ctrl>, <Alt> and <Delete> keys.

Control Keys	
<←> <→>	Move to select screen
<↑> <↓>	Move to select item
<Esc>	Quit the BIOS Setup
<Enter>	Select item
<Page Up/+>	Increases the numeric value or makes changes
<Page Down/->	Decreases the numeric value or makes changes
<Tab>	Select setup fields
<F1>	General help
<F2>	Previous value
<F3>	Load Optimized defaults
<F10>	Save configuration and Exit

Main Menu

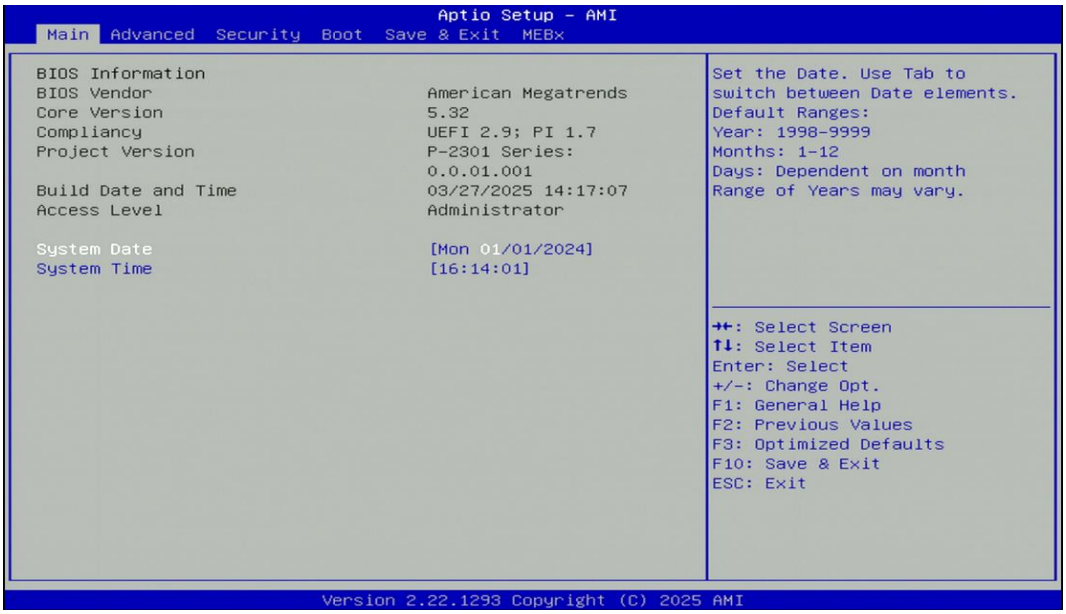
The main menu lists the setup functions you can make changes to. You can use the arrow keys (↑↓) to select the item. The on-line description of the highlighted setup function is displayed at the bottom of the screen.

Sub-Menu

If you find a right pointer symbol appears to the left of certain fields that means a sub-menu can be launched from this field. A sub-menu contains additional options for a field parameter. You can use arrow keys (↑↓) to highlight the field and press <Enter> to call up the sub-menu. Then you can use the control keys to enter values and move from field to field within a sub-menu. If you want to return to the main menu, just press the <Esc >.

4.2 Main Setup

Press <Del> to enter BIOS CMOS Setup Utility, the Main Menu (as shown below) will appears on the screen. Use arrow keys to move among the items and press <Enter> to accept or enter a sub-menu.



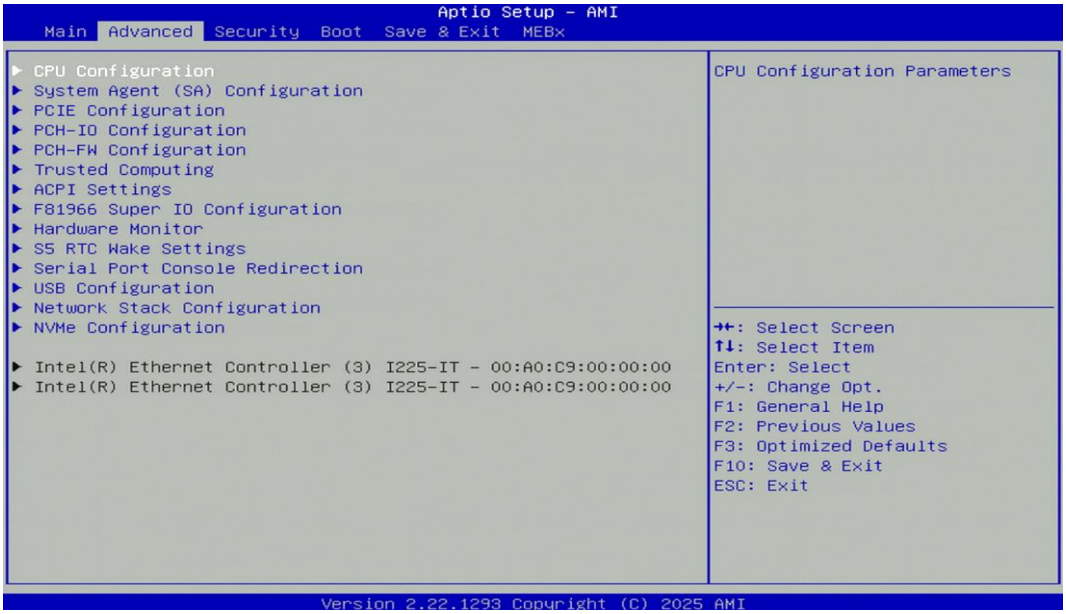
4.2.1 System Date

Set the date. Please use <Tab> to switch between date elements.

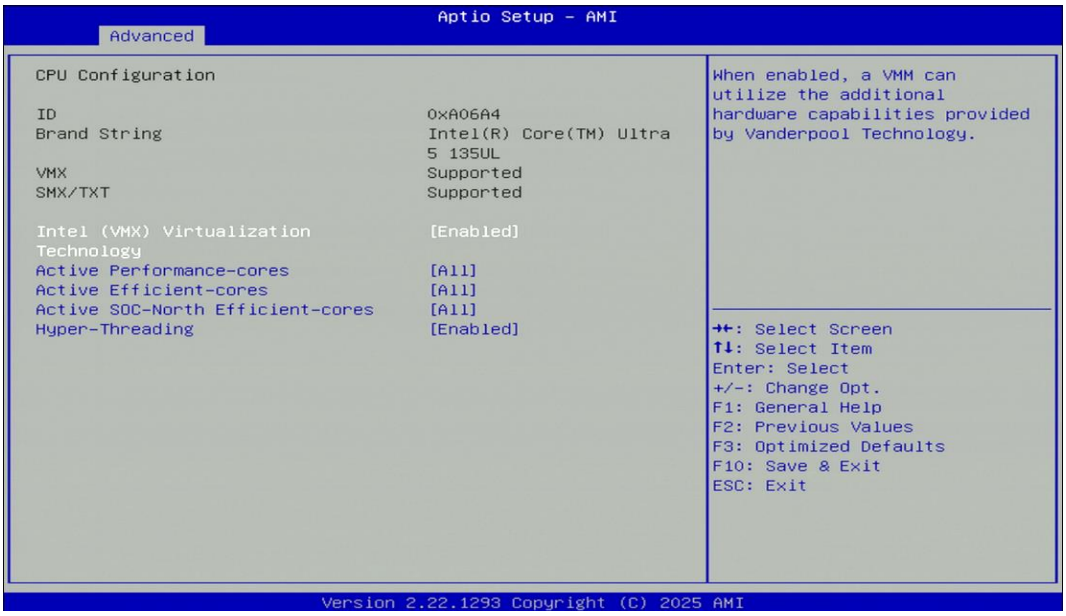
4.2.2 System Time

Set the time. Please use <Tab> to switch between time elements.

4.3 Advanced Setup



4.3.1 CPU Configuration



- **Intel® (VMX) Virtualization Technology [Enabled]**

  Enables or disables Intel® Virtualization Technology. Virtualization enhanced by Intel® Virtualization Technology will allow a platform to run multiple operating systems and applications in independent partitions. With virtualization, one computer system can function as multiple virtual systems.

- **Active Performance-cores [All]**

  Allows you to choose the number of active performance cores.

  Configuration options: [All] [1]

- **Active Efficient-cores [All]**

  Allows you to choose the number of active efficient cores.

  Configuration options: [All] [7] [6] [5] [4] [3] [2] [1] [0]

- **Active SOC-North Efficient-cores [All]**

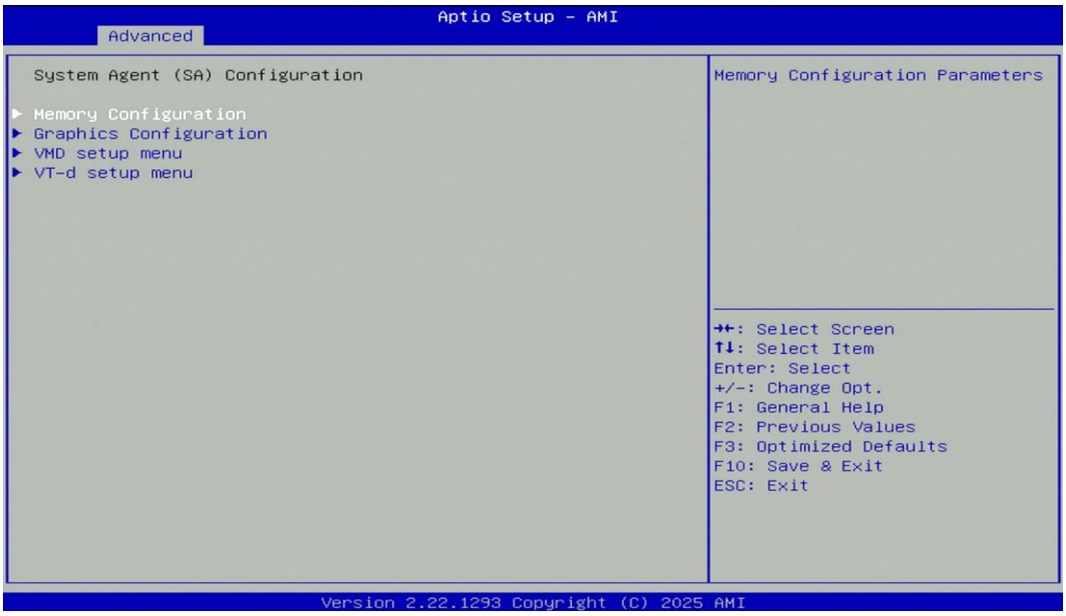
  Allows you to choose the number of active SOC-North Efficient-cores.

  Configuration options: [All] [1] [0]

- **Hyper-Threading [Enabled]**

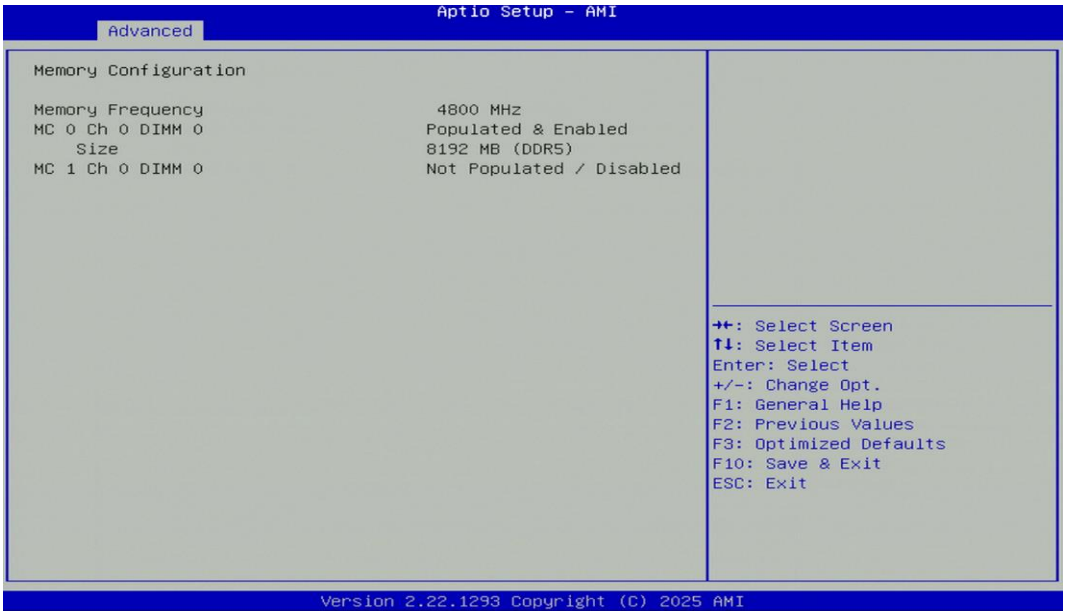
  Allows you to enable or disable Intel® Hyper-Threading function of processor.

4.3.2 System Agent (SA) Configuration

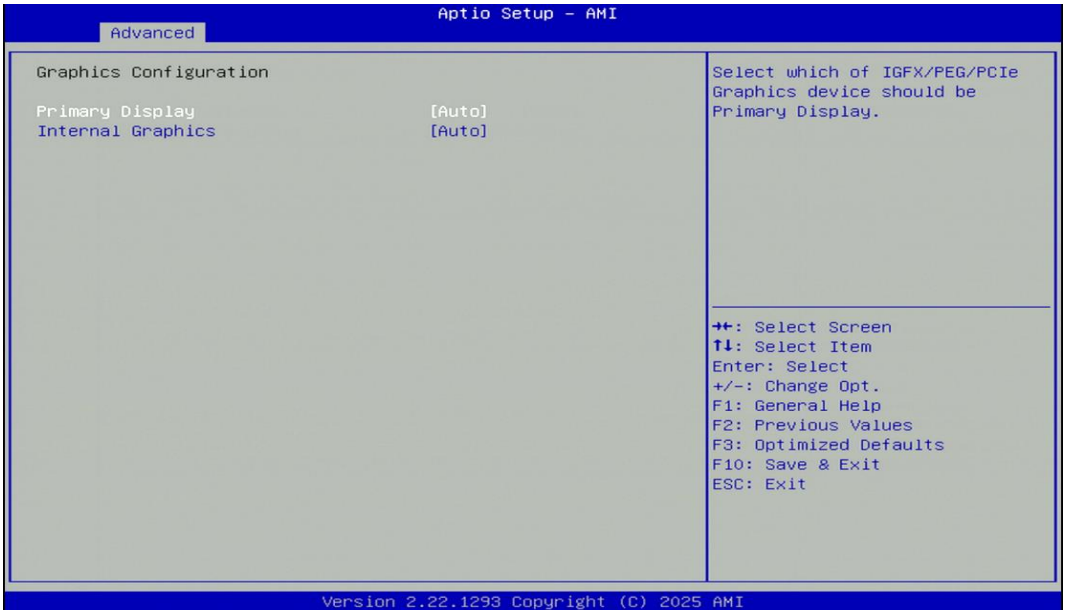


❑ **Memory Configuration**

This item displays detailed memory information in the system.



❑ Graphics Configuration



- **Primary Display [Auto]**

  Allows users to select which graphics device should be primary display or select SG for switchable graphics. Configuration options: [Auto] [IGFX]

- **Internal Graphics [Auto]**

  This item allows users to enable or disable Internal Graphics. When set to [Auto], it will detect by BIOS. Configuration options: [Auto] [Disabled] [Enabled]

❑ VMD Setup Menu



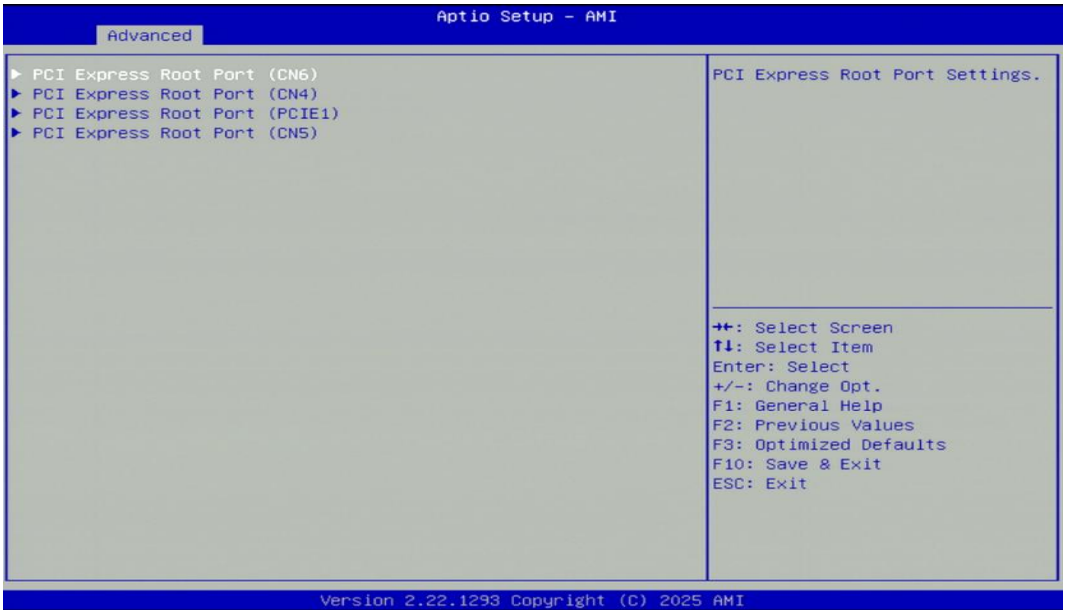
- **Enable VMD controller [Disabled]**

  This item allows users to enable or disable VMD controller. Enable this function can support creating RAID.

❑ VT-d Configuration



❑ PCIE Configuration



❑ PCI Express Root Port CN6

- **PCI Express Root Port [Enabled]**

  Allows you to enable or disable the PCI Express Port.

- **PCIe Speed [Auto]**

  Allows you to select PCI Express interface speed.

  Configuration options: [Auto] [Gen1] [Gen2] [Gen3] [Gen4].

❑ PCI Express Root Port CN4

- **PCI Express Root Port [Enabled]**

  Allows you to enable or disable the PCI Express Port.

- **PCIe Speed [Auto]**

  Allows you to select PCI Express interface speed.

  Configuration options: [Auto] [Gen1] [Gen2] [Gen3] [Gen4].

❑ **PCI Express Root Port PCIE1**

■ **PCI Express Root Port [Enabled]**

Allows you to enable or disable the PCI Express Port.

■ **PCIe Speed [Auto]**

Allows you to select PCI Express interface speed.

Configuration options: [Auto] [Gen1] [Gen2] [Gen3].

❑ **PCI Express Root Port CN5**

■ **PCI Express Root Port [Enabled]**

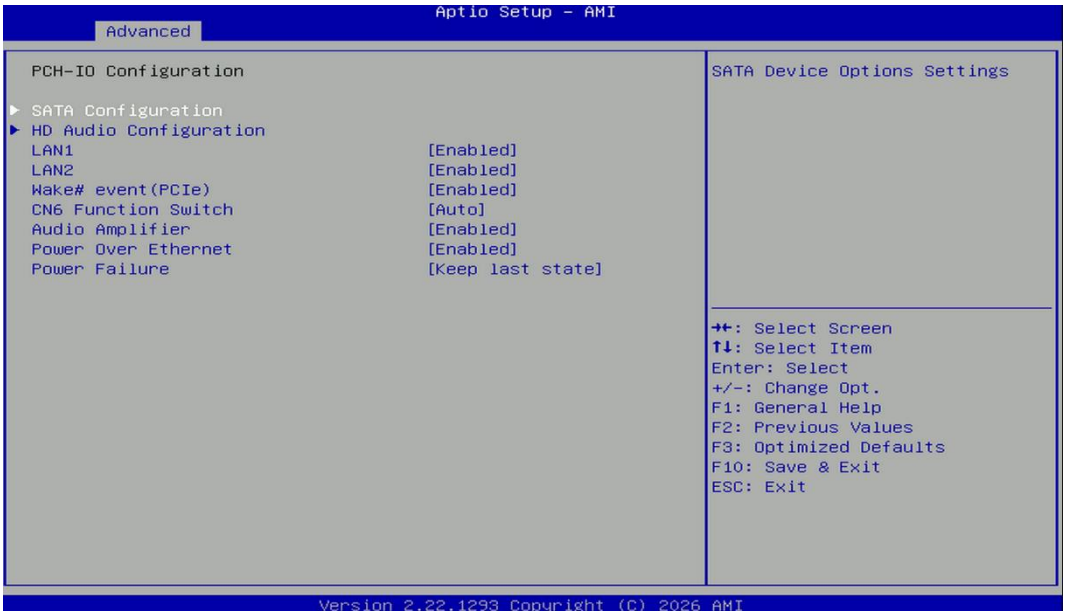
Allows you to enable or disable the PCI Express Port.

■ **PCIe Speed [Auto]**

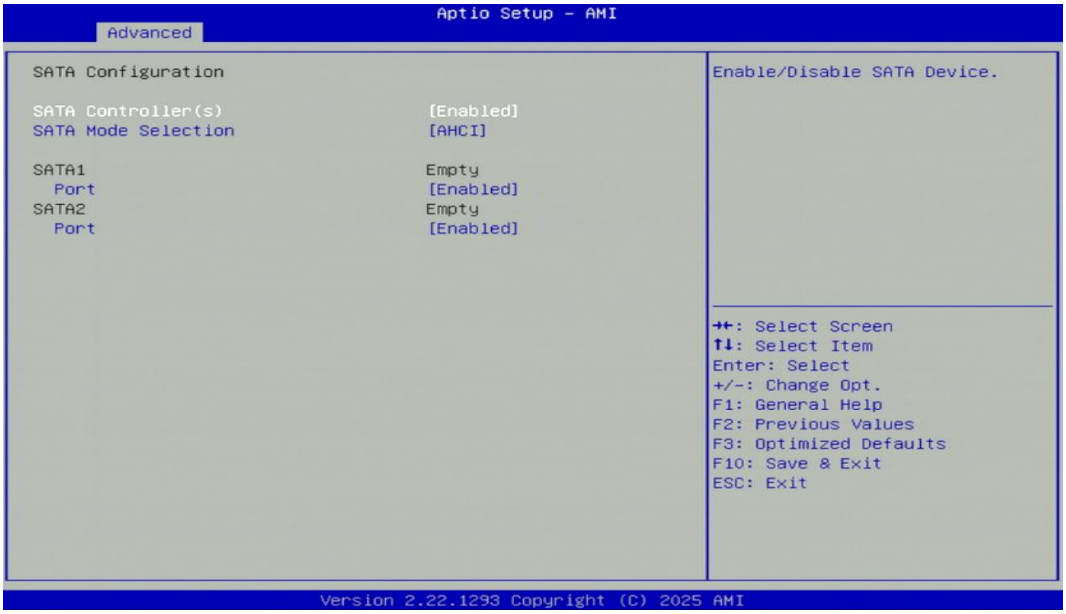
Allows you to select PCI Express interface speed.

Configuration options: [Auto] [Gen1] [Gen2] [Gen3] [Gen4].

4.3.3 PCH-IO Configuration



❑ **SATA Configuration**



- **SATA Controller(s) [Enabled]**

  Enables or disables Serial ATA controller.

- **SATA Mode [AHCI]**

  This item allows users to choose [AHCI] mode.

- **Serial ATA Port 1**

  Port [Enabled]

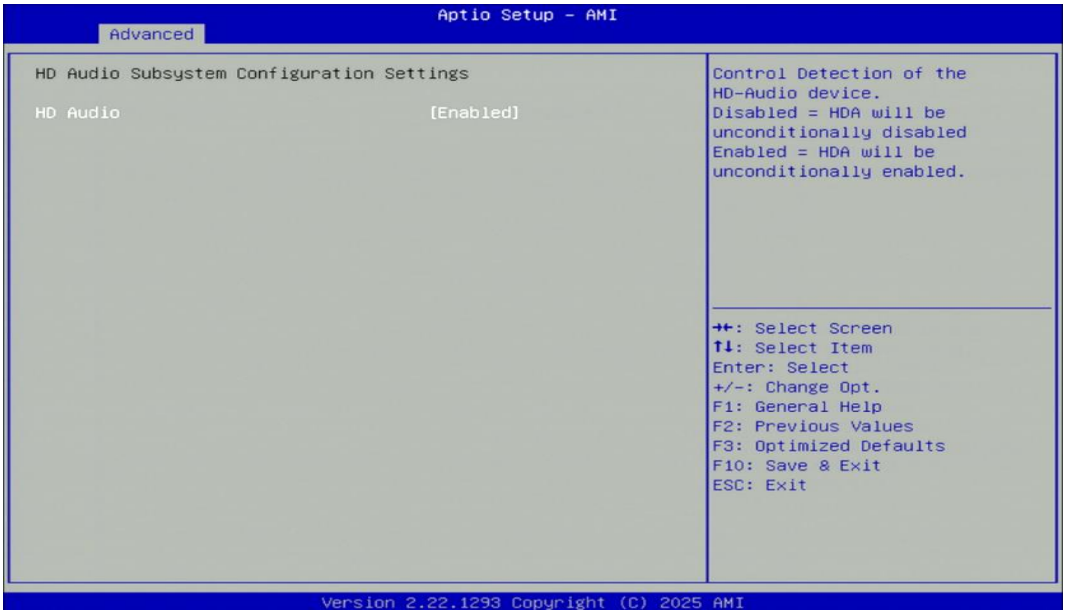
  Enables or disables SATA Port 1.

- **Serial ATA Port 2**

  Port [Enabled]

  Enables or disables SATA Port 2.

❑ **HD Audio Configuration**



- **HD Audio [Enabled]**

  Allows you to select HD Audio options.

  [Enabled]: HD Audio device is unconditionally enabled.

  [Disabled]: HD Audio device is unconditionally disabled.

- **LAN1 [Enabled]**

  Enables or disables i226 LAN Controller.

- **LAN2 [Enabled]**

  Enables or disables i226 LAN Controller.

- **Wake# event (PCIe) [Enabled]**

  Enables or disables Wake# event (PCIe).

- **CN6 Function Switch [Mini-PCIe]**

  Allows you to change Function as [Auto], [SSD-PCIe], [WWAN-PCIe], or [WWAN-USB3].

- **Audio Amplifier [Enabled]**

  Enable or disable Audio Amplifier.

- **Power Over Ethernet Function [Enabled]**

  Enable or disable Power Over Ethernet (POE) function.

■ **Power Failure [Keep last state]**

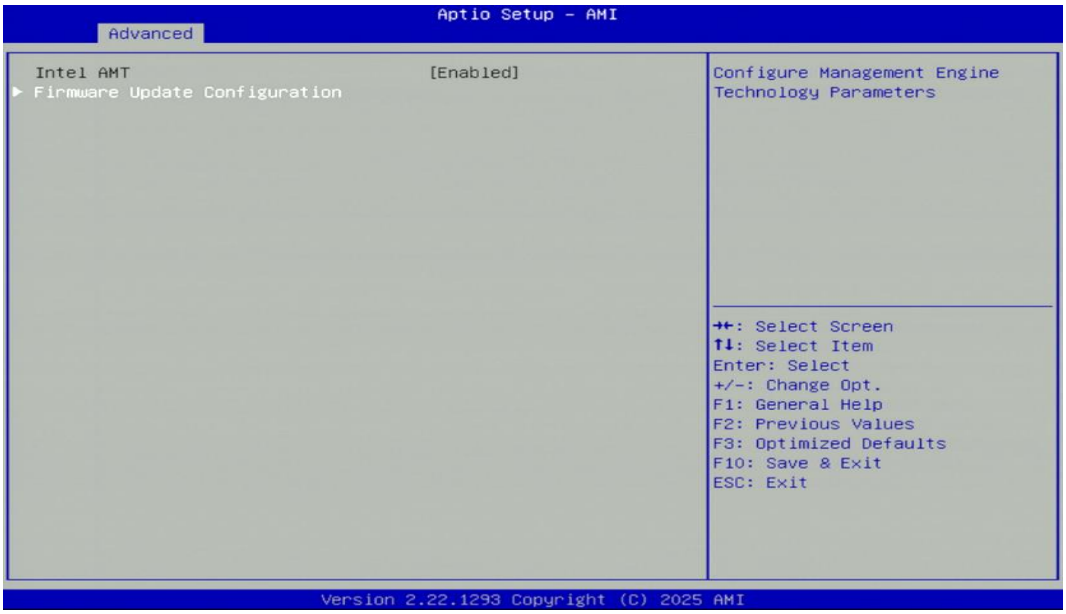
Allows you to specify which power state system will enter when power is resumed after a power failure (G3 state).

[Always on]: Enters to power on state.

[Always off]: Enters to power off state.

[Keep last state]: Enters to the last power state before a power failure.

4.3.4 PCH-FW Configuration



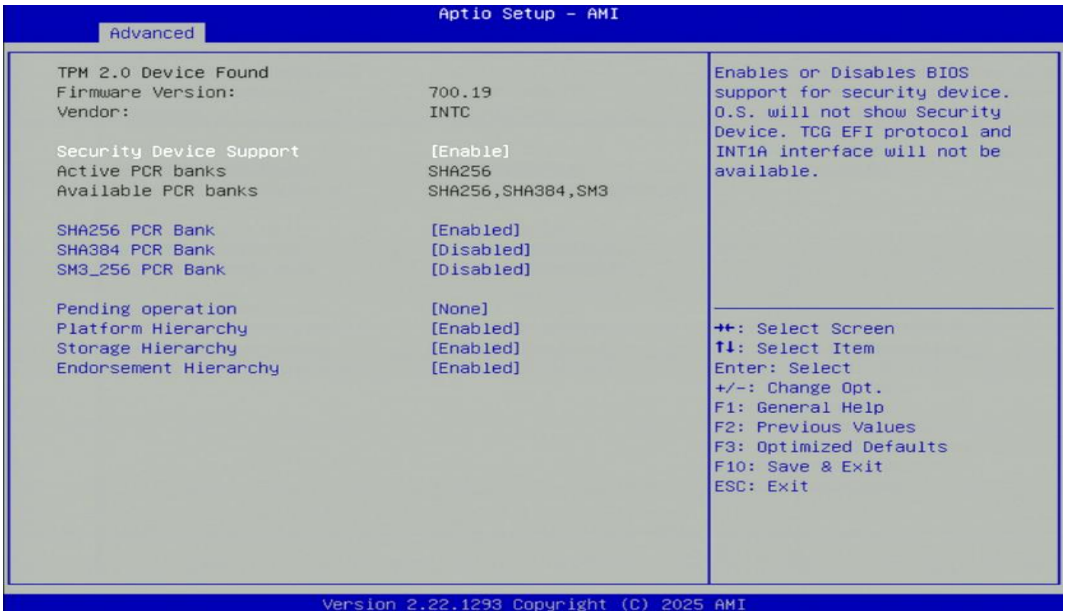
❑ **Firmware Update Configuration**



■ **ME FW Image Re-Flash [Disabled]**

Allows you to enable or disable ME firmware image re-flash function.

4.3.5 Trusted Computing



- **Security Device Support [Enable]**

  Allow you to enables or disables Security Device Support function.
- **SHA256 PCR Bank [Enabled]**

  Enables or disables SHA256 PCR Bank function.
- **SHA384 PCR Bank [Disabled]**

  Enables or disables SHA384 PCR Bank function.
- **SHA3_256 PCR Bank [Disabled]**

  Enables or disables SHA3_256 PCR Bank function.
- **Pending Operation [None]**

  Allows users to select which mode Pending Operation will operate.

  Configuration options: [None], [TPM Clear]
- **Platform Hierarchy [Enabled]**

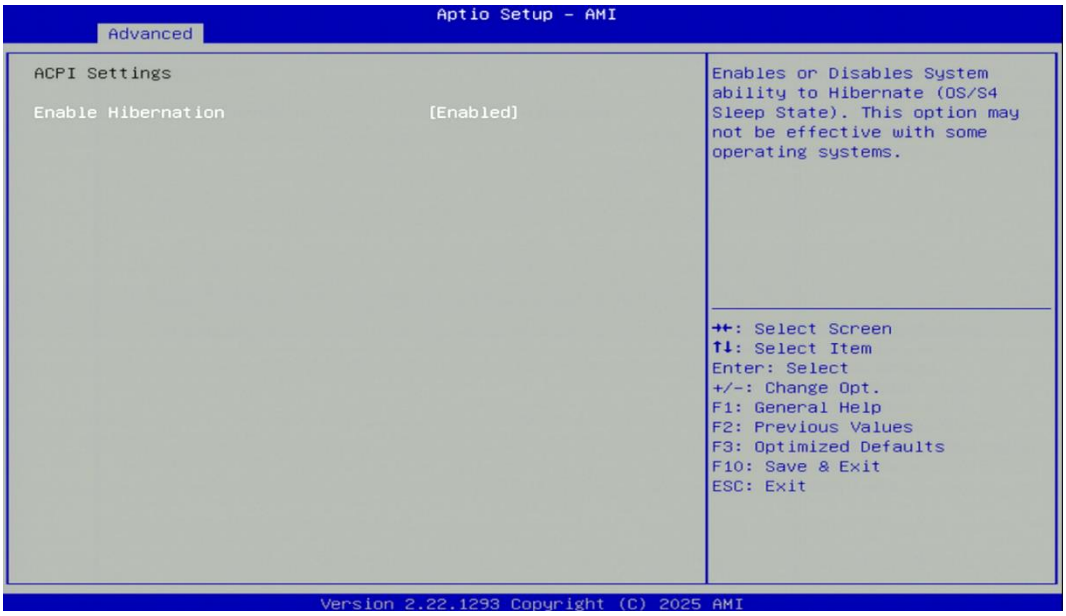
  Enables or disables Platform Hierarchy function.
- **Storage Hierarchy [Enabled]**

  Enables or disables Storage Hierarchy function.
- **Endorsement Hierarchy [Enabled]**

  Enables or disables Endorsement Hierarchy function.

4.3.6 ACPI Settings

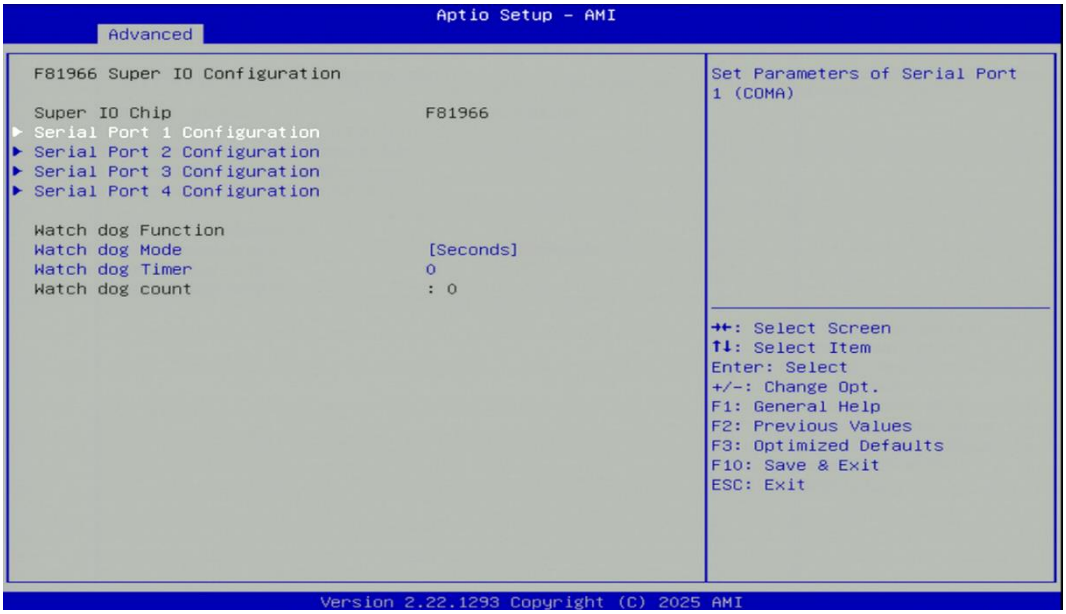
This item allows users to configure ACPI settings.



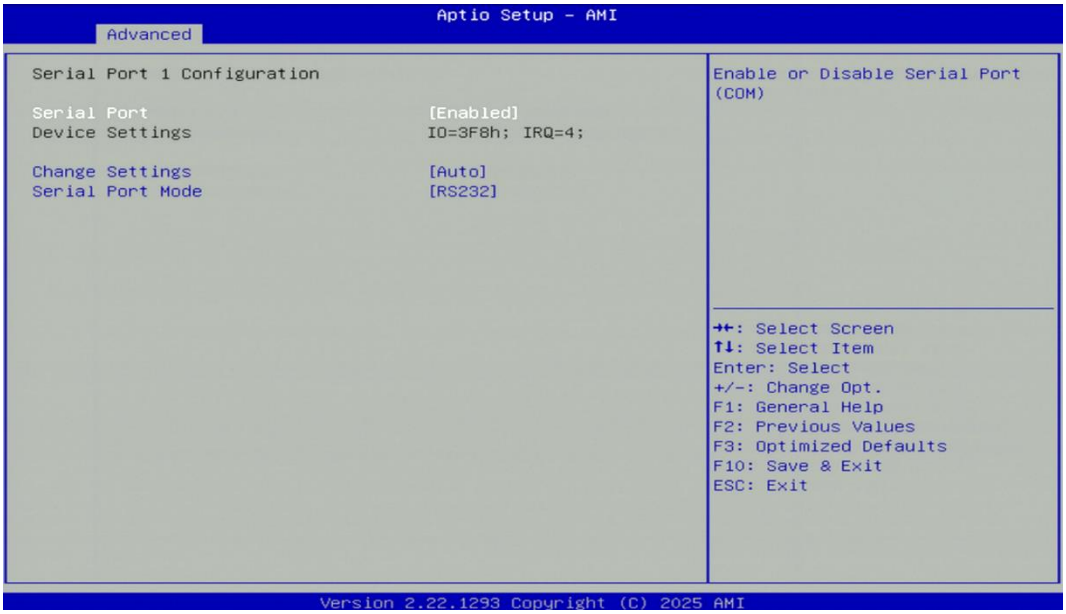
- **Enable ACPI Auto Configuration [Enabled]**
  Enables or disables BIOS Advanced Configuration Power Interface® (ACPI) auto configuration.

4.3.7 F81966 Super IO Configuration

The screen allows users to select options for the Super IO configuration, and change the value of the selected option.



❑ Serial Port 1~4 Configuration



- **Serial Port [Enabled]**

  This item allows users to enable or disable serial port.

- **Change Settings [Auto]**

  This item allows users to change the address & IRQ settings of the specified serial port.

- **Serial Port Mode [RS232]**

  This item allows users to select Serial Port Mode.

  Configuration options: [RS232] [RS422/RS485 Full Duplex] [RS485 Half Duplex]

- **Watch Dog [Disabled]**

  Enables or disables watch dog function.

- **Watch Dog Mode [Sec]**

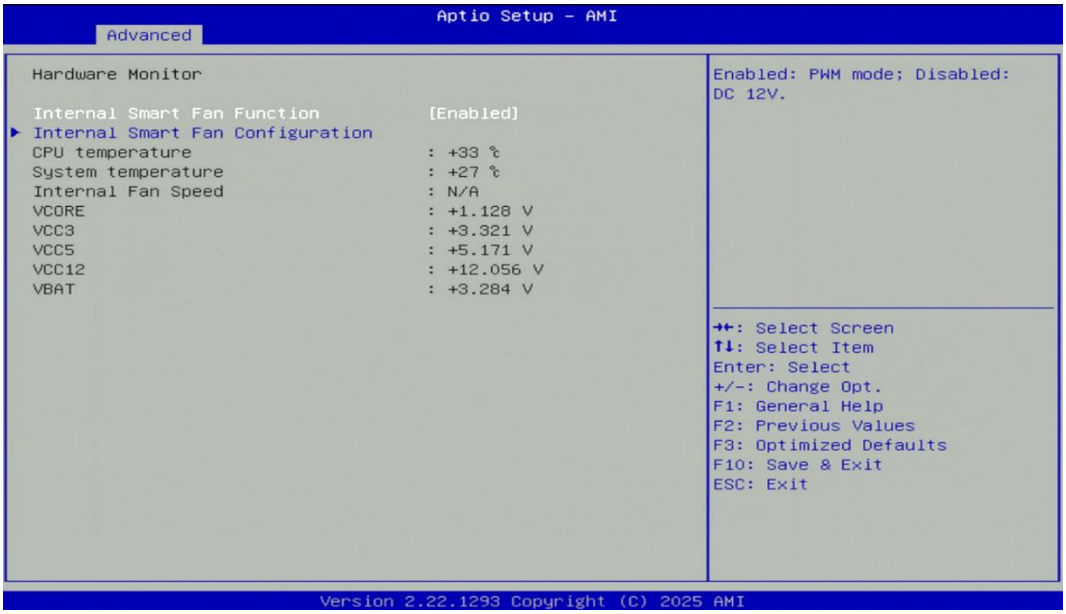
  Changes the Watch dog mode. Select [Sec] or [Min] mode.

- **Watch Dog Timer [0]**

  User can set a value in the range of 0 to 255.

4.3.8 Hardware Monitor

These items display the current status of all monitored hardware devices/ components such as voltages and temperatures.

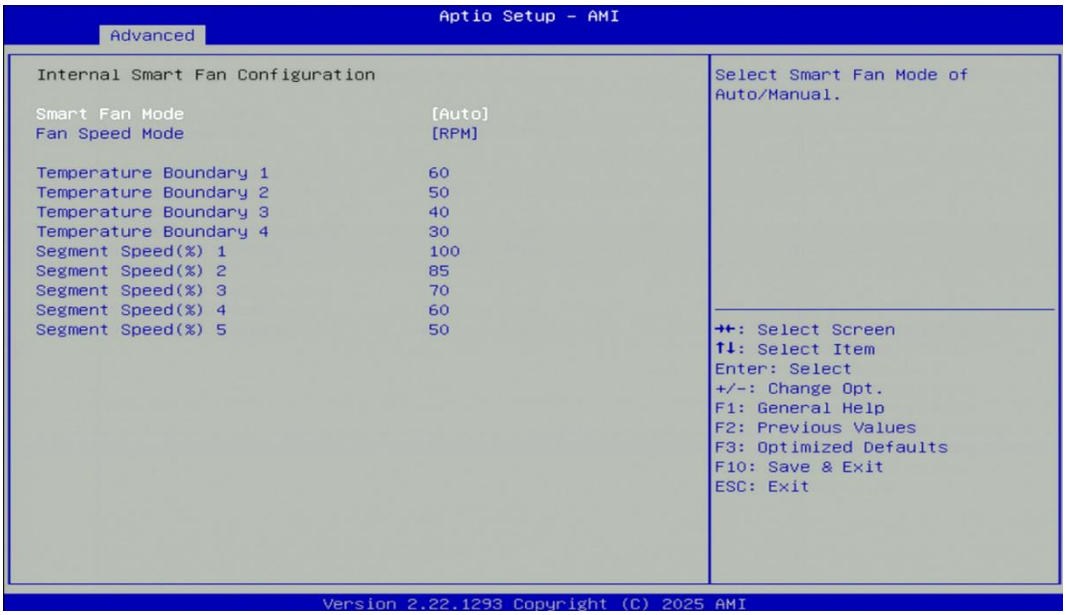


- **Internal Smart Fan Function [Enabled]**

  Enables or disables internal smart fan function. Please install the Riser Card (Model: RC-E4-02) and plug the power cord of the internal smart fan into the power socket on the Riser Card to effectively enable this function.

- **Internal Smart Fan Configuration**

Allows users to setting internal smart fan parameters.



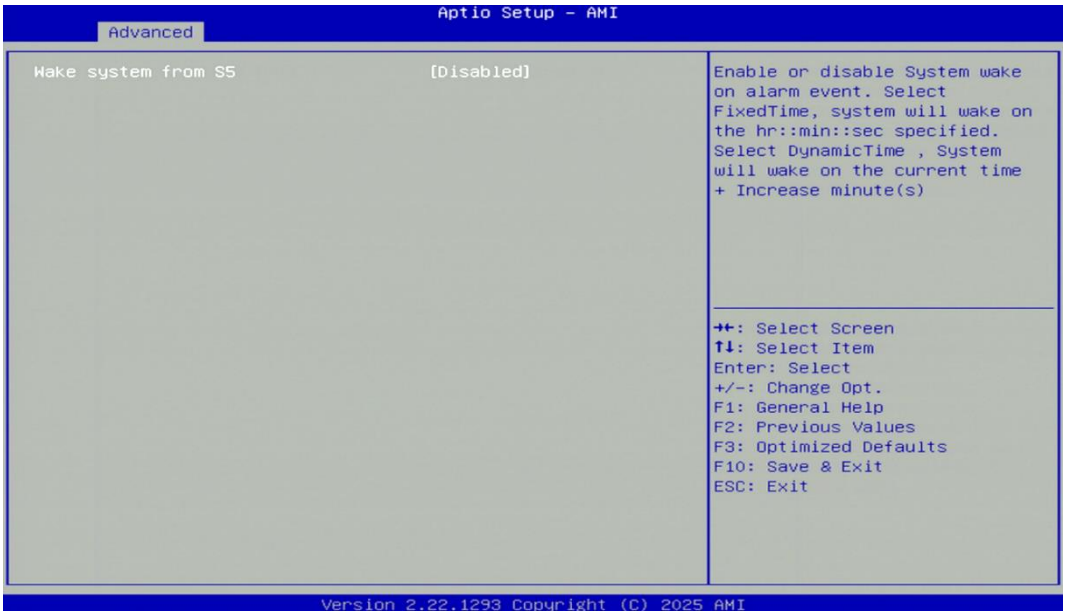
- **Smart Fan Mode [Auto]**

  This item allows users to select Auto or Manual for smart fan mode.

- **Fan Speed Mode [RPM]**

  This item allows users to select RPM or Duty for fan speed mode.

4.3.9 S5 RTC Wake Settings



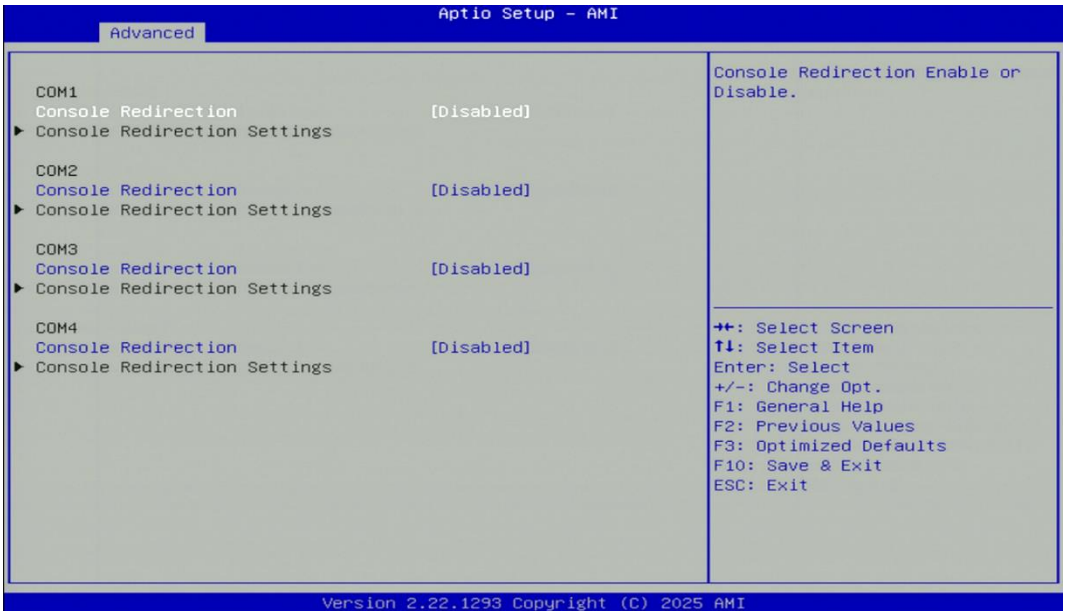
- **Wake System from S5 [Disabled]**

  This item allows users to change the way to wake system from S5 state.

  [Fixed Time]: Set the specified time (HH:MM:SS) to wake system.

  [Dynamic Time]: Set the increase time from current time to wake system.

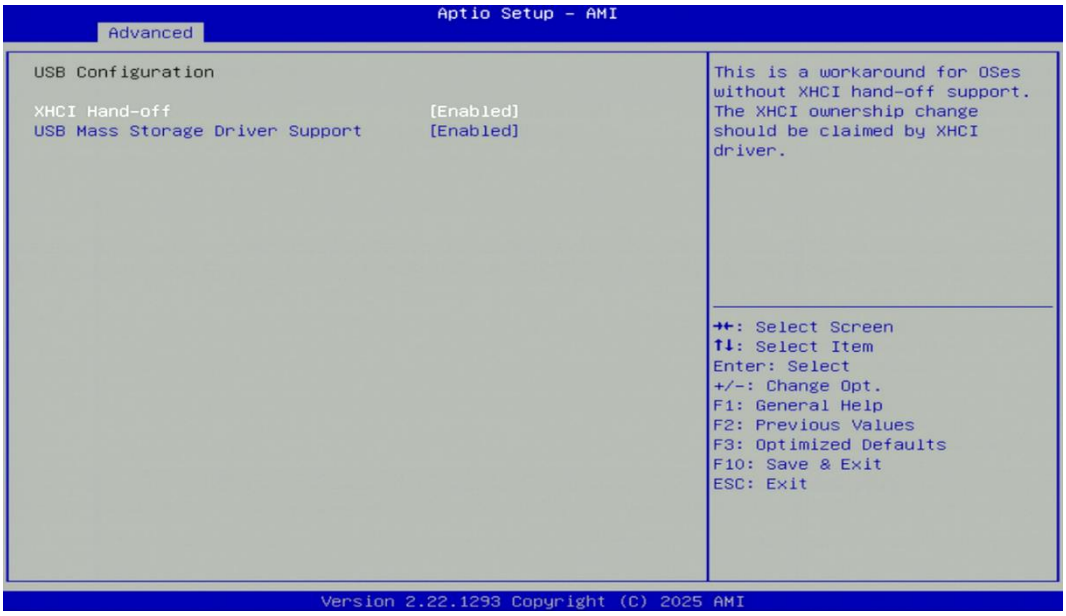
4.3.10 Serial Port Console Redirection



- **Console Redirection [Disabled]**

  These items allow users to enable or disable COM1, COM2, COM3, COM4 console redirection function.

4.3.11 USB Configuration



- **XHCI Hand-off [Enabled]**

  This item allows users to enable or disable XHCI (USB3.2) hand-off function.

- **USB Mass Storage Driver Support [Enabled]**

  Enables or disables support for USB mass storage devices.

4.3.12 Network Stack Configuration

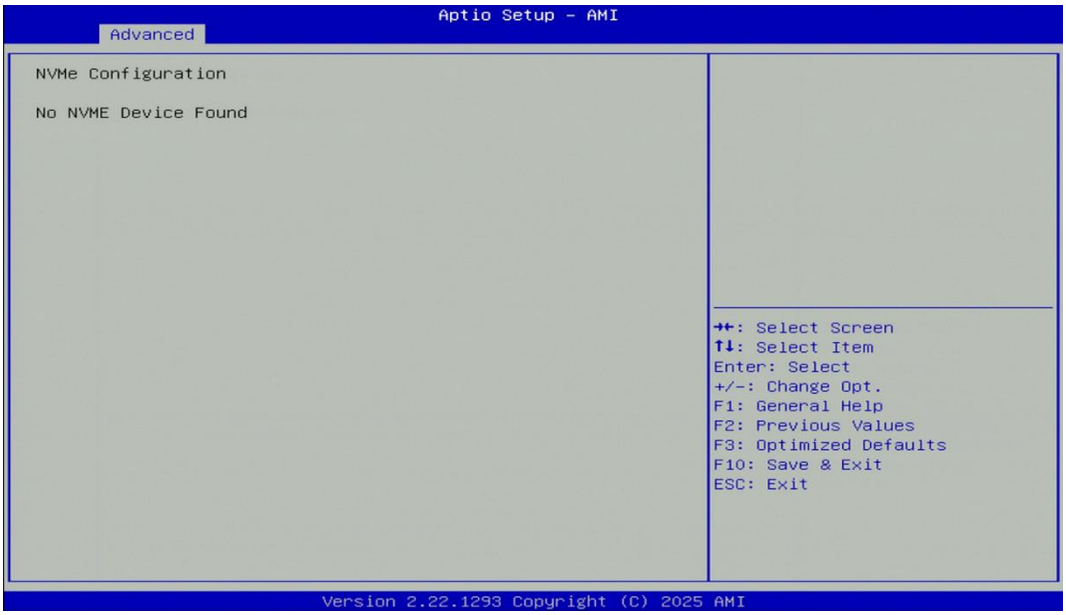


- **Network Stack [Disabled]**

  Enables or disables UEFI Network Stack.

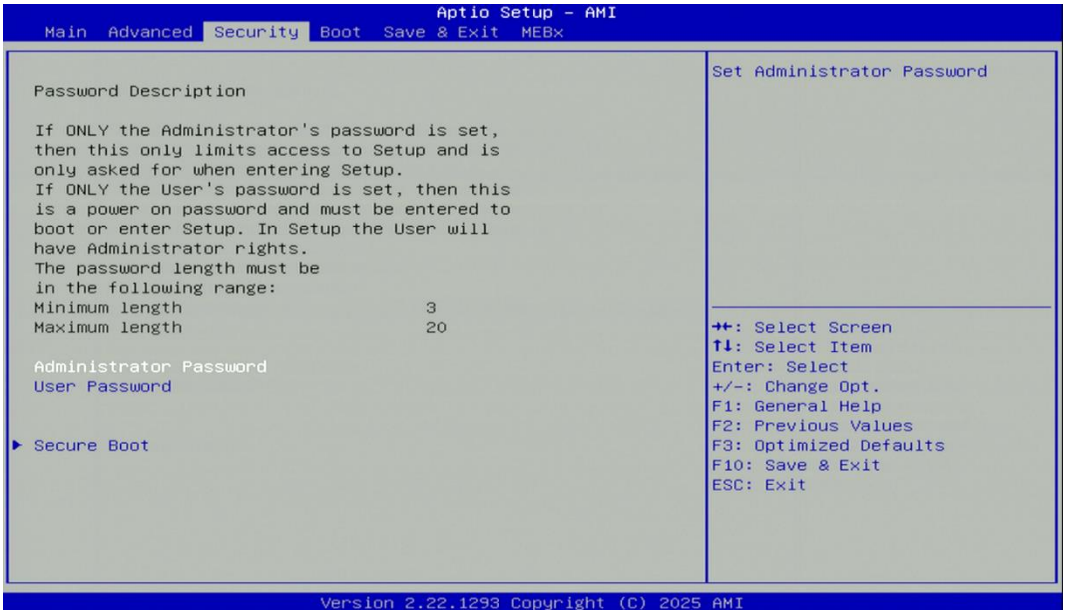
4.3.13 NVMe Configuration

The screen allows users to select options for the NVMe configuration, and change the value of the selected option. If there is NVMe Device detected, the options will show as the NVMe Device is found.



4.4 Security Setup

This section allows users to configure BIOS security settings.



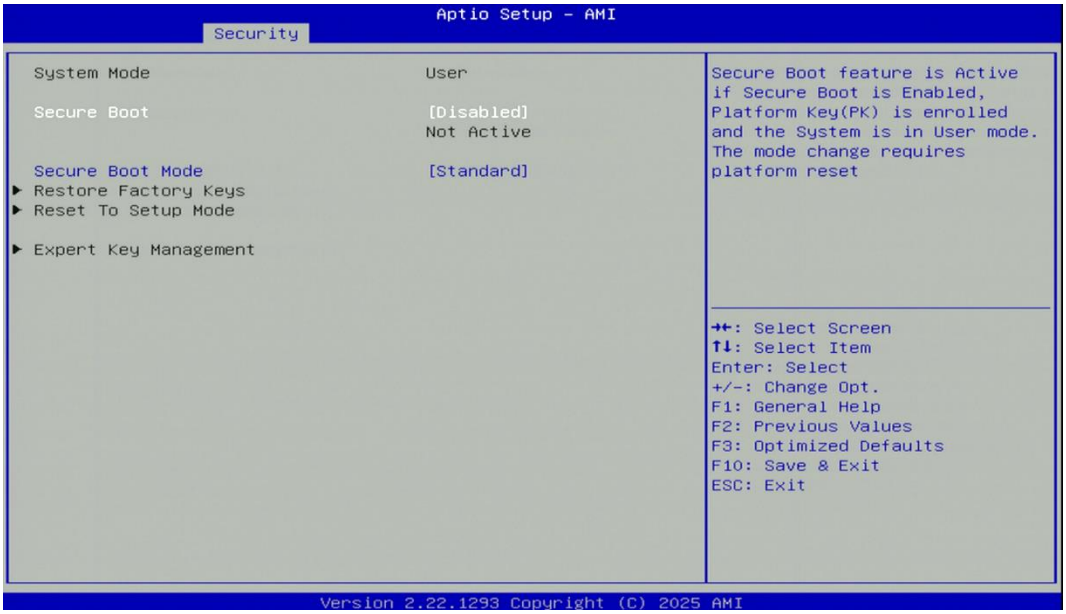
4.4.1 Administrator Password

Administrator Password controls access to the BIOS Setup utility.

4.4.2 User Password

User Password controls access to the system at boot and to the BIOS Setup utility.

4.4.3 Security Boot



- **Secure Boot [Disabled]**

  Enable or disable Secure Boot function.

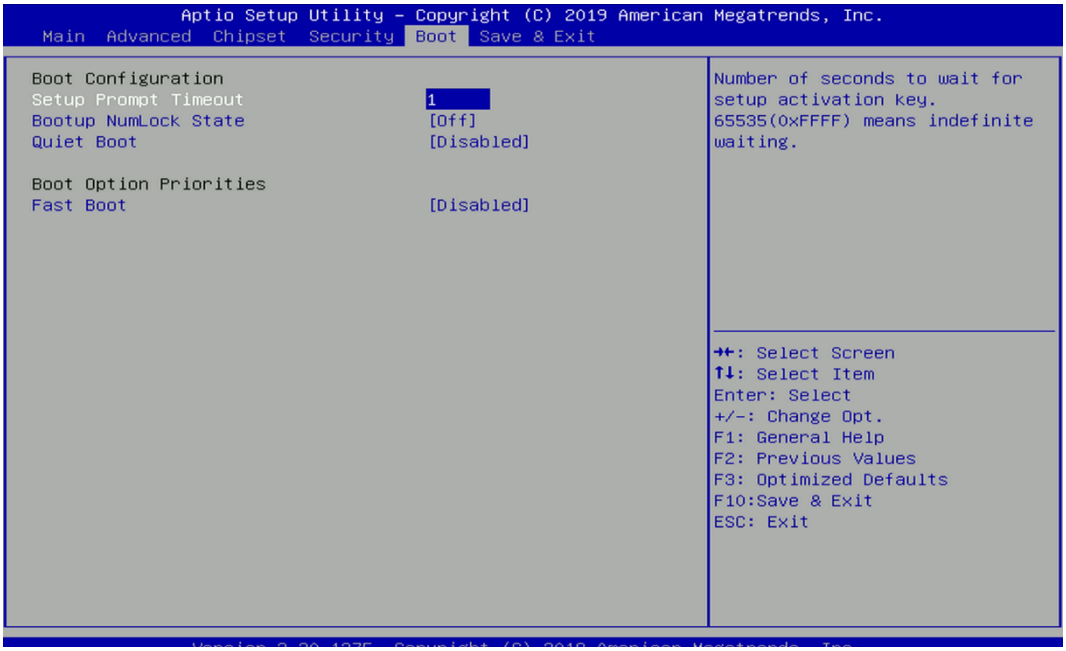
- **Secure Boot Mode [Standard]**

  Allows you to select Secure Boot Mode.

  Configuration options: [Standard] [Custom].

4.5 Boot Setup

This section allows you to configure Boot settings.



4.5.1 Setup Prompt Timeout [1]

Use this item to set number of seconds (1..65535) to wait for setup activation key.

4.5.2 Bootup NumLock State [Off]

Allows you to select the power-on state for keyboard NumLock.

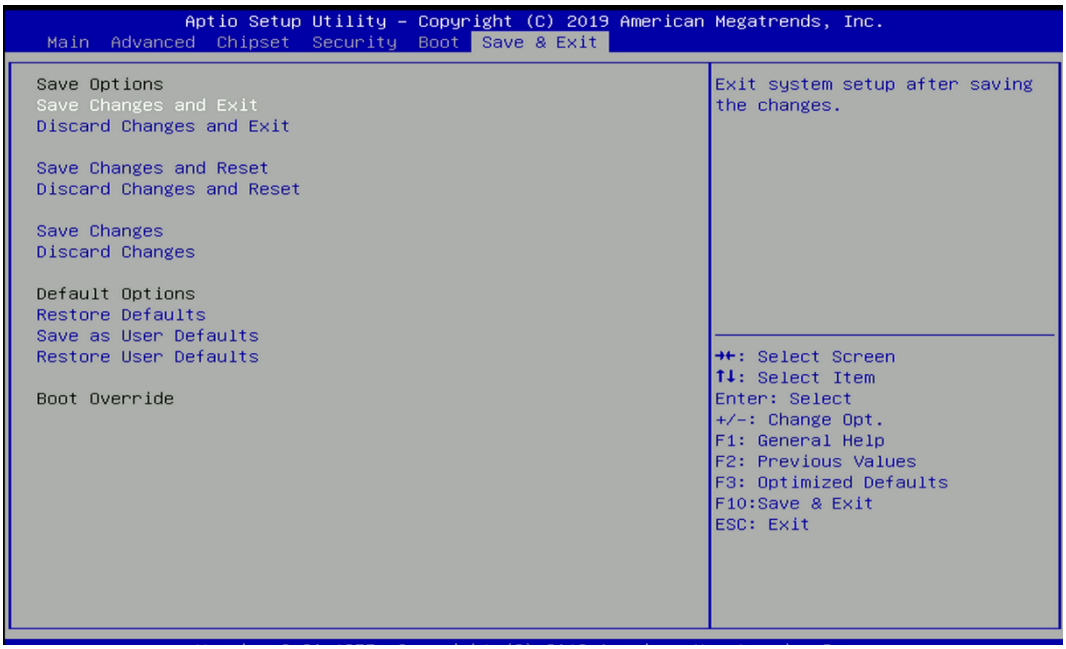
4.5.3 Quiet Boot [Disabled]

Allows you to enable or disable Quiet Boot function.

4.5.4 Fast Boot [Disabled]

Allows you to enable or disable Fast Boot function.

4.6 Save & Exit



4.6.1 Save Changes and Exit

This item allows you to exit system setup after saving changes.

4.6.2 Discard Changes and Exit

This item allows you to exit system setup without saving changes.

4.6.3 Save Changes and Reset

This item allows you to reset the system after saving changes.

4.6.4 Discard Changes and Reset

This item allows you to reset system setup without saving any changes.

4.6.5 Save Changes

This item allows you to save changes done so far to any of the setup options.

4.6.6 Discard Changes

This item allows you to discard changes done so far to any of the setup options.

4.6.7 Restore Defaults

This item allows you to restore/ load default values for all the options.

4.6.8 Save as User Defaults

This item allows you to save the changes done so far as user defaults.

4.6.9 Restore User Defaults

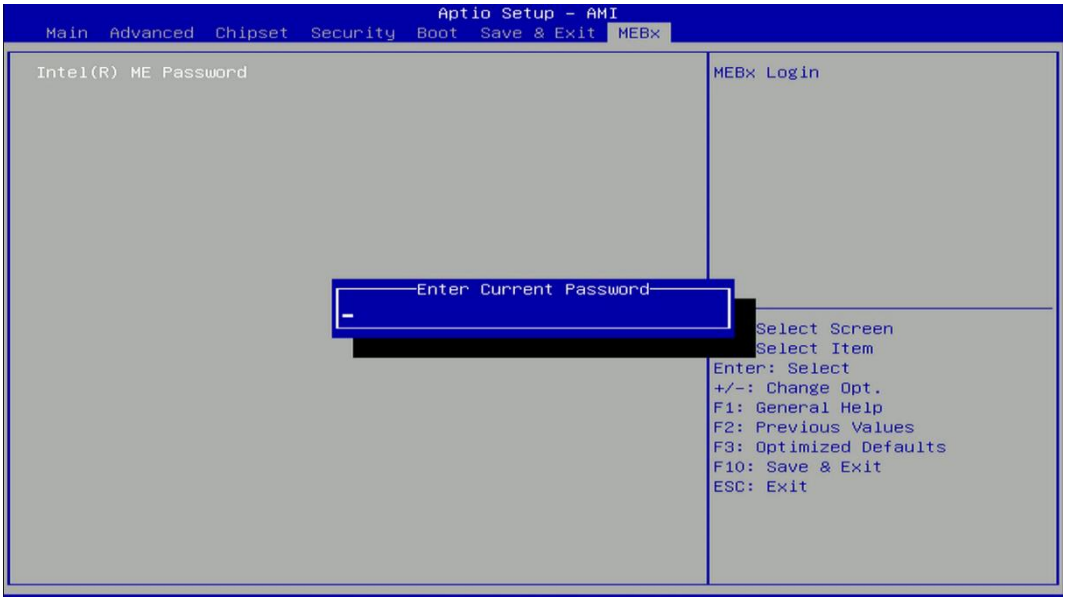
This item allows you to restore the user defaults to all the options.

4.7 MEBx

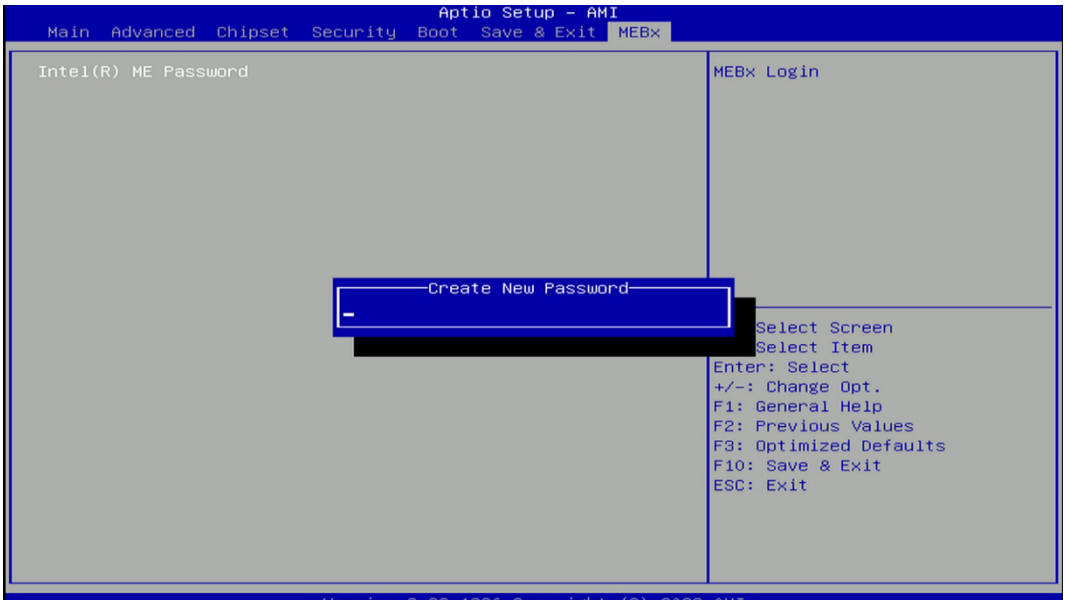
This page is for ME function setting. Press the delete key to enter the BIOS menu then user can see the following MEBx page.



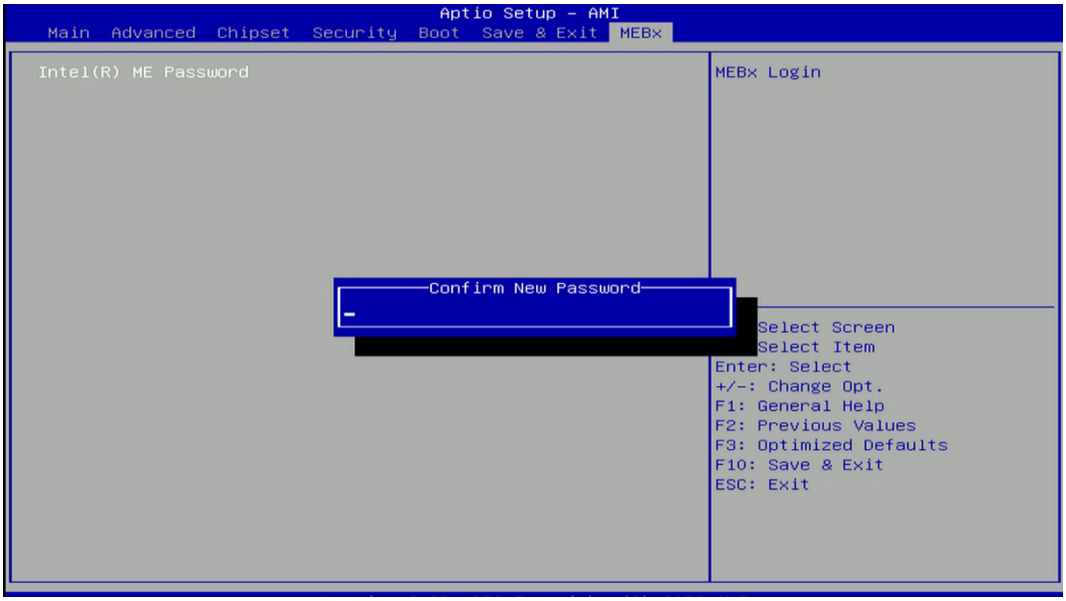
Press enter key to enter the default password "admin" to enter the next step for password creation.



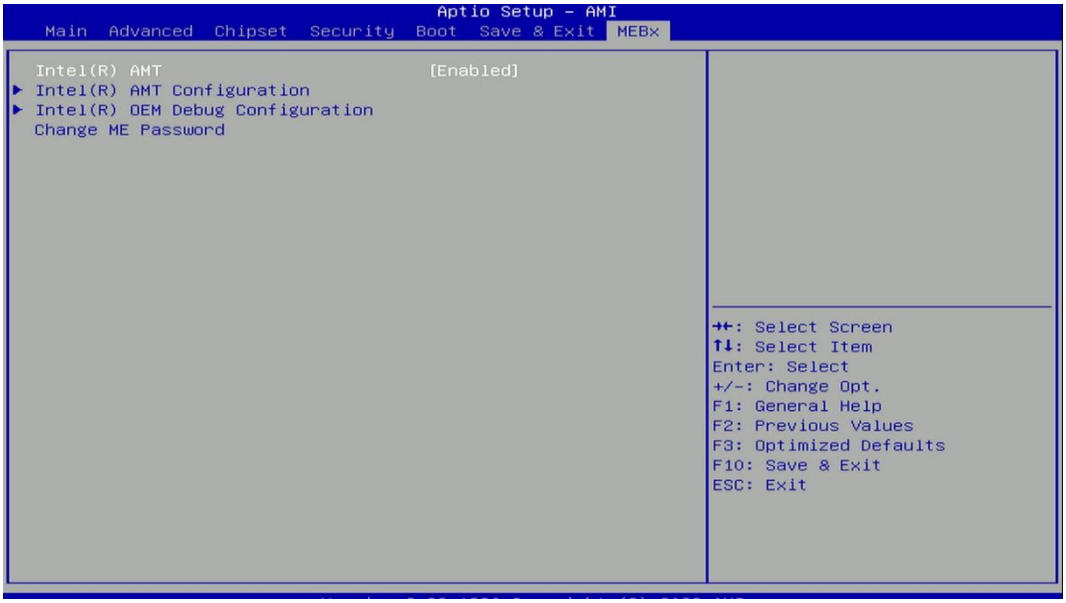
Create a new password using 8 characters including uppercase and lowercase letters, numbers and special symbols.



Enter the created password again for confirmation.



Then you can see the function setting page of MEBx.



Chapter 5
Product Application

5.1 Where to download drivers?

Drivers for the CV-200/P2302 Series can be downloaded from the CINCOZE website.

5.2 Where to find the technical documents?

The following documents are the most relevant technical references for the CV-200/P2302 Series. All documents can be accessed via the CINCOZE Partner Zone:

- **Application Notes**: Navigate to *Home > Partner Zone > Technical Support > Application Notes*.
- **Configure & Installation**: Navigate to *Home > Partner Zone > Technical Support > Configure & Installation*.
- **Other Product Information**: Navigate to *Home > Partner Zone > Product Center > Product Information > Industrial Panel PC & Monitor > Open Frame Panel PC > High Performance Open Frame Panel PC > CV-200/P2302 Series.*

Catalog	Document Title
Application Notes	DIO Application Guide
	DIO Technical Guide
	WDT Application Guide
	WDT Technical Guide
Configure & Installation	AT ATX Function Manual
	BIOS Administrator User Password Function Manual
	Clear CMOS Function Manual
	COM Function Manual
	CSM Function Manual
	Digital I/O Function Manual
	How to import Secure Boot Key?
	How to restore Windows image with Clonezilla?
	How to set TPM function under Windows?
	How to stop automatic driver update in Windows SOP
	How to Update BIOS and ME under UEFI shell?
	How to Update BIOS under UEFI shell?
	How to Update BIOS under Windows?
	IGN Module User Manual
	Intel AMT with KVM Remote Control
	POE Module User Manual
	PXE Function Manual
	RAID Function Manual
	Remote Switch Function Manual
	Wake On LAN Function Manual
	WDT Function Manual

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